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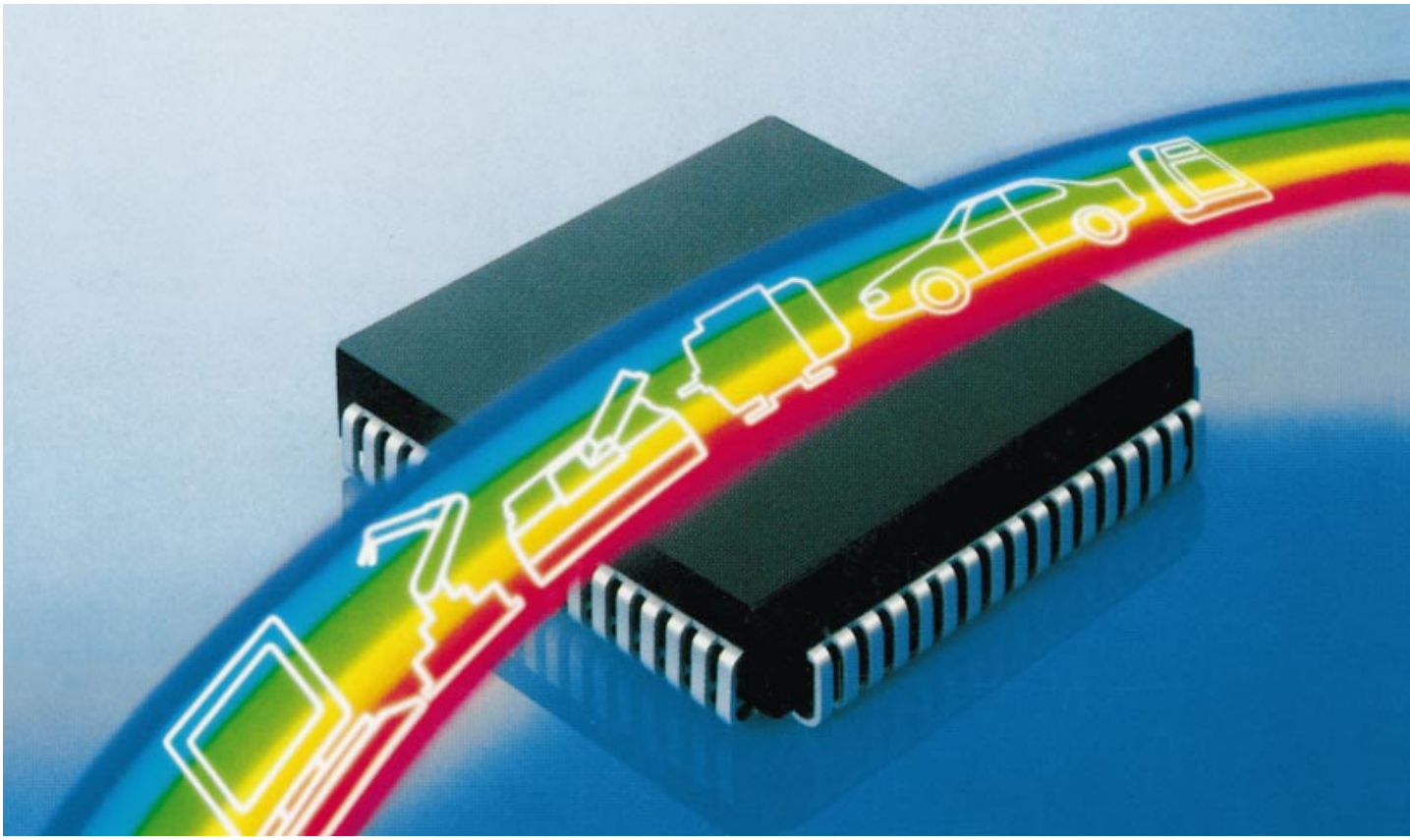

Microcomputer Components

SAB 80C517A/83C517A-5
8-Bit CMOS Single-Chip Microcontroller

Addendum to User's Manual SAB 80C517/80C537 05.94

Edition 05.94

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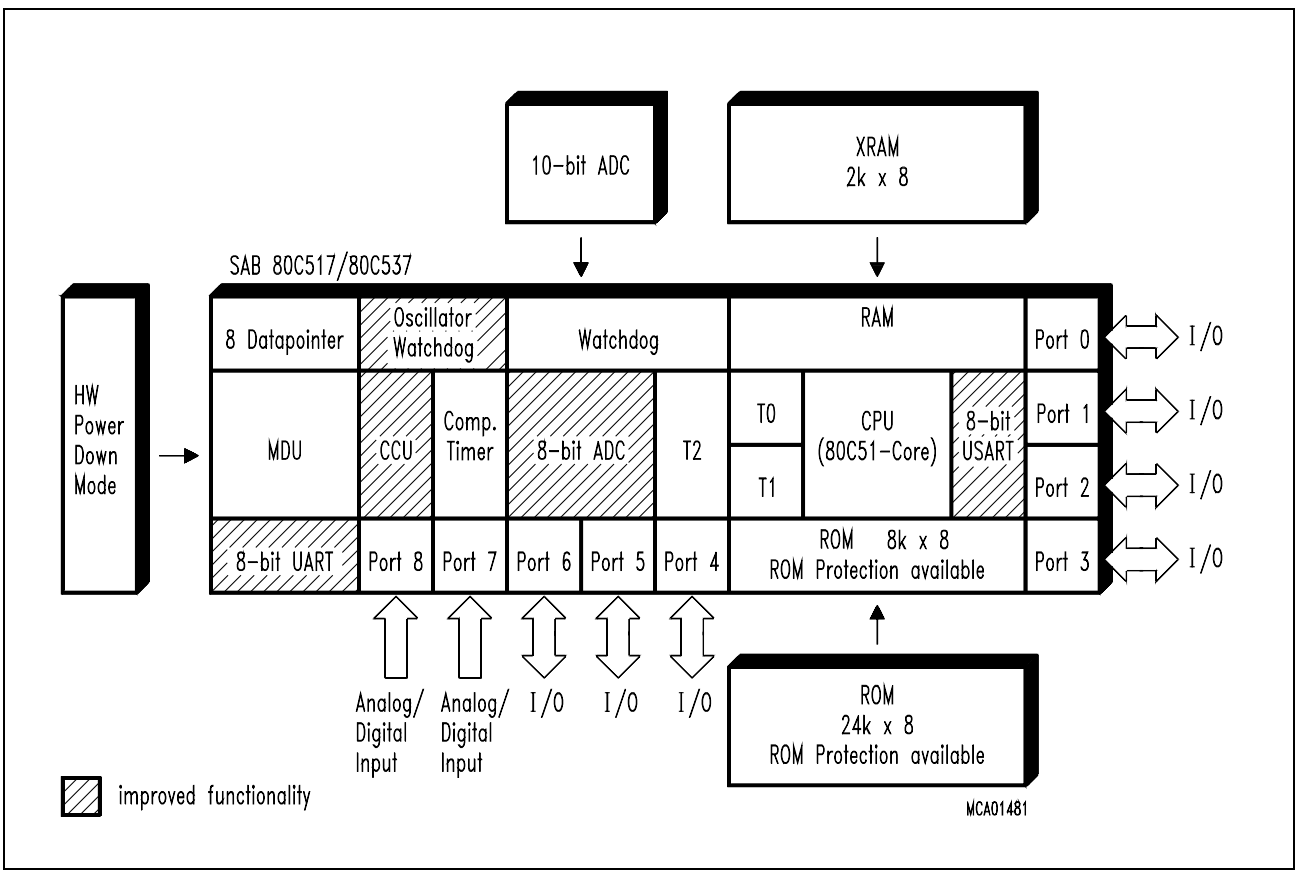
SAB 80C517A/83C517A-5 **Revision History:** **05.94**	
Previous Version:	11.92
Page	**Subjects (major changes since last revision 11.92)**
3-8 4-1 5-3 5-10/5-11	S0RELL adresses corrected $\overline{\text{HWPD}}$ pin number corrected T_S/T_C in table 5-1 corrected CC4EN bit names and table 5-3 corrected
Device Specifications SAB 80C517A/83C517A-5 **Revision History:** **05.94**	
Previous Releases:	01.94/08.93/11.92/10.91/04.91
Page	**Subjects (changes since last revision 04.91)**
5 4 6-14 several 2 25,26,30 33 39 57 60 62 65 several 66 68	Pin configuration P-MQFP-100-2 added Pin differences updated Pin numbers for P-MQFP-100-2 package added Correction of P-MRFP-100 into P-MQFP-100-2 Ordering information for – 40 to + 110 °C versions Correction of register names S0RELL, SCON, ADCON, ICRON and SBUF Figure 4 corrected Figure 8 corrected $\overline{\text{PE}}$/SWD function description completed Correct ordering numbers Test condition for V_{OH}, V_{OH1} corrected t_{PXIZ} name corrected t_{AVIV}, t_{AZPL} values corrected Minimum clock frequence is now 3.5 MHz t_{QVWH} (data setup before $\overline{\text{WR}}$) corrected and added t_{LLAX2} corrected
Page	**Subjects (changes since last version 08.93)**
25 51 65 67 74	Corrected SFR name S0RELL Below “Termination of HWPD Mode”: 4th paragraph with ident corrected Description of t_{LLIV} corrected Program Memory Read Cycle: f_{PXAV} added Oscillator circuit drawings: MQFP-100-2 pin numbers added.
Page	**Subjects (changes since last revision 01.94)**
 47	Minor changes on several pages Table 6 corrected

Contents Page

1 Introduction

The SAB 80C517A is a superset of the high end microcontroller SAB 80C517.

While maintaining all architectural and operational characteristics of the SAB 80C517 the SAB 80C517A incorporates more on-chip RAM as well as some enhancements in the compare / capture unit. The oscillator watchdog got an improved functionality. Also the operating frequency is higher than that of the SAB 80C517.



SAB 80C517A / 83C517A-5

In this manual, any reference made to the SAB 80C517A applies to both versions, the SAB 80C517A and the SAB 83C517A-5, unless otherwise noted. Furthermore only new features of the SAB 80C517A in addition to the features of the SAB 80C517A/83C517A-5 are described. For additional reference, the user's manual of the SAB 80C517/80C537 (Ord. No. B258-H6075-G1-X-7600) should be used.

Listed below is a summary of the main features of the SAB 80C517A:

- SAB 80C517A/83C517A-5, up to 18 MHz operation frequency
- 32 K×8 ROM (SAB 83C517A-5 only, ROM-Protection available)
- 256×8 on-chip RAM
- 2K×8 on-chip RAM (XRAM)
- Superset of SAB 80C51 architecture:
  - 1 µs instruction cycle time at 12 MHz
  - 666 ns instruction cycle time at 18 MHz
  - 256 directly addressable bits
  - Boolean processor
  - 64 Kbyte external data and program memory addressing
- Four 16-bit timer/counters
- Powerful 16-bit compare/capture unit (CCU) with up to 21 high-speed or PWM output channels and 5 capture inputs
- Versatile "fail-safe" provisions
- Fast 32-bit division, 16-bit multiplication, 32-bit normalize and shift by peripheral MUL/DIV unit (MDU)
- Eight data pointers for external memory addressing
- Seventeen interrupt vectors, four priority levels selectable
- genuine 10-bit A/D converter with 12 multiplexed inputs
- Two full duplex serial interfaces with programmable Baudrate-Generators
- Fully upward compatible with SAB 80C515, SAB 80C517, SAB 80C515A
- Extended power saving modes
- Fast Power-On Reset
- Nine ports: 56 I/O lines, 12 input lines
- Three temperature ranges available:
  0 to 70 °C (T1)
  – 40 to + 85 °C (T3)
  – 40 to + 110 °C (T4)
- Plastic packages: P-LCC-84
  P-MQFP-100-2

The pin functions of the SAB 80C517A are identical with those of the SAB 80C517/80C537 with one exception:

Package	SAB 80C517A	SAB 80C517 / 80C537
PLCC-84/60 PMRFP-100/72	$\overline{\text{HWPD}}$	V_{SS}

2 Fundamental Structure

The SAB 80C517A/83C517A-5 is a high-end member of the Siemens SAB 8051 family of microcontrollers. It is designed in Siemens ACMOS technology and based on the SAB 8051 architecture. ACMOS is a technology which combines high-speed and density characteristics with low-power consumption or dissipation.

While maintaining all the SAB 80C517 features and operating characteristics the SAB 80C517A is expanded in its "fail-safe" characteristics and timer capabilities.

Furthermore, the SAB 80C517A additionally contains 2 kByte of on-chip RAM (called XRAM), a 10bit A/D converter with 12 multiplexed inputs, enhanced Baud Rate Generators and the capabilities of the Compare Capture Unit are improved.

The SAB 80C517A is identical with the SAB 83C517A-5 except that it lacks the on-chip program memory. The SAB 80C517A / 83C517A-5 is supplied in a 84-pin plastic leaded chip carrier package (P-LCC-84) and in a 100-pin plastic metric rectangular flat package (P-MRFP-100).

The essential enhancements to the SAB 80C517 are:

- Additional 2KByte RAM on chip.
- 32 kByte on-chip program memory (SAB 83C517A-5 only)
- 12-channel 10-bit A/D Converter
- Additional Compare Mode for Concurrent Compare function at Port 5; up to eight pins on P5 can be either set or reset on a compare match in two additional compare registers.
- Dedicated interrupt vector for the 16-bit compare registers CM0-CM7: Interrupt requested on a compare match in one of the eight compare channels (eight request flags are available)
- New baud rate generator for Serial Channel 0
- Expanded baud rate range for Serial Channel 1
- Hardware controlled Power Down Mode
- Improved functionality of the Oscillator Watchdog
- High speed operation of the device (up to 18 MHz crystal frequency)

Figure 2-1 shows a block diagram of the SAB 80C517A

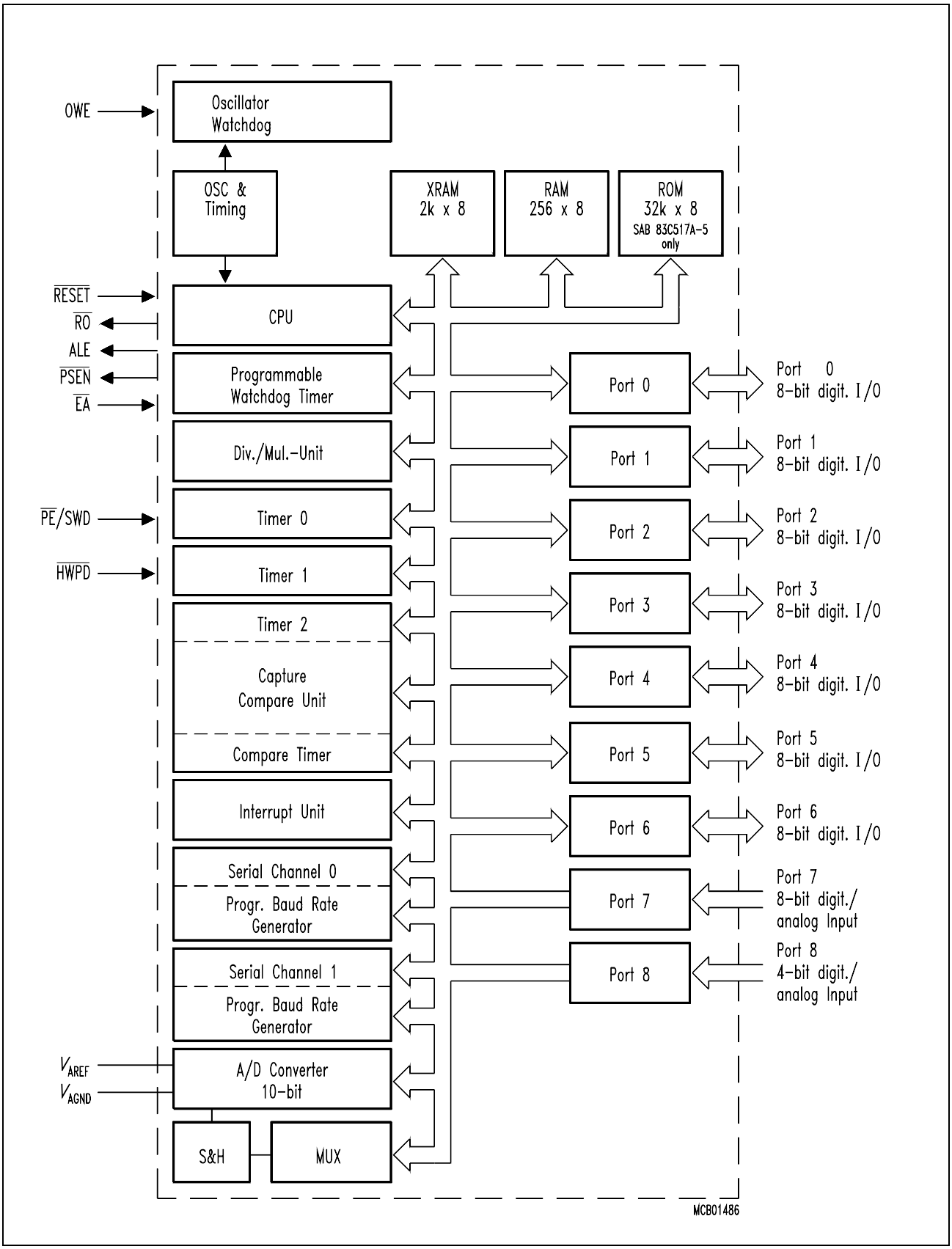


Figure 2-1, Block Diagram of the SAB 80C517A

3 Memory Organization

According to the SAB 8051 architecture, the SAB 80C517A has separate address spaces for program and data memory. **Figure 3-1** illustrates the mapping of address spaces.

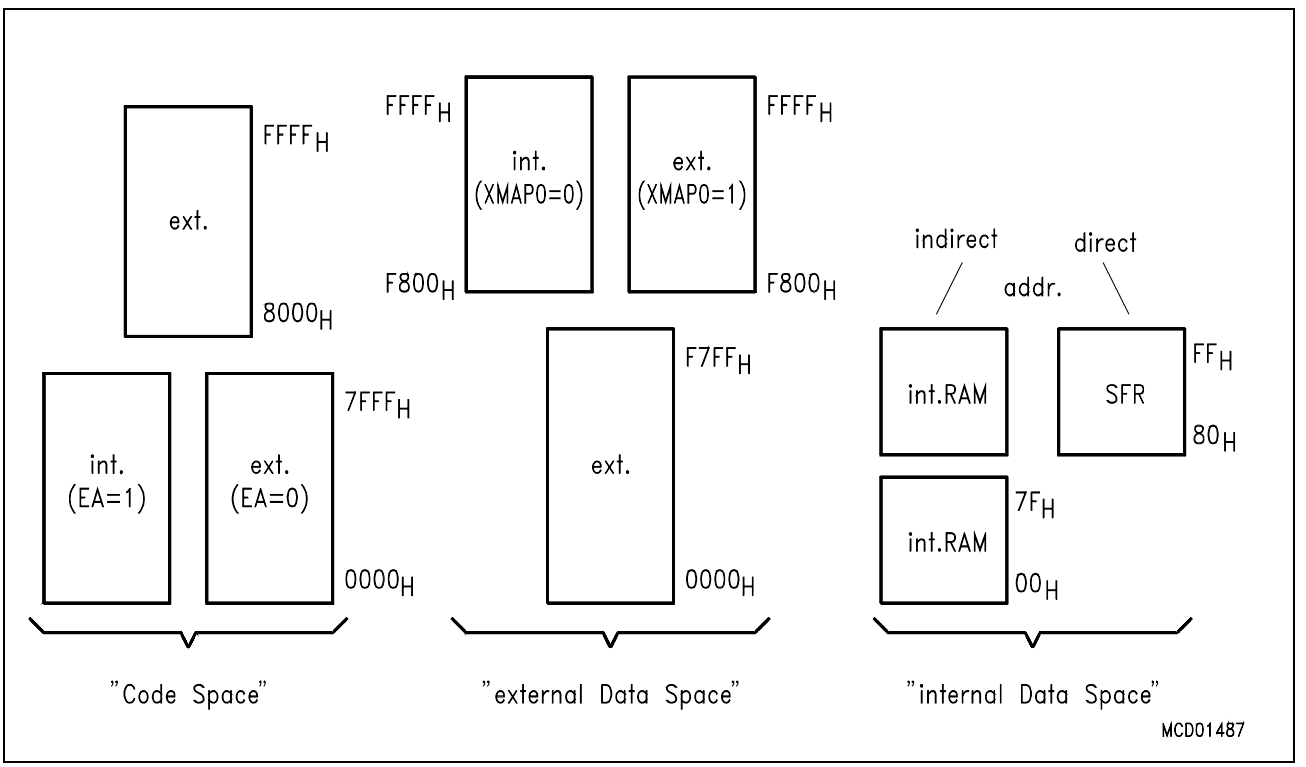


Figure 3-1
Memory Map

3.1 Program Memory, ROM Protection

The SAB 83C517A-5 has 32 Kbyte of on-chip ROM, while the SAB 80C517A has no internal ROM. The program memory can externally be expanded up to 64 Kbyte. Pin $\overline{EA}$ controls whether program fetches below address 8000H are done from internal or external memory.

As a new feature the SAB 83C517A-5 offers the possibillity of protecting the internal ROM against unauthorized access. This protection is implemented in the ROM-Mask. Therefore, the decision ROM-Protection 'yes' or 'no' has to be made when delivering the ROM-Code. Once enabled, there is no way of disabling the ROM-Protection.

Effect : The access to internal ROM done by an externally fetched MOVC instruction is disabled. Nevertheless, an access from internal ROM to external ROM is possible.

To verify the read protected ROM-Code a special ROM-Verify-Mode is implemented. This mode also can be used to verify unprotected internal ROM.

ROM-Protection	**ROM-Verification Mode (see 'AC Characteristics')**	**Restrictions**
no	ROM-Verification Mode 1 (standard 8051 Verification Mode) ROM-Verification Mode 2	–
yes	ROM-Verification Mode 2	– standard 8051 Verification Mode is disabled – externally applied MOVC accessing to internal ROM is disabled

3.2 Data Memory

The data memory space consists of an internal and an external memory space. The SAB 80C517A contains another 2 kByte of On-Chip RAM above the 256 Bytes internal RAM of the base type SAB 80C517. This RAM is called XRAM in this document.

- External Data Memory
  Up to 64 Kbyte external data memory can be addressed by instructions that use 8-bit or 16-bit indirect addressing. For 8-bit addressing MOVX instructions in combination with registers R0 and R1 can be used. A 16-bit external memory addressing is supported by eight 16-bit datapointers. Registers XPAGE and SYSCON are controlling whether data fetches at addresses $F800_H$ to $FFFF_H$ are done from internal XRAM or from external data memory.
- Internal Data Memory
  The internal data memory is divided into four physically distinct blocks:
  - the lower 128 bytes of RAM including four banks containing eight registers each
  - the upper 128 byte of RAM
  - the 128 byte special function register area
  - a 2Kx8 area which is accessed like external RAM (MOVX-instructions), called XRAM implemented on chip at the address range from$F800_H$ to $FFFF_H$. Special Function Register SYSCON controls whether data is read or written (to) XRAM or external RAM

3.3 Special Function Registers

All registers, except the program counter and the four general purpose register banks, reside in the special function register area. The 81 special function registers include arithmetic registers, pointers, and registers that provide an interface between the CPU and the on-chip peripherals. There are also 128 directly addressable bits within the SFR area. All special function registers are listed in **table 3-1** and **table 3-2**.

In **table 3-1** they are organized in numeric order of their addresses. In **table 3-2** they are organized in groups which refer to the functional blocks of the SAB 80C517A.

Table 3-1, Special Function Register

Address	Register	Contents after Reset	Address	Register	Contents after Reset
80_H	**P0** [1]	**FF_H**	**$A0_H$**	**P2** [1]	**FF_H**
81_H	SP	07_H	$A1_H$	COMSETL	00_H
82_H	DPL	00_H	$A2_H$	COMSETH	00_H
83_H	DPH	00_H	$A3_H$	COMCLRL	00_H
84_H	(WDTL)	–	$A4_H$	COMCLRH	00_H
85_H	(WDTH)	–	$A5_H$	SETMSK	00_H
86_H	WDTREL	00_H	$A6_H$	CJRMSK	00_H
87_H	PCON	00_H	$A7_H$	–	–
88_H	**TCON** [1]	**00_H**	**$A8_H$**	**IEN0** [1]	**00_H**
89_H	TMOD	00_H	$A9_H$	IP0	00_H
$8A_H$	TL0	00_H	AA_H	SORELL	$D9_H$
$8B_H$	TL1	00_H	AB_H	–	–
$8C_H$	TH0	00_H	AC_H	–	–
$8D_H$	TH1	00_H	AD_H	–	–
$8E_H$	–	–	AE_H	–	–
$8F_H$	–	–	AF_H	–	–
90_H	**P1** [1]	**FF_H**	**$B0_H$**	**P3** [1]	**FF_H**
91_H	XPAGE	00_H	$B1_H$	SYSCON	$XXXX\ XX01_B$
92_H	DPSEL	$XXXXX000_B$	$B2_H$	–	–
93_H	–	–	$B3_H$	–	–
94_H	–	–	$B4_H$	–	–
95_H	–	–	$B5_H$	–	–
96_H	–	–	$B6_H$	–	–
97_H	–	–	$B7_H$	–	–
98_H	**S0CON** [1]	**00_H**	**$B8_H$**	**IEN1** [1]	**00_H**
99_H	S0BUF	XX_H	$B9_H$	IP1	$XX00\ 0000_B$
$9A_H$	IEN2	$XX00\ 00X0_B$	BA_H	S0RELH	$XXXX\ XX11_B$
$9B_H$	S1CON	$0X00\ 0000_B$	BB_H	S1RELH	$XXXX\ XX11_B$
$9C_H$	S1BUF	XX_H	BC_H	–	–
$9D_H$	S1RELL	00_H	BD_H	–	–
$9E_H$	–	–	BE_H	–	–
$9F_H$	–	–	BF_H	–	–

1) : Bit-addressable Special Function Register

Table 3-1, Special Function Register (cont´d)

Address	Register	Contents after Reset	Address	Register	Contents after Reset
$C0_H$	**IRCON0** [1]	**00_H**	**$E0_H$**	**ACC** [1]	**00_H**
$C1_H$	CCEN	00_H	$E1_H$	CTCON	$0X00\ 0000_B$
$C2_H$	CCL1	00_H	$E2_H$	CML3	00_H
$C3_H$	CCH1	00_H	$E3_H$	CMH3	00_H
$C4_H$	CCL2	00_H	$E4_H$	CML4	00_H
$C5_H$	CCH2	00_H	$E5_H$	CMH4	00_H
$C6_H$	CCL3	00_H	$E6_H$	CML5	00_H
$C7_H$	CCH3	00_H	$E7_H$	CMH5	00_H
$C8_H$	**T2CON** [1]	**00_H**	**$E8_H$**	**P4** [1]	**FF_H**
$C9_H$	CC4EN	00_H	$E9_H$	MD0	XX_H
CA_H	CRCL	00_H	EA_H	MD1	XX_H
CB_H	CRCH	00_H	EB_H	MD2	XX_H
CC_H	TL2	00_H	EC_H	MD3	XX_H
CD_H	TH2	00_H	ED_H	MD4	XX_H
CE_H	CCL4	00_H	EE_H	MD5	XX_H
CF_H	CCH4	00_H	EF_H	ARCON	$0XXX\ XXXX_B$
$D0_H$	**PSW** [1]	**00_H**	**F0**	**B** [1]	**00_H**
$D1_H$	IRCON1	00_H	$F1_H$	–	–
$D2_H$	CML0	00_H	$F2_H$	CML6	00_H
$D3_H$	CMH0	00_H	$F3_H$	CMH6	00_H
$D4_H$	CML1	00_H	$F4_H$	CML7	00_H
$D5_H$	CMH1	00_H	$F5_H$	CMH7	00_H
$D6_H$	CML2	00_H	$F6_H$	CMEN	00_H
$D7_H$	CMH2	00_H	$F7_H$	CMSEL	00_H
$D8_H$	**ADCON0** [1]	**00_H**	**$F8_H$**	**P5** [1]	**FF_H**
$D9_H$	ADDATH	00_H	$F9_H$	–	–
DA_H	ADDATL	00_H	FA_H	P6	FF_H
DB_H	P7	XX_H	FB_H	–	–
DC_H	ADCON1	$XXXX\ 0000_B$	FC_H	–	–
DD_H	P8	XX_H	FD_H	–	–
DE_H	CTRELL	00_H	FE_H	–	–
DF_H	CTRELH	00_H	FF_H	–	–

1) : Bit-addressable Special Function Register

Table 3-1, Special Function Register (cont´d)

Block	Symbol	Name	Address	Contents after Reset
XRAM	XPAGE	Page Address. Reg. for extended onchip RAM	91_H	00_H
	SYSCON	XRAM Control Reg.	$B1_H$	XXXX $XX01_B$ [3]
CPU	ACC	Accumulator	**$E0_H$** [1]	00_H
	B	B-Register	**$F0_H$** [1]	00_H
	DPH	Data Pointer, High Byte	83_H	00_H
	DPL	Data Pointer, Low Byte	82_H	00_H
	DPSEL	Data Pointer Select Register	92_H	$XXXXX000_B$ [3]
	PSW	Program Status Word Register	**$D0_H$** [1]	00_H
	SP	Stack Pointer	81_H	07_H
A/D-Converter	ADCON0	A/D Converter Control Register 0	**$D8_H$** [1]	00_H
	ADCON1	A/D Converter Control Register 1	D_H	00_H
	ADDATH	A/D Converter Data Register High Byte	$D9_H$	00_H
	ADDATL	A/D Converter Data Register Low Byte	DA_H	00_H
Interrupt System	IEN0	Interrupt Enable Register 0	**$A8_H$** [1]	00_H
	CTCON [2]	Com. Timer Control Register	$E1_H$	$0X00\ 0000_B$ [3]
	IEN1	Interrupt Enable Register 1	**$B8_H$** [1]	00_H
	IEN2	Interrupt Enable Register 2	$9A_H$	$XX00\ 00X0_B$ [3]
	IP0	Interrupt Priority Register 0	A_{9H}	00_H
	IP1	Interrupt Priority Register 1	$B9_H$	$XX00\ 0000_B$
	IRCON0	Interrupt Request Control Register	**$C0_H$** [1]	00_H
	IRCON1	Interrupt Request Control Register	$D1_H$	00_H
	TCON [2]	Timer Control Register	**88_H** [1]	00_H
	T2CON [2]	Timer 2 Control Register	**$0C8_H$** [1]	00_H
MUL/DIV Unit	ARCON	Arithmetic Control Register	EF_H	$0XXX\ XXXX_B$
	MD0	Multiplication/Division Register 0	$E9_H$	XX_H
	MD1	Multiplication/Division Register 1	EA_H	XX_H
	MD2	Multiplication/Division Register 2	EB_H	XX_H
	MD3	Multiplication/Division Register 3	EC_H	XX_H
	MD4	Multiplication/Division Register 4	ED_H	XX_H
	MD5	Multiplication/Division Register 5	EE_H	XX_H
Compare/ Capture-Unit (CCU), Timer2	CCEN	Comp./Capture Enable Reg.	$C1_H$	00_H
	CC4EN	Comp./Capture 4 Enable Reg.	$C9_H$	00_H
	CCH1	Comp./Capture Reg. 1, High Byte	$C3_H$	00_H
	CCH2	Comp./Capture Reg. 2, High Byte	$C5_H$	00_H
	CCH3	Comp./Capture Reg. 3, High Byte	$C7_H$	00_H
	CCH4	Comp./Capture Reg. 4, High Byte	CF_H	00_H
	CCL1	Comp./Capture Reg. 1, Low Byte	$C2_H$	00_H

1) Bit-addressable special function registers

2) This special function register is listed repeatedly since some bits of it also belong to other functional blocks.

3) X means that the value is indeterminate

Table 3-1, Special Function Register

Block	Symbol	Name	Address	Contents after Reset
Compare/ Capture- Unit (CCU) (cont´d)	CCL2	Comp./Capture Reg. 2, Low Byte	$C4_H$	00_H
	CCL3	Comp./Capture Reg. 3, Low Byte	$C6_H$	00_H
	CCL4	Comp./Capture Reg. 4, Low Byte	CE_H	00_H
	CMEM	Compare Enable Register	$F6_H$	00_H
	CMH0	Compare Reg. 0, High Byte	$D3_H$	00_H
	CMH1	Compare Reg. 1, High Byte	$D5_H$	00_H
	CMH2	Compare Reg. 2, High Byte	$D7_H$	00_H
	CMH3	Compare Reg. 3, High Byte	$E3_H$	00_H
	CMH4	Compare Reg. 4, High Byte	$E5_H$	00_H
	CMH5	Compare Reg. 5, High Byte	$E7_H$	00_H
	CMH6	Compare Reg. 6, High Byte	$F3_H$	00_H
	CMH7	Compare Reg. 7, High Byte	$F5_H$	00_H
	CML0	Compare Register 0, Low Byte	$D2_H$	00_H
	CML1	Compare Register 1, Low Byte	$D4_H$	00_H
	CML2	Compare Register 2, Low Byte	$D6_H$	00_H
	CML3	Compare Register 3, Low Byte	$E2_H$	00_H
	CML4	Compare Register 4, Low Byte	$E4_H$	00_H
	CML5	Compare Register 5, Low Byte	$E6_H$	00_H
	CML6	Compare Register 6, Low Byte	$F2_H$	00_H
	CML7	Compare Register 7, Low Byte	$F4_H$	00_H
	CMSEL	Compare Input Select	$F7_H$	00_H
	CRCH	Com./Rel./Capt. Reg. High Byte	CB_H	00_H
	CRCL	Com./Rel./Capt. Reg. Low Byte	CA_H	00_H
	COMSETL	Compare register, Low Byte	$A1_H$	00_H
	COMSETH	Compare register, High Byte	$A2_H$	00_H
	COMCLRL	Compare register, Low Byte	$A3_H$	00_H
	COMCLRH	Compare register, High Byte	$A4_H$	00_H
	SETMSK	mask register, concerning COMSET	$A5_H$	00_H
	CLRMSK	mask register, concerning COMCLR	$A6_H$	00_H
	CTCON	Com. Timer Control Reg.	$E1_H$	$0X00\ 0000_B$ 3)
	CTRELH	Com. Timer Rel. Reg., High Byte	DF_H	00_H
	CTRELL	Com. Timer Rel. Reg., Low Byte	DE_H	00_H
	TH2	Timer 2, High Byte	CD_H	00_H
	TL2	Timer 2, Low Byte	CC_H	00_H
	T2CON	Timer 2 Control Register	**$C8_H$** 1)	00_H

1) Bit-addressable special function registers

2) This special function register is listed repeatedly since some bits of it also belong to other functional blocks.

3) X means that the value is indeterminate

Table 3-1, Special Function Register

Block	Symbol	Name	Address	Contents after Reset
Ports	P0	Port 0	**80_H** 1)	FF_H
	P1	Port 1	**90_H** 1)	FF_H
	P2	Port 2	**$A0_H$** 1)	FF_H
	P3	Port 3	**$B0_H$** 1)	FF_H
	P4	Port 4	**$E8_H$** 1)	FF_H
	P5	Port 5	**$F8_H$** 1)	FF_H
	P6	Port 6	FA_H	FF_H
	P7	Port 7, Analog/Digital Input	DB_H	–
	P8	Port 8, Analog/Digital Input, 4-bit	DD_H	–
Pow. Save Modes	PCON	Power Control Register	87H	00_H
Serial Channels	ADCON0 2)	A/D Converter Control Reg.	**$D8_H$** 1)	00_H
	PCON 2)	Power Control Register	87_H	00_H
	S0BUF	Serial Channel 0 Buffer Reg.	99_H	XX_H
	S0CON	Serial Channel 0 Control Reg.	**98_H** 1)	00_H
	S0RELL	Serial Channel 0 Reload Reg., low byte	$0AA_H$	$D9_H$
	S0RELH	Serial Channel 0 Reload Reg., high byte	BA_H	$XXXX\ XX11_B$ 3)
	S1BUF	Serial Channel 1 Buffer Reg.	$9C_H$	XX_H 3)
	S1CON	Serial Channel 1 Control Reg.	$9B_H$	$0X00\ 0000_B$ 3)
	S1RELL	Serial Channel 1 Reload Reg., low byte	$9D_H$	00_H
	S1RELH	Serial Channel 1 Reload Reg., high byte	BB_H	$XXXX\ XX11_B$ 3)
Timer 0/ Timer 1	TCON	Timer Control Register	**88_H** 1)	00_H
	TH0	Timer 0, High Byte	$8C_H$	00_H
	TH1	Timer 1, High Byte	$8D_H$	00_H
	TL0	Timer 0, Low Byte	$8A_H$	00_H
	TL1	Timer 1, Low Byte	$8B_H$	00_H
	TMOD	Timer Mode Register	89_H	00_H
Watchdog	IEN0 2)	Interrupt Enable Register 0	**$A8_H$** 1)	00_H
	IEN1 2)	Interrupt Enable Register 1	**$B8_H$** 1)	00_H
	IP0 2)	Interrupt Priority Register 0	$A9_H$	00_H
	IP1 2)	Interrupt Priority Register 1	$B9_H$	$XX00\ 0000_B$ 3)
	WDTREL	Watchdog Timer Reload Reg.	86_H	00_H

1) Bit-addressable special function registers

2) This special function register is listed repeatedly since some bits of it also belong to other functional blocks.

3) X means that the value is indeterminate

3.4 Architecture for the XRAM

The contents of the XRAM is not affected by a reset or HW Power Down. After power-up the contents is undefined, while it remains unchanged during and after a reset or HW Power Down if the power supply is not turned off.

The additional On-Chip RAM is logically located in the "external data memory" range at the upper end of the 64 KByte address range ($F800_H$-$FFFF_H$). It is possible to enable and disable (only by reset) the XRAM. If it is disabled the device shows the same behaviour as the parts without XRAM, i.e. all MOVX accesses use the external bus to physically external data memory.

3.4.1 Accesses to XRAM

Because the XRAM is used in the same way as external data memory the same instruction types must be used for accessing the XRAM.

Note:

If a reset occurs during a write operation to XRAM, the effect on XRAM depends on the cycle which the reset is detected at (MOVX is a 2-cycle instruction):

Reset detection at cycle 1: The new value will not be written to XRAM. The old value is not affected.

Reset detection at cycle 2: The old value in XRAM is overwritten by the new value.

Accesses to XRAM using the DPTR

There are a Read and a Write instruction from and to XRAM which use one of the 16-bit DPTR for indirect addressing. The instructions are:

```
MOVX    A, @DPTR    (Read)
MOVX    @DPTR, A    (Write)
```

Normally the use of these instructions would use a physically external memory. However, in the SAB 80C517A the XRAM is accessed if it is enabled and if the DPTR points to the XRAM address space (DPTR $\geq F800_H$).

Accesses to XRAM using the Registers R0/R1

The 8051 architecture provides also instructions for access to external data memory range which use only an 8-bit address (indirect addressing with registers R0 or R1). The instructions are:

MOVX	A, @ Ri	(Read)
MOVX	@Ri, A	(Write)

In application systems, either a real 8-bit bus (with 8-bit address) is used or Port 2 serves as page register which selects pages of 256-Byte. However, the distinction, whether Port 2 is used as general purpose I/0 or as "page address" is made by the external system design. From the device's point of view it cannot be decided whether the Port 2 data is used externally as address or as I/0 data!

Hence, a special page register is implemented into the SAB 80C517A to provide the possibility of accessing the XRAM also with the MOVX @Ri instructions, i.e. XPAGE serves the same function for the XRAM as Port 2 for external data memory.

Special Function Register XPAGE

	MSB							LSB	
Bit No.	7	6	5	4	3	2	1	0	
Addr. 91_H									XPAGE

The reset value of XPAGE is 00_H.

XPAGE can be set and read by software.

Figures 3-2 to **3-4** show the dependencies of XPAGE- and Port 2 - addressing in order to explain the differencies in accessing XRAM, ext. RAM or what is to do when Port 2 is used as an I/O-port.

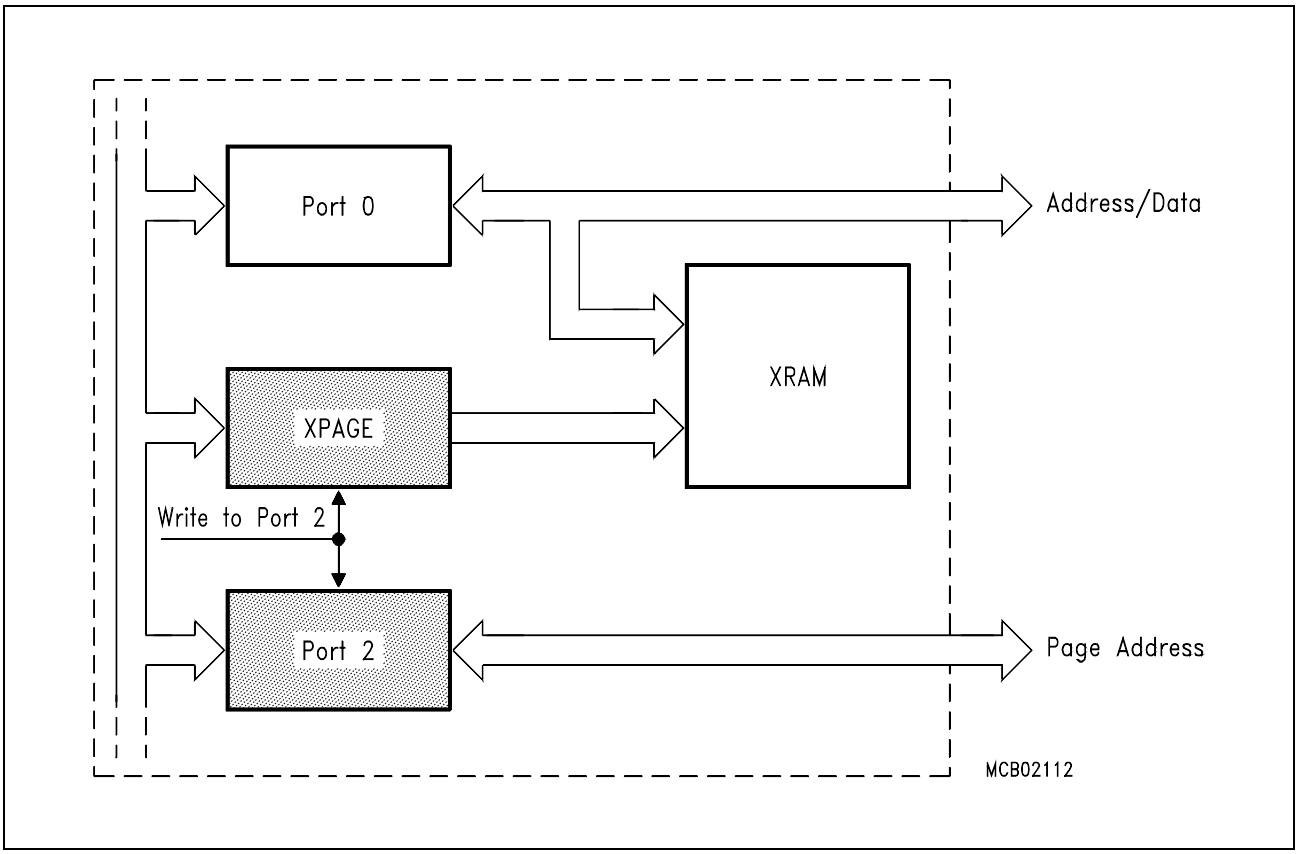


Figure 3-2
Write Page Address to Port 2

MOV P2, pageaddress will write the page address to Port 2 **and** XPAGE-Register.

When external RAM is to be accessed in the XRAM address range ($F800_H$ - $FFFF_H$) XRAM has to be disabled. When additional external RAM is to be addressed in an address range ≤ XRAM ($F800_H$) XRAM may remain being enabled and there is no need to overwrite XPAGE by a second move.

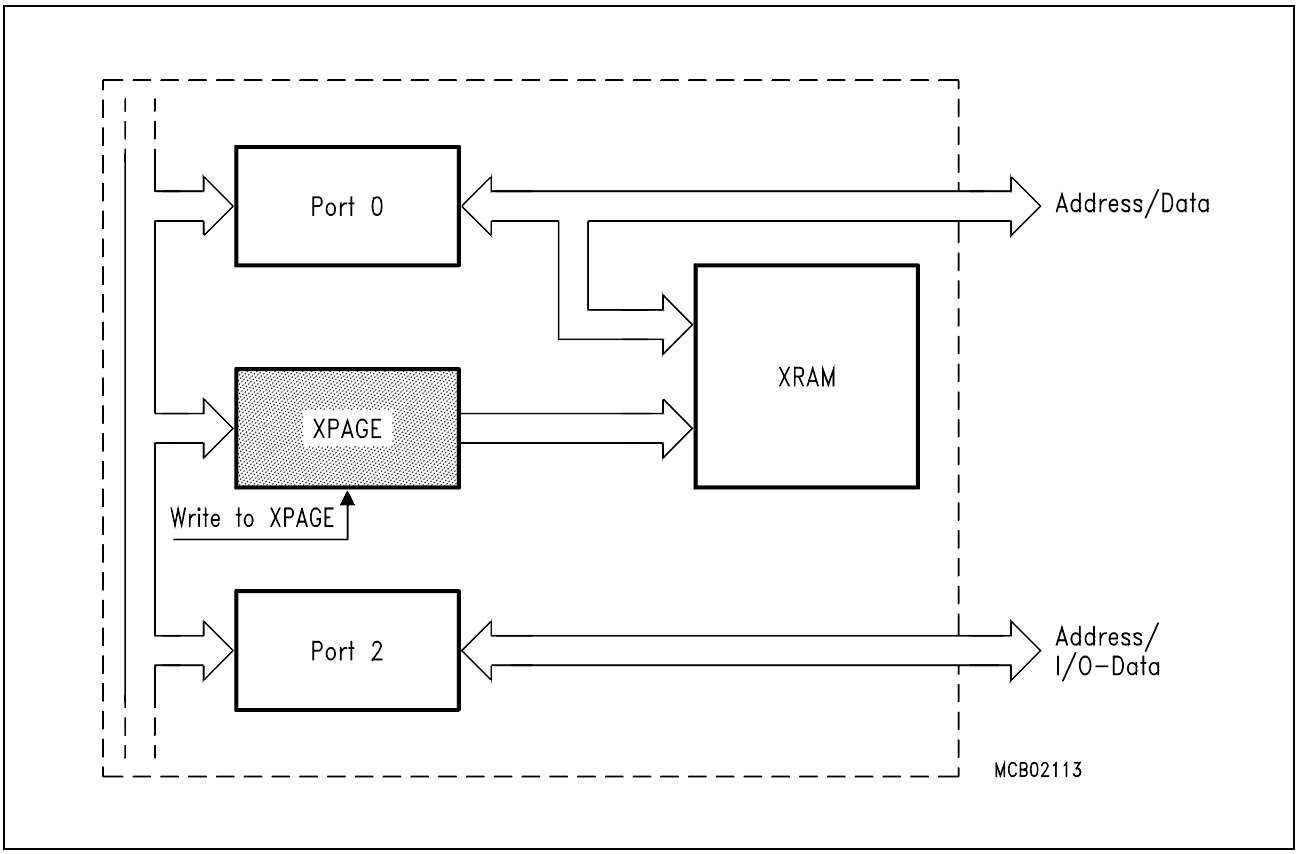


Figure 3-3
Write Page Address to XPAGE

The page address is only written to XPAGE-register. Port 2 is available for addresses or I/O-Data. See **figure 3-4** to see what happens when Port 2 is used as I/O-Port.

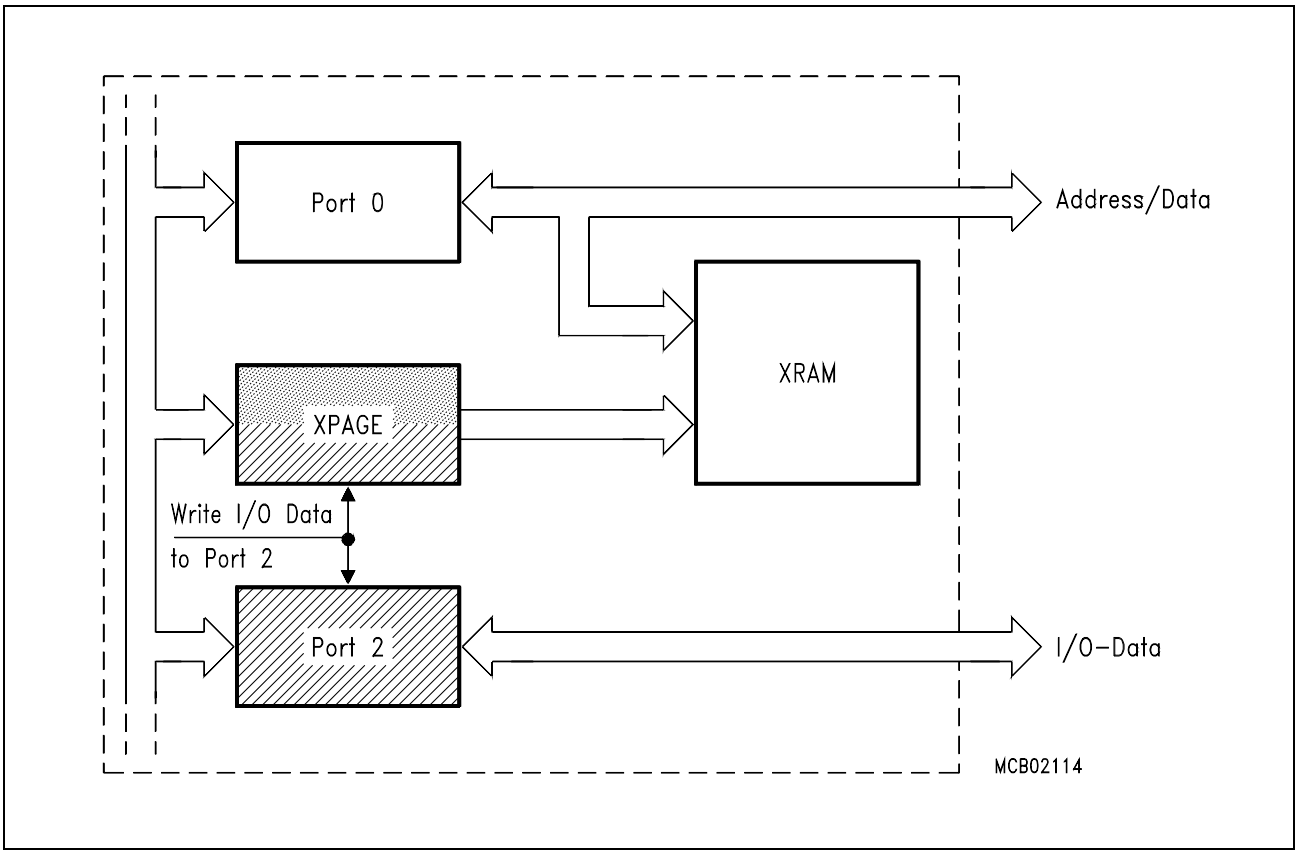


Figure 3-4
Use of Port 2 as I/O-Port

At a write to Port 2, XRAM address in XPAGE-register will be overwritten because of the concurrent write to Port 2 and XPAGE-register. So whenever XRAM is used and the XRAM address differs from the byte written to Port 2 latch it is absolutely nessesary to rewrite XPAGE with page address.

Example:

I/O-Data at Port 2 shall be 0AAH. A Byte shall be fetched from XRAM at address $0F830_H$

```
MOV R0, #30H
MOV P2, #0AAH                ; P2 shows 0AA_H
MOV XPAGE, #0F8H             ; P2 still shows 0AA_H but XRAM is addressed
MOVX A, @R0                  ; the contents of XRAM at 0F830_H is moved to accu
```

The register XPAGE provides the upper address byte for accesses to XRAM with MOVX @Ri instructions. If the address formed from XPAGE and Ri is less than the XRAM address range, then an external access is performed. For the SAB 80C517A the contents of XPAGE must be greater or equal than $F8_H$ in order to use the XRAM. Of course, the XRAM must be enabled if it shall be used with MOVX @Ri instructions.

Thus, the register XPAGE is used for addressing of the XRAM; additionally its contents are used for generating the internal XRAM select. If the contents of XPAGE is less than the XRAM address range then an external bus access is performed where the upper address byte is provided by P2 and not by XPAGE!

Therefore, the software has to distinguish two cases, if the MOVX @Ri instructions with paging shall be used:

a) Access to XRAM: The upper address byte must be written to XPAGE or P2; both writes selects the XRAM address range.

b) Access to external memory: The upper address byte must be written to P2; XPAGE will be loaded with the same address in order to deselect the XRAM.

The behaviour of Port0, Port2 and the $\overline{RD}$/$\overline{WR}$ signals depends on the state of pin $\overline{EA}$ and on the control bits XMAP0 and XMAP1 in register SYSCON.

3.4.2 Control of XRAM in the SAB 80C517A

There are two control bits in register SYSCON which control the use and the bus operation during accesses to the additional On-Chip RAM in XDATA range (≙ XRAM).

Special Function Register SYSCON

	MSB							LSB	
Bit No.	7	6	5	4	3	2	1	0	
Addr. $0B1_H$	–	–	–	–	–	–	XMAP1	XMAP0	SYSCON

Bit	Function
XMAP0	Global enable/disable bit for XRAM memory. XMAP0 = 0: The access to XRAM (= On-Chip XDATA memory) is enabled. XMAP0 = 1: The access to XRAM is disabled. All MOVX accesses are performed by the external bus.
XMAP1	Control bit for $\overline{RD}$/$\overline{WR}$ signals during accesses to XRAM; this bit has no effect if XRAM is disabled (XMAP0 = 1) or if addresses outside the XRAM address range are used for MOVX accesses. XMAP1 = 0: The signals $\overline{RD}$ and $\overline{WR}$ are not activated during accesses to XRAM. XMAP1 = 1: The signals $\overline{RD}$ and $\overline{WR}$ are activated during accesses to XRAM.

Reset value of SYSCON is XXXX XX01B.

The control bit XMAP0 is a global enable/disable bit for the additional On-Chip RAM (XRAM). If this bit is set, the XRAM is disabled, all MOVX accesses use external memory via the external bus. In this case the SAB80C517A can't use the additional On-Chip RAM and is compatible with the types without XRAM.

A hardware protection is done by an unsymetric latch at XMAP0-bit. A unintentional disabling of XRAM could be dangerous since indeterminate values could be read from external bus. To avoid this the XMAP-bit is forced to '1' only by reset. Additional during reset an internal capacitor is loaded. So the reset state is a disabled XRAM. Because of the load time of the capacitor XMAP0-bit once written to '0' (that is, discharging capacitor) cannot be set to '1' again by software. On the other hand any distortion (software hang up, noise,...) is not able to load this capacitor, too. That is, the stable status is XRAM enabled. The only way to disable XRAM after it was enabled is a reset.

The clear instruction for the XMAP0-bit should be integrated in the program initialization routine before XRAM is used. In extremely noisy systems the user may have redundant clear instructions.

The control bit XMAP1 is relevant only if the XRAM is accessed. In this case the external $\overline{RD}$ and $\overline{WR}$ signals at P3.6 and P3.7 are not activated during the access, if XMAP1 is cleared. For debug purposes it might be useful to have these signals available. This is performed if XMAP1 is set.

3.4.3 Behaviour of Port0 and Port2

The behaviour of Port 0 and P2 during a MOVX access depends on the control bits in register SYSCON and on the state of pin $\overline{EA}$. The **table 3-3** lists the various operating conditions. It shows the following characteristics:

a) Use of P0 and P2 pins during the MOVX access.
   Bus: The pins work as external address/data bus. If (internal) XRAM is accessed, the data read from the XRAM can not be seen on the bus.
   I/0: The pins work as Input/Output lines under control of their latch.
b) Activation of the $\overline{RD}$ and $\overline{WR}$ pin during the access.
c) Use of internal or external XDATA memory.

The shaded areas describe the standard operation as each 80C51 device without on-chip XRAM behaves.

		$\overline{EA}$ = 0			$\overline{EA}$ = 1		
		XMAP1, XMAP0			XMAP1, XMAP0		
		00	**10**	**X1**	**00**	**10**	**X1**
MOVX @DPTR	DPTR < XRAM address range	a)P0/P2→Bus b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0/P2→Bus b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0/P2→Bus b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0/P2→Bus b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0/P2→Bus b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0/P2→Bus b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used
	DPTR ≥ XRAM address range	a)P0/P2→Bus ($\overline{WR}$-Data only) b)$\overline{RD}$/$\overline{WR}$ inactive c)XRAM is used	a)P0/P2→Bus ($\overline{WR}$-Data only) b)$\overline{RD}$/$\overline{WR}$ active c)XRAM is used	a)P0/P2→Bus b)$\overline{RD}$/$\overline{WR}$ active c) ext.memory is used	a)P0/P2→I/O b)$\overline{RD}$/$\overline{WR}$ inactive c)XRAM is used	a)P0/P2→Bus ($\overline{WR}$-Data only) b)$\overline{RD}$/$\overline{WR}$ active c)XRAM is used	a)P0/P2→Bus b)$\overline{RD}$/$\overline{WR}$ active c) ext.memory is used
MOVX @ Ri	XPAGE < XRAM addr.page range	a)P0→Bus P2→I/O b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0→Bus P2→I/O b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0→Bus P2→I/O b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0→Bus P2→I/O b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0→Bus P2→I/O b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0→Bus P2→I/O b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used
	XPAGE ≥ XRAM addr.page range	a)P0→Bus ($\overline{WR}$-Data only) P2→I/O b)$\overline{RD}$/$\overline{WR}$ inactive c)XRAM is used	a)P0→Bus ($\overline{WR}$-Data only) P2→I/O b)$\overline{RD}$/$\overline{WR}$ active c)XRAM is used	a)P0→Bus P2→I/O b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used	a)P0/P2→I/O b)$\overline{RD}$/$\overline{WR}$ inactive c)XRAM is used	a)P0→Bus ($\overline{WR}$-Data only) P2→I/O b)$\overline{RD}$/$\overline{WR}$ active c)XRAM is used	a)P0→Bus P2→I/O b)$\overline{RD}$/$\overline{WR}$ active c)ext.memory is used

[shaded box] modes compatible to 8051-family

Table 3-3: Behaviour of P0/P2 and $\overline{RD}$/$\overline{WR}$ During MOVX Accesses

4 System Reset

4.1 Additional Hardware Power Down Mode in the SAB 80C517A

The SAB 80C517A has an additional Power Down Mode which can be initiated by an external signal at a dedicated pin. This pin is labeled $\overline{\text{HWPD}}$ and is a floating input line (active low). This pin substitutes one of the VSS pins of the base types SAB 80C517 (PLCC84: Pin60; P-MQFP-100-2: Pin36). Because this new power down mode is activated by an external hardware signal this mode is referred to as Hardware Power Down Mode in opposite to the program controlled Software Power Down Mode.

For a correct function of the Hardware Power Down Mode the oscillator watchdog unit including its internal RC oscillator is needed. Therefore this unit must be enabled by pin OWE (OWE = High), if the Hardware Power Down Mode shall be used. However, the control pin $\overline{\text{PE}}$/SWD has no control function for the Hardware Power Down Mode; it enables and disables only the use of all software controlled power saving modes (Slow Down Mode, Idle Mode, Software Power Down Mode).

The function of the new Hardware Power Down Mode is as follows:

The pin $\overline{\text{HWPD}}$ controls this mode. If it is on logic high level (inactive) the part is running in the normal operating modes. If pin $\overline{\text{HWPD}}$ gets active (low level) the part enters the Hardware Power Down Mode; as mentioned above this is independent of the state of pin $\overline{\text{PE}}$/SWD.

$\overline{\text{HWPD}}$ is sampled once per machine cycle. If it is found active, the device starts a complete internal reset sequence. This takes two machine cycles; all pins have their default reset states during this time. This reset has exactly the same effects as a hardware reset; i.e.especially the watchdog timer is stopped and its status flag WDTS is cleared. In this phase the power consumption is not yet reduced. After completion of the internal reset both oscillators of the chip are disabled, the on-chip oscillator as well as the oscillator watchdog's RC oscillator. At the same time the port pins and several control lines enter a floating state as shown in **table 4-1**. In this state the power consumption is reduced to the power down current IPD. Also the supply voltage can be reduced.
Table 4-1 also lists the voltages which may be applied at the pins during Hardware Power Down Mode without affecting the low power consumption.

Table 4-1, Status of all Pins During Hardware Power Down Mode

Pins	Status	Voltage Range at Pin During HW-Power Down
P0, P1, P2, P3, P4, P5, P6, P7, P8	Floating outputs / Disabled input function	$V_{SS} \le V_{IN} \le V_{CC}$
$\overline{EA}$	active input	$V_{IN} = V_{CC}$ or $V_{IN} = V_{SS}$
$\overline{PE}$/SWD	active input, Pull-up resistor disabled during HW power down	$V_{IN} = V_{CC}$ or $V_{IN} = V_{SS}$
XTAL1	active output	pin may not be driven
XTAL2	disabled input function	$V_{SS} \le V_{IN} \le V_{CC}$
$\overline{PSEN}$, ALE	Floating outputs / Disabled input function (for test modes only)	$V_{SS} \le V_{IN} \le V_{CC}$
VAREF, VAGND	active supply pins	$V_{AGnd} \le V_{IN} \le V_{CC}$
OWE	active input; must be at high level for start-up after HW PD; pull up resistor disabled during HW-power down	$V_{IN} = V_{CC}$ or ($V_{IN} = V_{SS}$)
$\overline{Reset}$	active input; must be on high level if HW PD is used	$V_{IN} = V_{CC}$
$\overline{R0}$	Floating output	$V_{SS} \le V_{IN} \le V_{CC}$

The power down state is maintained while pin $\overline{\text{HWPD}}$ is held active. If HWPD goes to high level (inactive state) an automatic start up procedure is performed:

- First the pins leave their floating condition and enter their default reset state as they had immediately before going to float state.
- Both oscillators are enabled (only if OWE = high). While the on-chip oscillator (with pins XTAL1 and XTAL2) usually needs a longer time for start-up, if not externally driven (with crystal approx. 1 ms), the oscillator watchdog's RC oscillator has a very short start-up time (typ. less than 2 microseconds)**.**
- Because the oscillator watchdog is active it detects a failure condition if the on-chip oscillator hasn't yet started. Hence, the watchdog keeps the part in reset and supplies the internal clock from the RC oscillator.
- Finally, when the on-chip oscillator has started, the oscillator watchdog releases the part from reset after it performed a final internal reset sequence and switches the clock supply to the on-chip oscillator. This is exactly the same procedure as when the oscillator watchdog detects first a failure and then a recovering of the oscillator during normal operation. Therefore, also the oscillator watchdog status flag is set after restart from Hardware Power Down Mode.
  When automatic start of the watchdog was enabled ($\overline{\text{PE}}$/SWD connected to V_{CC}), the Watchdog Timer will start, too (with its default reload value for time-out period).

The SWD-Function of the $\overline{\text{PE}}$/SWD Pin is sampled only by a hardware reset. Therefore at least one Power On Reset has to be performed.

4.2 Hardware Power Down Reset Timing

Following figures are showing the timing diagrams for entering (**figure 4-1**) and leaving (**figure 4-2**) the Hardware Power Down Mode. If there is only a short signal at pin $\overline{\text{HWPD}}$ (i.e. $\overline{\text{HWPD}}$ is sampled active only once), then a complete internal reset is executed. Afterwards the normal program execution starts again (**figure 4-3**).

Note:

Delay time caused by internal logic is not included.

The $\overline{\text{Reset}}$ pin overrides the Hardware Power Down function, i.e. if reset gets active during Hardware Power Down it is terminated and the device performs the normal reset function. Thus, pin $\overline{\text{Reset}}$ has to be inactive during Hardware Power Down Mode.

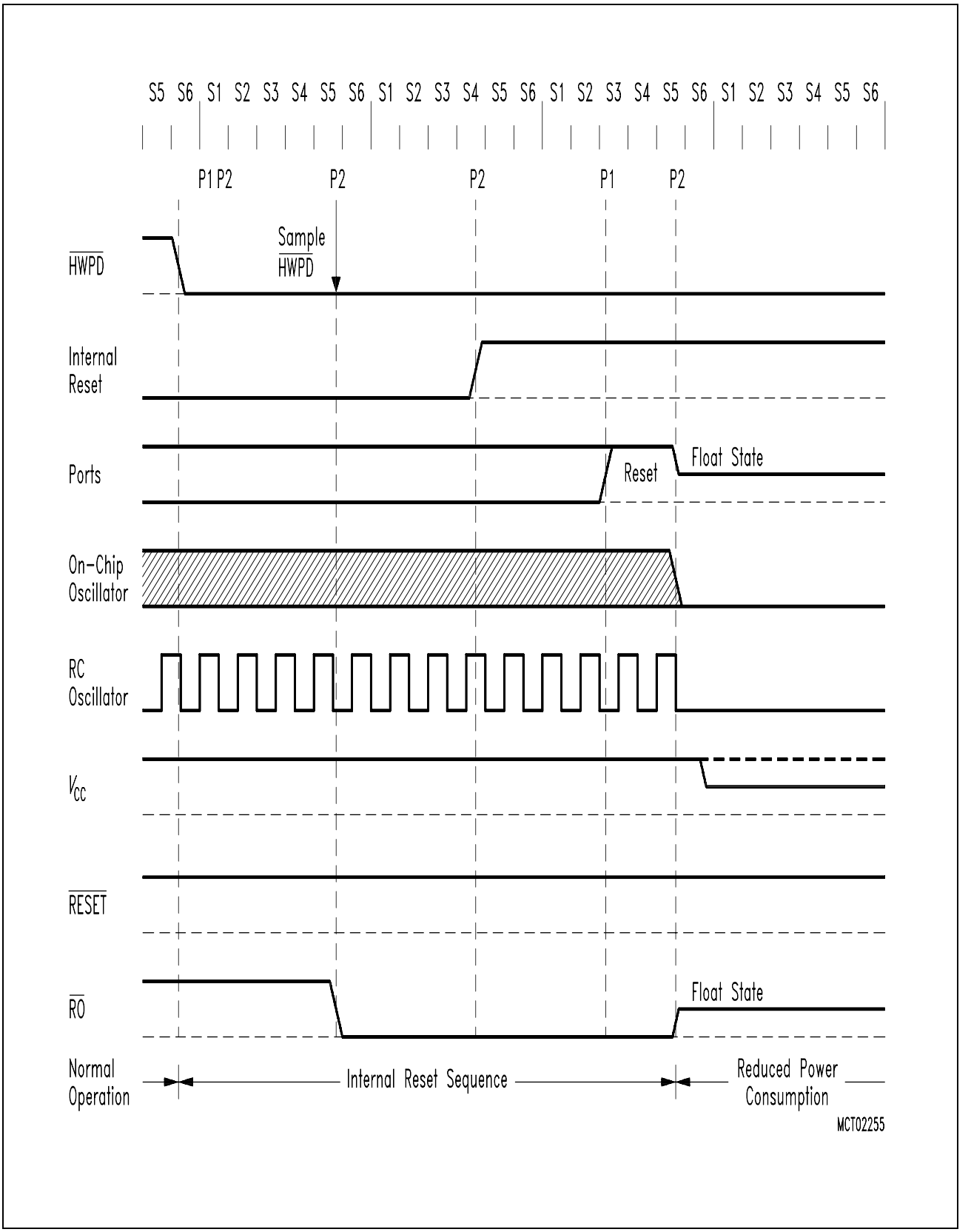


Figure 4-1
Timing Diagram of Entering Hardware Power Down Mode

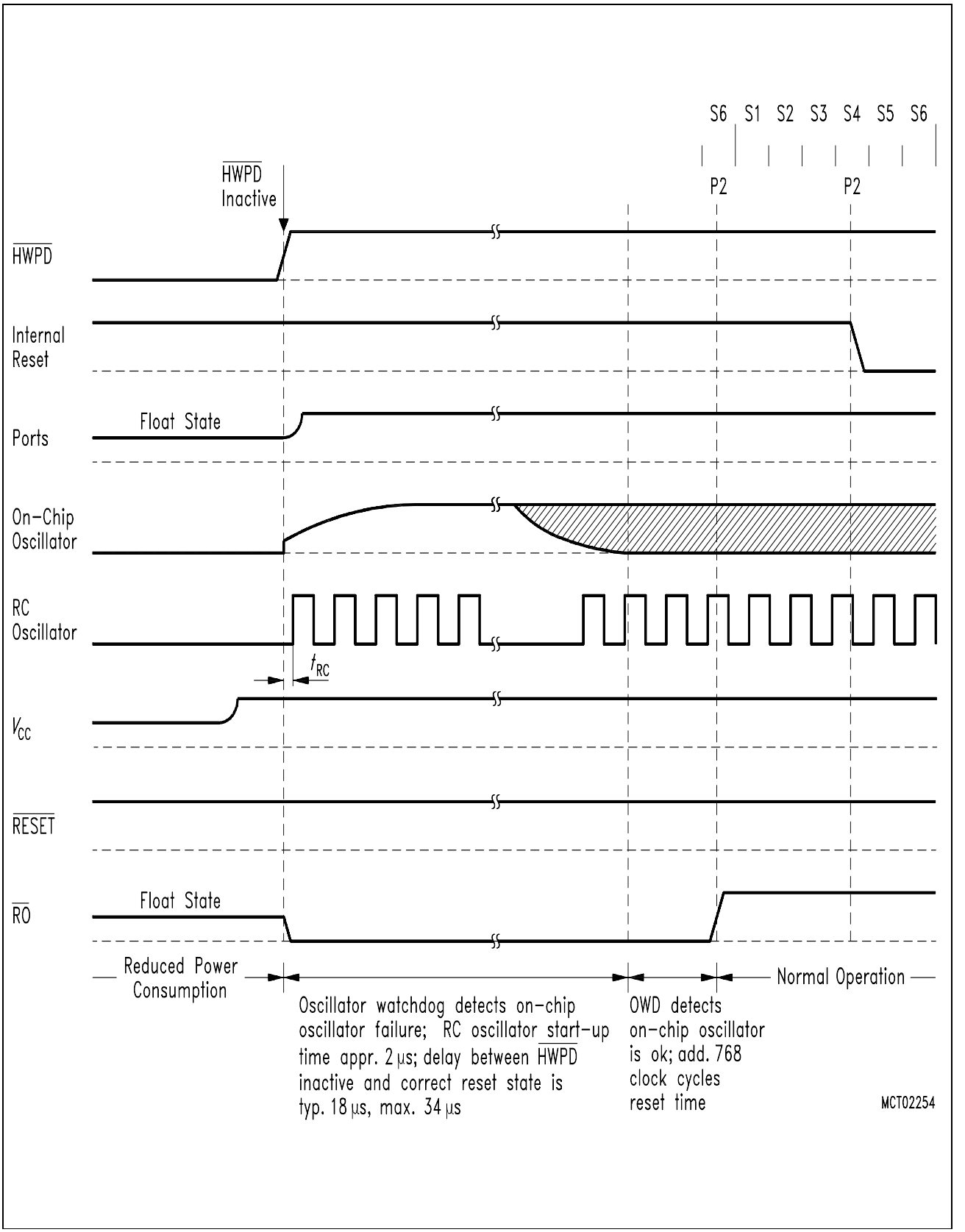


Figure 4-2
Timing Diagram of Leaving Hardware Power Down Mode

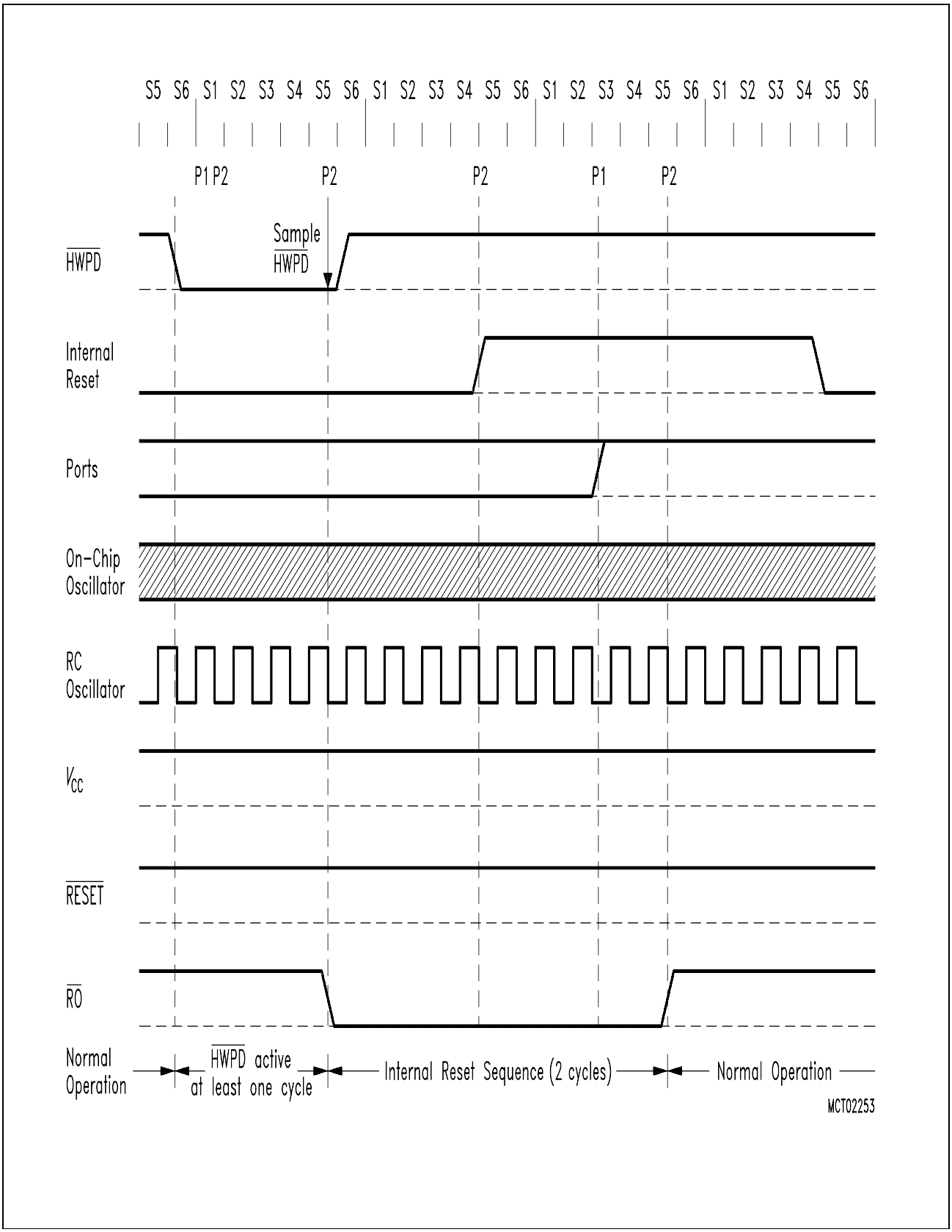


Figure 4-3
Timing Diagram of Hardware Power Down Mode, HWPD-Pin is Active for only one cycle

4.3 Fast internal Reset after Power-On

The SAB 80C517A can use the oscillator watchdog unit for a fast internal reset procedure after power-on.

Figure 4-4 shows the power-on sequence under control of the oscillator watchdog.

Normally the devices of the 8051 family (like the SAB 80C517) enter their default reset state not before the on-chip oscillator starts. The reason is that the external reset signal must be internally synchronized and processed in order to bring the device into the correct reset state. Especially if a crystal is used the start up time of the oscillator is relatively long (typ. 1ms). During this time period the pins have an undefined state which could have severe effects especially to actuators connected to port pins.

In the SAB 80C517A the oscillator watchdog unit can avoid this situation. For doing this, the oscillator watchdog must be enabled. In this case, after power-on the oscillator watchdog's RC oscillator starts working within a very short start-up time (typ. less than 2 microseconds). In the following the watchdog circuitry detects a failure condition for the on-chip oscillator because this has not yet started (a failure is always recognized if the watchdog's RC oscillator runs faster than the on-chip oscillator). As long as this condition is detected the watchdog uses the RC oscillator output as clock source for the chip rather than the on-chip oscillator's output. This allows correct resetting of the part and brings also all ports to the defined state (**see figure 4-4, I**). The time period from power-on till reaching the reset state at the ports adds from the following terms:

- RC oscillator start-up < 2 µs
- synchronization of the RC oscillators divider-by-5 < 6 T
- synchronization of the state and cycle counters < 6 T
- reset procedure till correct port states are reached < 12T

Delay between power-on and correct reset state:

Typ.: 18 µs
Max.: 34 µs

After the on-chip oscillator finally has started, the oscillator watchdog detects the correct function; then the watchdog still holds the reset active for a time period of 768 cycles of the RC oscillator in order to allow the oscillation of the on-chip oscillator to stabilize (**figure 4-4, II**). Subsequently the clock is supplied by the on-chip oscillator and the oscillator watchdog's reset request is released (**figure 4-4, III**). However, an externally applied reset still remains (**figure 4-4, IV**) active and the device does not start program execution (**figure 4-4, V**) before the external reset is also released.

Although the oscillator watchdog provides a fast internal reset it is additionally necessary to apply the external reset signal when powering up. The reasons are as follows:

- Termination of Hardware Power Down Mode (a $\overline{\text{HWPD}}$ signal is overridden by reset)
- Termination of Software Power Down Mode
- Reset of the status flag OWDS that is set by the oscillator watchdog during the power up sequence.

The external reset signal must be hold active at least until the on-chip oscillator has started and the internal watchdog reset phase is completed. An external reset time of more than 5 ms should be sufficient in typical applications. If only a capacitor at pin $\overline{\text{Reset}}$ is used a value of 100 nF provides the desired reset time.

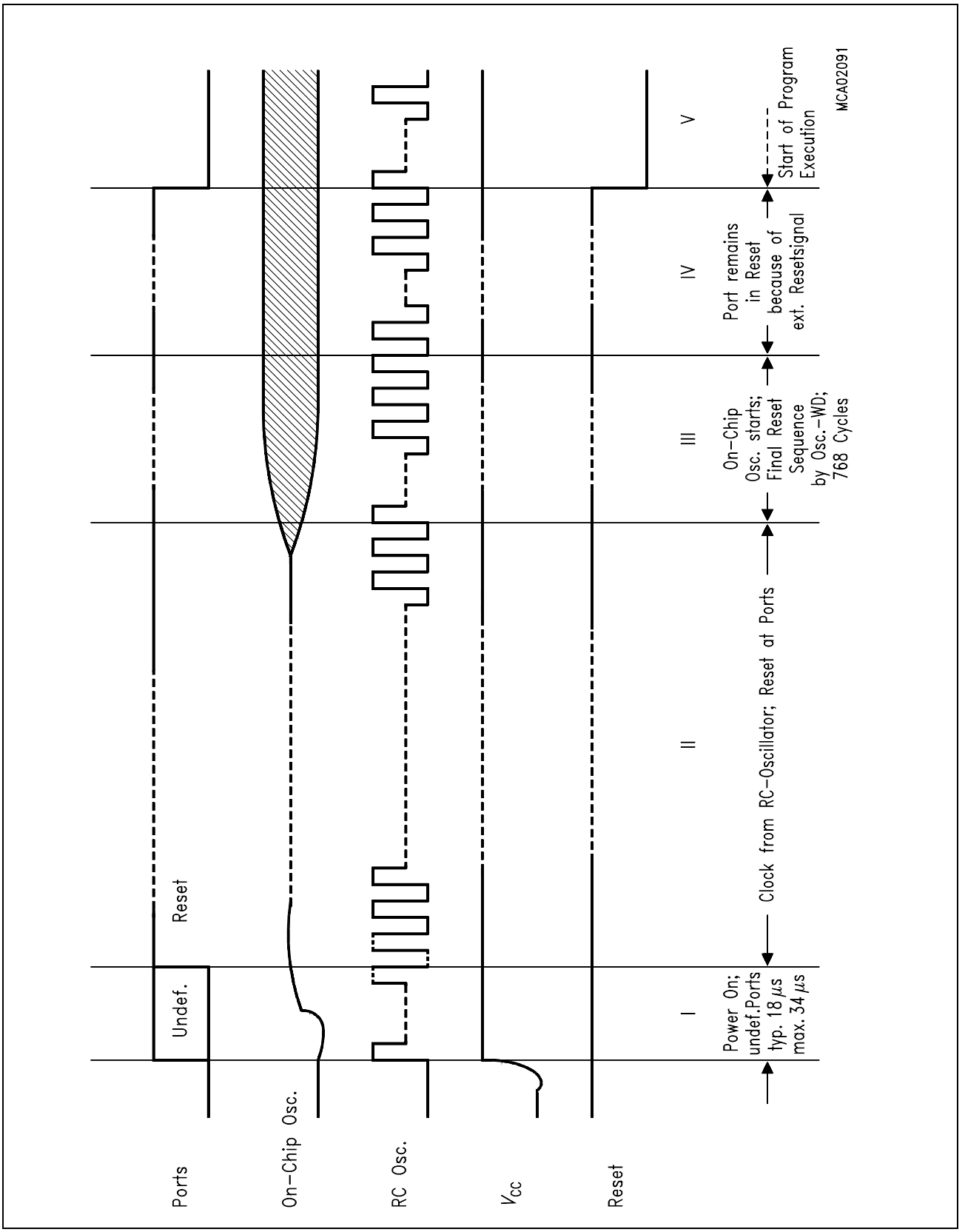


Figure 4-4
Power-On of the SAB 80C517A

5 On-Chip Peripheral Components

5.1 Digital I/O Port Circuitry

To realize the Hardware Power Down Mode with floating Port pins in the SAB 80C517A/83C517A 5 the standard port structure used in the 8051 Family is modified (**figure 5-1**).

The FETs p4, p5 and n2 are added. During Hardware Power Down this FETs disconnect the port pins from internal logic.

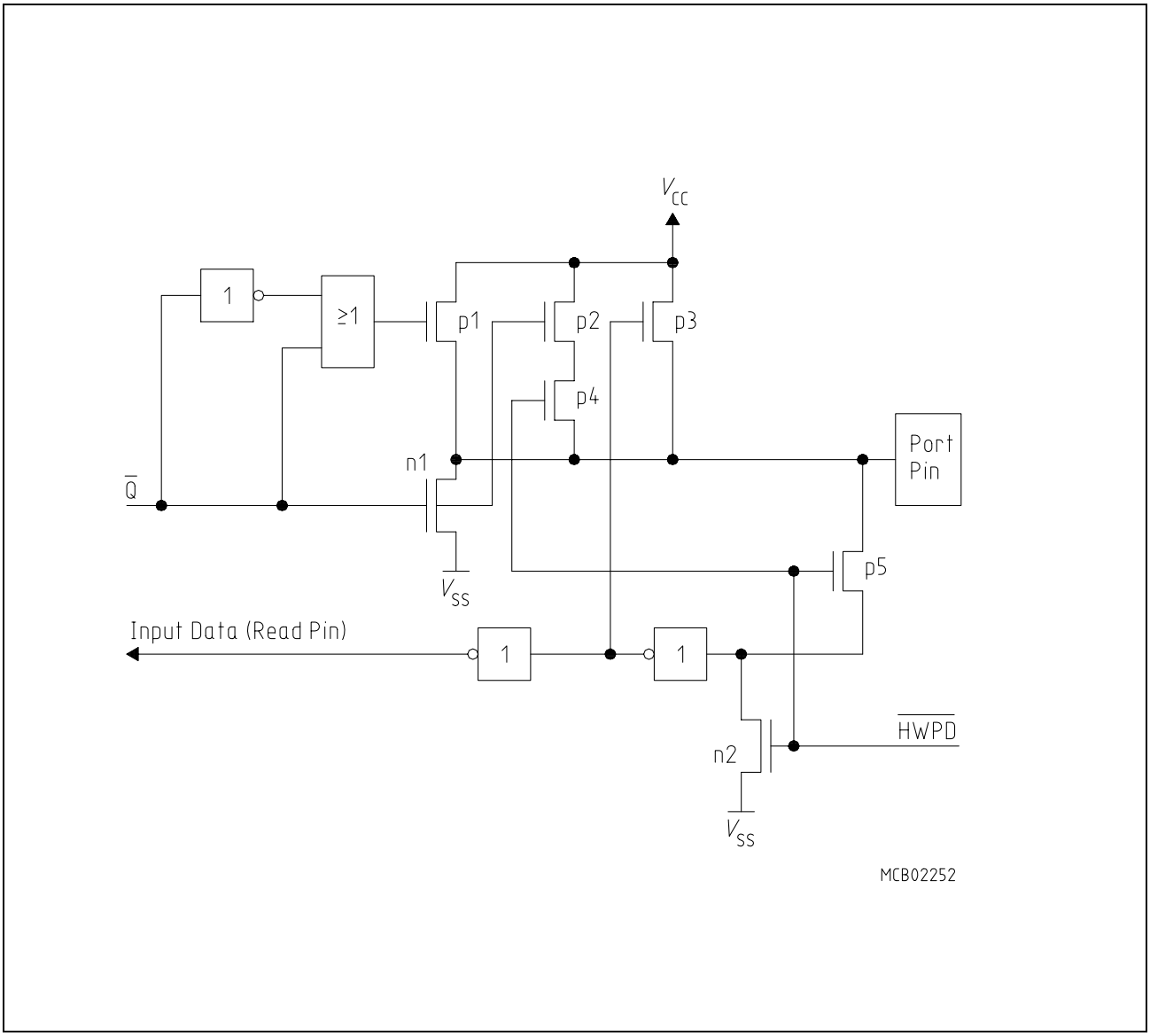


Figure 5-1
Port Structure

P1 and p3 are not active during Hardware Power Down.
P1 is activated only for two oscillator periods if a 0-to-1 transition is programmed to the port pin (not possible during HWPD).
P3 is turned off during reset state (also HWPD).
For detailled description of the port structure please refer to the SAB 80C517/80C537 User's Manual.

5.2 10-bit A/D-Converter

In the SAB 80C517A is a new high performance / high speed 12-channel 10-bit A/D-Converter is implemented. Its successive approximation techniqe provides 7 µs conversion time (f_{OSC}=16 MHz). The conversion principle is upward compatible to the one used in the SAB 80C517. The major components are shown in **figure 5-1**.

The comparator is a fully differential comparator for a high power supply rejection ratio and very low offset voltages. The capacitor network is binary weighted providing 10-bit resolution.

The **table 5-1** below shows the sample time T_S and the conversion time T_C (including T_S), which depend on f_{OSC} and the selected prescaler (see also Bit ADCL in SFR ADCON 1).

Table 5-1, ADC-Convertion Time

f_{OSC}[MHz]	Prescaler	f_{ADC}[MHz]	T_S [µs]	T_C [µs] (incl. T_S)
12	÷ 8	1.5	1.33	8
	÷ 16	0.75	2.8	16
16	÷ 8	2.0	2.0	7.0
	÷ 16	1.0	4.0	14.0
18	÷ 8	–	–	–
	÷ 16	1.125	3.555	12.4

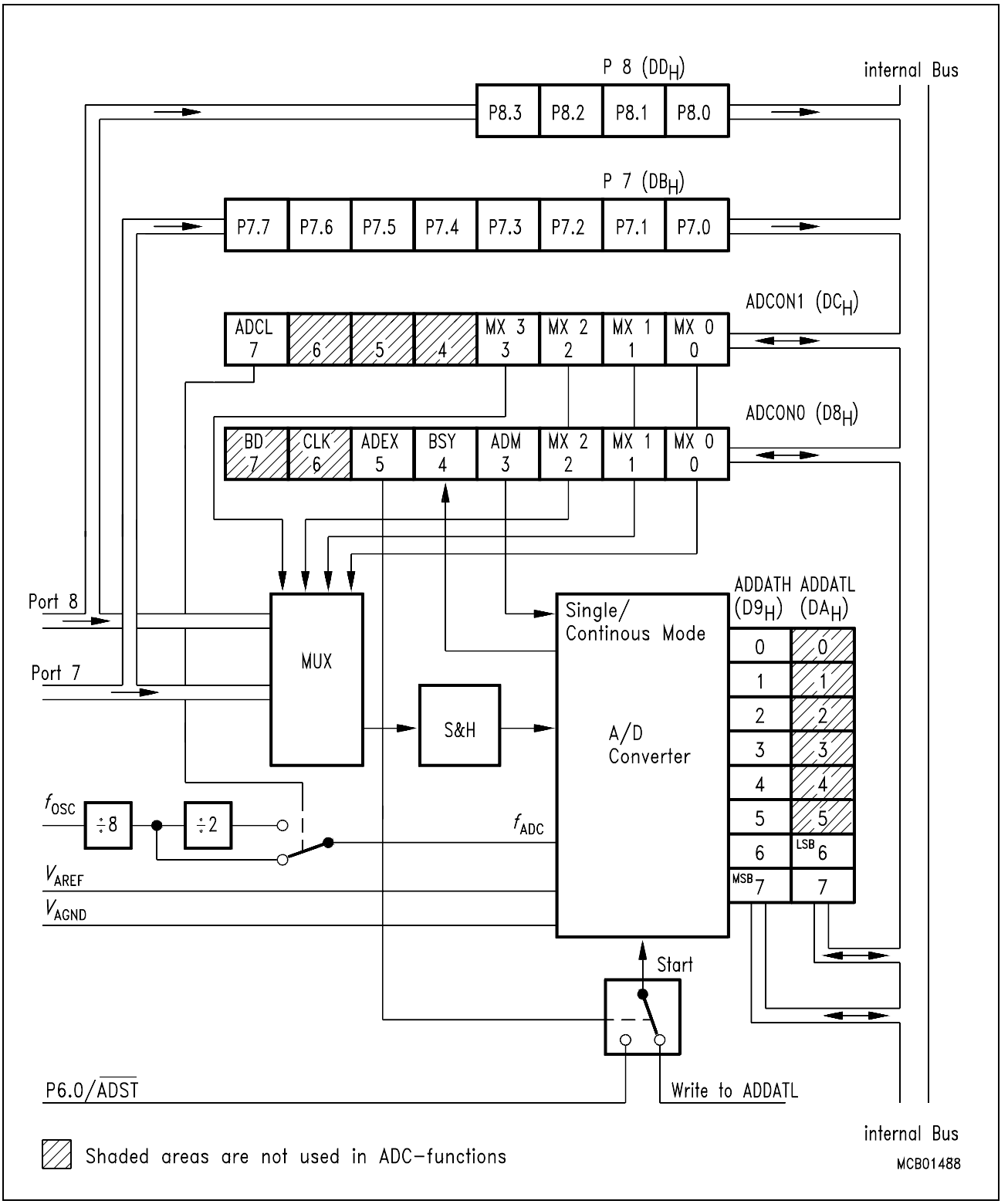


Figure 5-1
10-Bit A/D-Converter

Special Function Registers ADCON0, ADCON1

	MSB							LSB	
Bit No.	7	6	5	4	3	2	1	0	
Addr. $0D8_H$	BD	CLK	ADEX	BSY	ADM	MX2	MX1	MX0	ADCON0

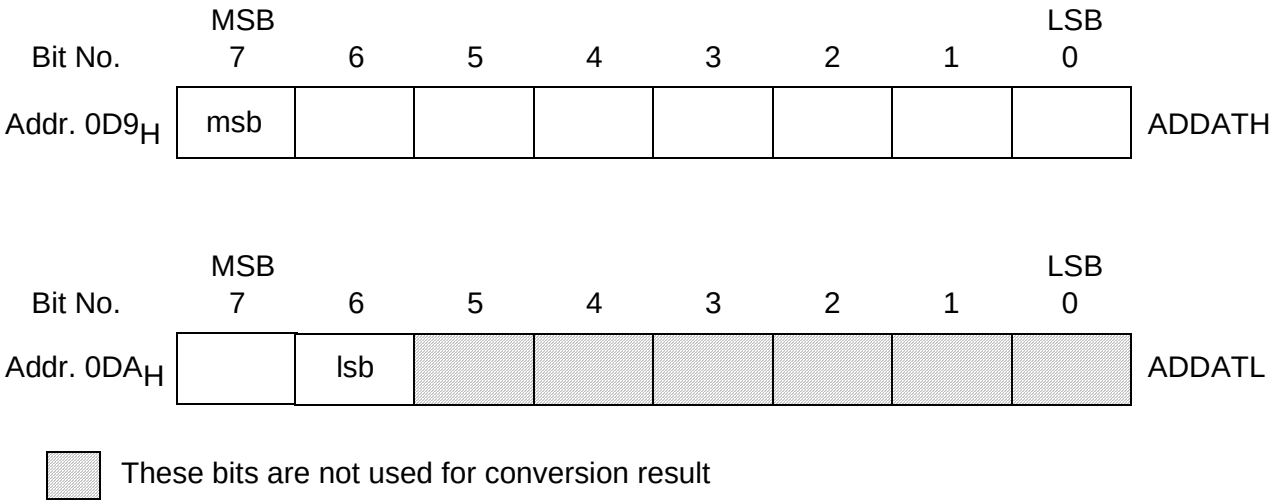
	MSB							LSB	
Bit No.	7	6	5	4	3	2	1	0	
Addr. $0DC_H$	ADCL				MX3	MX2	MX1	MX0	ADCON1

These bits are not used in controlling A/D converter functions in the 80C517A

Bit	Function
ADEX	Internal / external start of conversion. When set, the external start of conversion by P6.0 / $\overline{ADST}$ is enabled.
BSY	Busy flag. This flag indicates whether a conversion is in progress (BSY = 1). The flag is cleared by hardware when the conversion is finished.
ADM	A/D Conversion mode. When set, a continous conversion is selected. If cleared, the converter stops after one conversion.
MX3 - MX0	Select 12 input channels of the ADC. Bits MX0 to MX2 con be written or read either in ADCON0 or in ADCON1.
ADCL	ADC Clock. When set $f_{ADC} = f_{OSC} / 16$. Has to be set when $f_{OSC} > 16$ MHz

The reset value of ADCON0 and ADCON1 is 00_H

Special Function Register ADDATH, ADDATL



The reset value of ADDATH and ADDATL is 00_H.

The registers **ADDATH** (0D9H) and **ADDATL** (0DAH) contain the 10-bit conversion result. The data is read as two 8-bit bytes. Data is presented in left justified format (i.e. the msb is the most left-hand bit in a 16-bit word). To get a 10-bit conversion result two READ operations are required. Otherwise ADDATH contains the 8-bit conversion result.

A/D Converter Timing

After a conversion has been started (by a write to ADDATL, external start by P6.0/$\overline{\text{ADST}}$ or in continous mode) the analog input voltage is sampled for 4 clock cycles. The analog source must be capable of charging the capacitor network of appr. 50 pF to full accuracy in this time. During this period the converter is susceptable to spikes and noise at the analog input, which may cause wrong codes at the digital outputs. Therefore RC-filtering at the analog inputs is recommended (see **figure 5-2** below).

Conversion of the sampled analog voltage takes place between the 4th an 14th clock cycle.

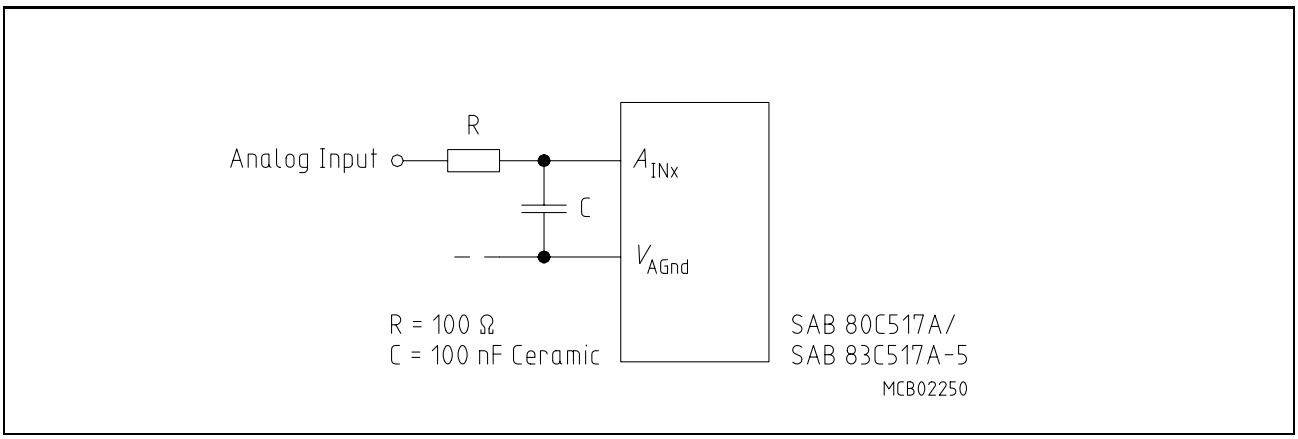


Figure 5-2
Recommended RC-filtering at the Analog Inputs

5.3 Additional Compare Mode for the Concurrent Compare Unit

The SAB 80C517A has an additional compare mode (compare mode 2) in the Compare/Capture Unit which can be used for the Concurrent Compare Output at P5. In this compare mode 2 the P5 pins are no longer general purpose I/O pins or under control of compare/capture register CC4, but under control of the new compare registers COMSET and COMCLR. These both 16-bit registers are always associated with Timer 2 (same as CRC, CC1 to CC4). Each of these registers consists of two 8-bit portions, i.e COMSET consists of COMSETL (address $0A1_H$) and COMSETH (address $0A2_H$), COMCLR consists of COMCLRL (address $0A3_H$) and COMCLRH (address $0A4_H$)

In compare mode 2 the concurrent compare output pins on Port 5 are used as follows (**see figure 5-3**):

- When a compare match occurs with register COMSET, a high level appears at the pins of port 5 whose corresponding bits in the mask register SETMSK (address $0A5_H$) are set.
- When a compare match occurs in register COMCLR, a low level appears at the pins of port 5 whose corresponding bits in the mask register CLRMSK (address $0A6_H$) are set.
- Additionally the Port 5 pins used for compare mode 2 may also be directly written to by write instructions to SFR P5. Of course, the pins can also be read under program control.

If compare mode 2 shall be selected register CC4 must operate in compare mode 1 (with the corresponding output pin P1.4); thus, compare mode 2 is selected by enabling compare function for register CC4 (COCAH4=1; COCAL4=0 SFR CC4EN) and by programming bits COCOEN0 and COCOEN1 in SFR CC4EN. Like in concurrent compare mode associated with CC4, the number of port pins at P5 which serve the compare output function can be selected by bits COCON0-COCON2 (in SFR CC4EN). If a set and reset request occurs at the same time (identical values in COMSET and COMCLR), the set operation takes precedence. It is also possible to use only the interrupts which are generated by matches in COMSET and COMCLR without affecting P5 ("software compare"). For this "interrupt-only" mode it is not necessary that the compare function at CC4 is selected.

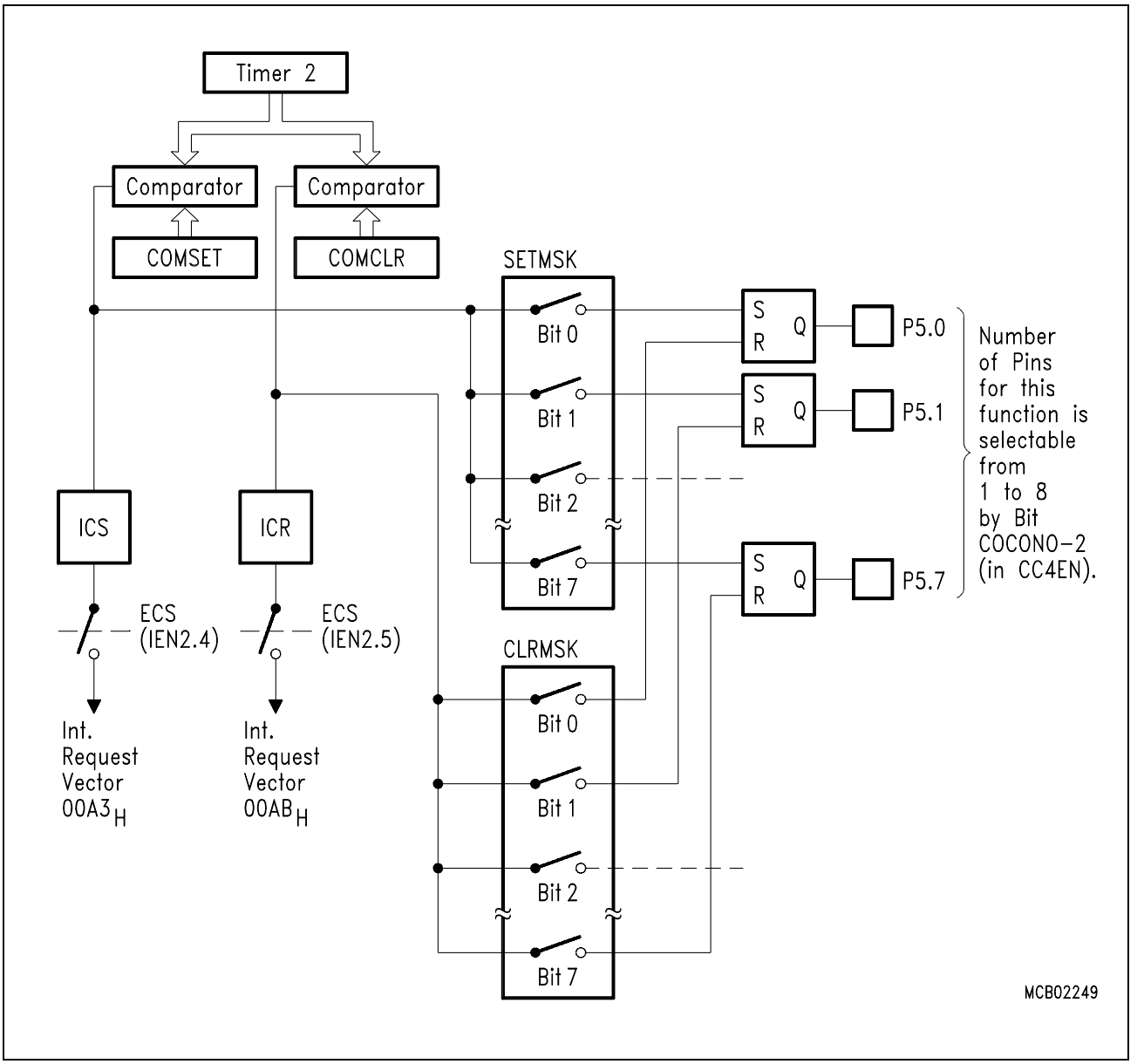


Figure 5-3
Compare Mode 2 (Port 5 only)

Special Function Register CC4EN

Bit No.	MSB 7	6	5	4	3	2	1	LSB 0	
$0C9_H$	COCOEN1	COCON2	COCON1	COCON0	COCOEN0	COCAH4	COCAL4	COM0	CC4EN

Bit	Function
COCON2 COCON1 COCON0	Selects number of compare outputs at P5 (for compare modes 1 and 2); **see table 2-2**
COCAH4 COCAL4 0 0 0 1 1 0 1 1	Compare/capture mode for register CC4 and compare modes 1 and 2 at P5 Compare/capture at CC4 disabled Capture on falling/rising edge at pin P1.4/$\overline{INT2}$/CC4 Compare enabled at CC4 Capture on write operation into register CCL4
COCOEN1 COCOEN0	Selection of compare modes 1 and 2 at P5; valid only in combination with certain configurations in COCAH4, COCAL4; **see table 2-3** Setting of bit COCOEN0 automatically sets COM0
COM0	Compare Mode for register CC4 COM0 = 0 selects compare mode 0 COM0 = 1 selects compare mode 1 Setting of bit COCOEN0 automatically sets COM0

The reset value of SFR CC4EN is 00_H.

COCON2	COCON1	COCON0	Function
0	0	0	One additional output of CC4 at P5.0
0	0	1	Additional outputs of CC4 at P5.0 to P5.1
0	1	0	Additional outputs of CC4 at P5.0 to P5.2
0	1	1	Additional outputs of CC4 at P5.0 to P5.3
1	0	0	Additional outputs of CC4 at P5.0 to P5.4
1	0	1	Additional outputs of CC4 at P5.0 to P5.5
1	1	0	Additional outputs of CC4 at P5.0 to P5.6
1	1	1	Additional outputs of CC4 at P5.0 to P5.7

Table 5-3, Configurations for Concurrent Compare Mode and Compare Mode 2 at P5

COCAH4	COCAL4	COCOEN1	COCOEN0	Function of CC4	Function of Compare Modes at P5
0	0	0	0	Compare / Capture disabled	Disabled
0	0	1	0	Compare / Capture disabled	Compare mode 2 selected, but only interrupt generation (ICR, ICS); no output signals
0	0	1	1	Compare / Capture disabled	Compare Mode 2 selected at P5
0	1	0	0	Capture on falling/ rising edge at pin P1.4/$\overline{INT2}$/CC4	Disabled
0	1	1	0	–	Compare modes 2 selected, but olny interrupt generation (ICR, ICS); no output signals at P5
1	0	0	0	Compare enable at CC4; Mode $^0/_1$ is selected by COM0	Disabled
1	0	0	1	Compare mode 1 enabled at CC4; COM0 is automatically set	Concurrent compare (mode 1) selected at P5
1	0	1	0	Compare enable at CC4; mode $^0/_1$ is selected by COM0	Compare mode 2 selected, but only interrupt generation (ICR, ICS); no output signals at P5
1	0	1	1	Compare mode 1 enabled at CC4; COM0 is automatically set	Compare Mode 2 selected at P5
1	1	0	0	Capture on write operation into register CCL4	Disabled
1	1	1	0	Capture on write operation into register CCL4	Compare mode 2 selected, but only interrupt generation (ICR, ICS); no output signals at P5

The other combinations are reserved and must not be used.

The following **table 5-4** lists the SFR's with their addresses and default values after reset which are used in compare mode 2:

Table 5-4, Compare Mode 2, used SFR's and their default Reset Value

SFR	Address	Default Value after Reset
COMSETL	$0A1_H$	00_H
COMSETH	$0A2_H$	00_H
COMCLRL	$0A3_H$	00_H
COMCLRH	$0A4_H$	00_H
SETMSK	$0A5_H$	00_H
CLRMSK	$0A6_H$	00_H
CTCON	$0E1_H$	$0X00\ 0000_B$
CC4EN	$0C9_H$	00_H

The compare registers COMSET and COMCLR have their dedicated interrupt vectors. The corresponding request flags are ICS for register COMSET and ICR for register COMCLR. The flags are set by a match in registers COMSET and COMCLR, when enabled. As long as the match condition is valid the request flags can't be reset (neither by hardware nor software). The request flags are located in SFR CTCON.

Special Function Register CTCON

Bit No.	MSB 7	6	5	4	3	2	1	LSB 0	
$0BA_H$	T2PS1	–	ICR	ISC	CTF	CLK2	CLK1	CLK0	CTCON

Bit	Function
CLK0 CLK1 CLK2 CTF	Same function as SAB 80C517
ICS	Interrupt request flag for Compare register COMSET. ICS is set when a compare match occured. Cleared when interrupt is processed.
ICR	Interrupt request flag for Compare register COMRES. ICR is set when a compare match occured. Cleared when interrupt is processed.
T2PS1	Prescaler select bit for Timer 2. **See table 5-5**

The default value of CTCON after reset is 0X00 0000B

Extended Prescaler for Timer 2

The prescaler for Timer 2 has an extended range. This prescaler divides the input clock for Timer 2 when it is operated in timer mode. In addition to the ÷ 2 option there are now scale ratings of ÷ 4 and ÷ 8 available. The rate is selected by the control bits T2PS (T2CON.7) and T2PS1 (CTCON.7). **Table 5-5** lists all available options. This prescaler must not be used when Timer 2 is operated in counter mode.

Table 5-5, Timer 2 Prescaler

T2PS1 (CTCON.7)	T2PS (T2CON.7)	Prescaler Ratio
0	0	÷ 1
0	1	÷ 2
1	0	÷ 4
1	1	÷ 8

5.4 New Baud Rate Generators for Serial Channel 0 and Serial Channel 1

5.4.1 Serial Channel 0 Baud Rate Generator

The Serial Channel 0 has a new baud rate generator which provides greater flexibility and better resolution. It substitutes the 80C517's baud rate generator at Serial Channel 0 which provides only 4.8 kBaud or 9.6 kBaud at 12 MHz crystal frequency. Since the new generator offers greater flexibility it is often possible to use it instead of Timer1 which is then free for other tasks.

Figure 5-4 shows a block diagram of the new baud rate generator for Serial Channel 0. It consists of a free running 10-bit timer with f_{OSC} /2 input frequency. On overflow of this timer there is an automatic reload from the registers S0RELL (address AA_H) and S0RELH (address BA_H). The lower 8 bits of the timer are reloaded from S0RELL, while the upper two bits are reloaded from bit 0 and 1 of register S0RELH. The baud rate timer is reloaded by writing to S0RELL.

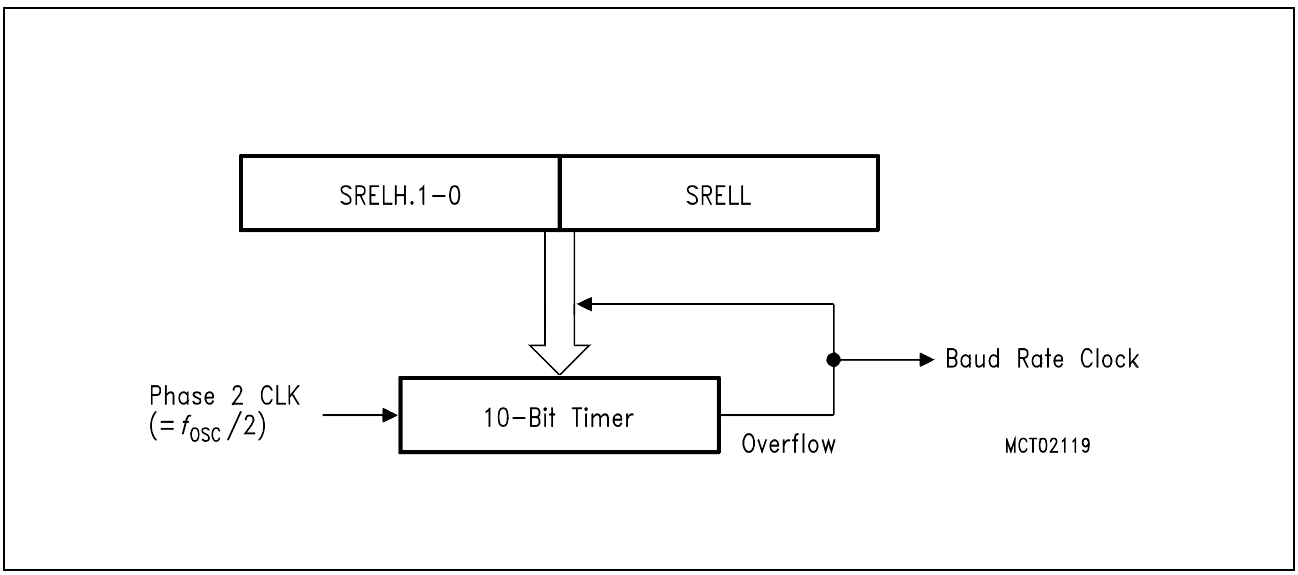
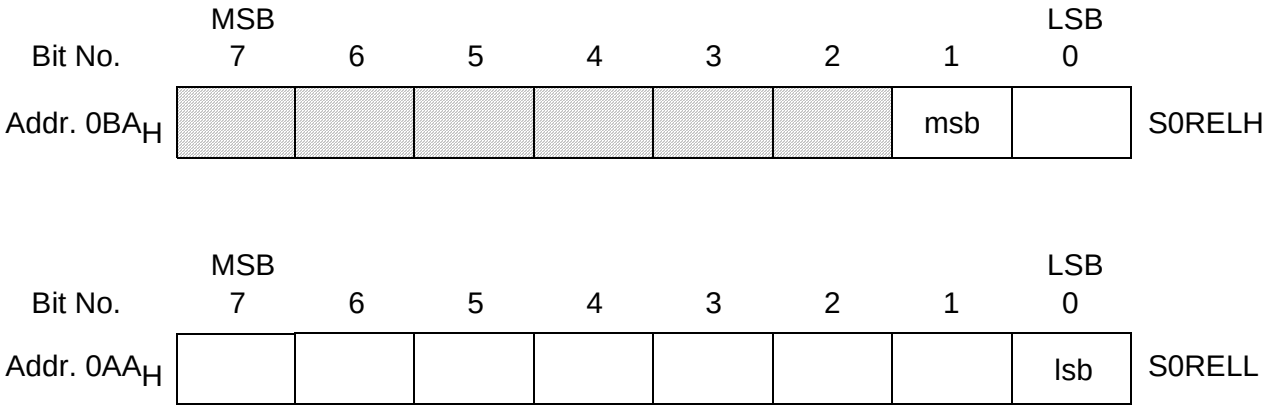


Figure 5-4
Baud Rate Generator for Serial Interface 0

The default value after reset of S0RELL is $0D9_H$, S0 RELH contains XXXX XX11B.

Special Function Register S0RELH, S0RELL



Bit	Function
S0RELH.0-1	Reload value. Upper two bits of the timer reload value.
S0RELL.0-7	Reload value. Lower 8 bit of timer reload value.

Reset value of S0RELL is 0D9$_H$, S0RELH contains XXXX XXX11B.

Figure 5-5 shows a block diagram of the options available for baud rate generation of Serial Channel 0. It is a fully compatible superset of the functionality of the SAB 80C517. The new baud rate generator can be used in modes 1 and 3 of the Serial Channel 0. It is activated by setting bit BD (ADCON0.7). This also starts the baud rate timer. When Timer1 shall be used for baud rate generation, bit BD must be cleared. In any case, bit SMOD (PCON.7) selects an additional divider by two.

The default values after reset in registers S0RELL and S0RELH provide a baud rate of 4.8 kBaud (with SMOD = 0) or 9.6 kBaud (with SMOD = 1) at 12 MHz oscillator frequency. This guarantees full compatibility to the SAB 80C517.

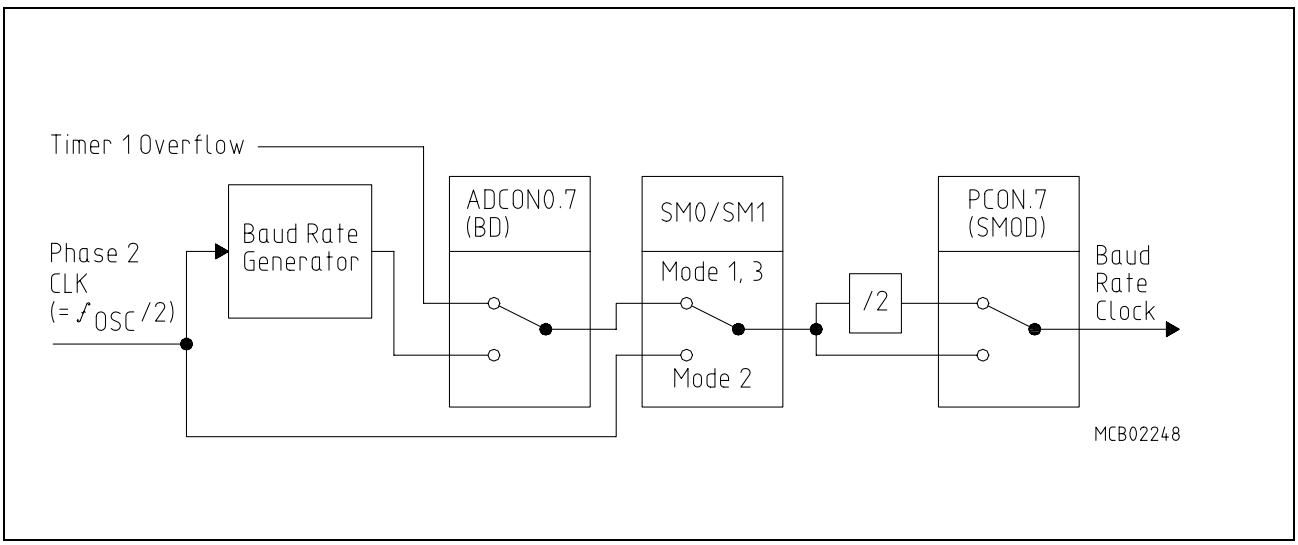


Figure 5-5
Block Diagram of Baud Rate Generation for Serial Interface 0

If the new baud rate generator is used the baud rate of Serial Channel 0 in Mode 1 and 3 can be determined as follows:

$$\text{Mode 1, 3 baud rate} = \frac{2^{SMOD} \times \text{oscillator frequency}}{64 \times (2^{10} - \text{S0REL})}$$

with S0REL = S0RELH.1 – 0, S0RELL.7 – 0

5.4.2 Serial Channel 1 Baud Rate Generator

A new baud rate generator for Serial Channel 1 now offers a wider range of selectable baud rates. Especially a baud rate of 1200 baud can be achieved now.

The baud rate generator itself is identical with the one used for Serial Channel 0. It consists of a free running 10-bit timer with F_{OSC} /2 input frequency. On overflow of this timer there is an automatic reload from the registers S1RELL (address $9D_H$) and S1RELH (address BB_H). The lower 8 bits of the timer are reloaded from S1RELL, while the upper two bits are reloaded from bit 0 and 1 of register S1RELH. The baud rate timer is reloaded by writing to S1RELL.

The baud rate in mode A and B can be determined by the following formula:

$$\text{Mode A, B baud rate} = \frac{\text{oscillator frequency}}{32 \times (2^{10} - \text{S1REL})}$$

with S1REL = S1RELH.1 – 0, S1RELL.7 – 0

Figure 5-6 shows a block diagram of the baud rate generator for Serial Interface 1.

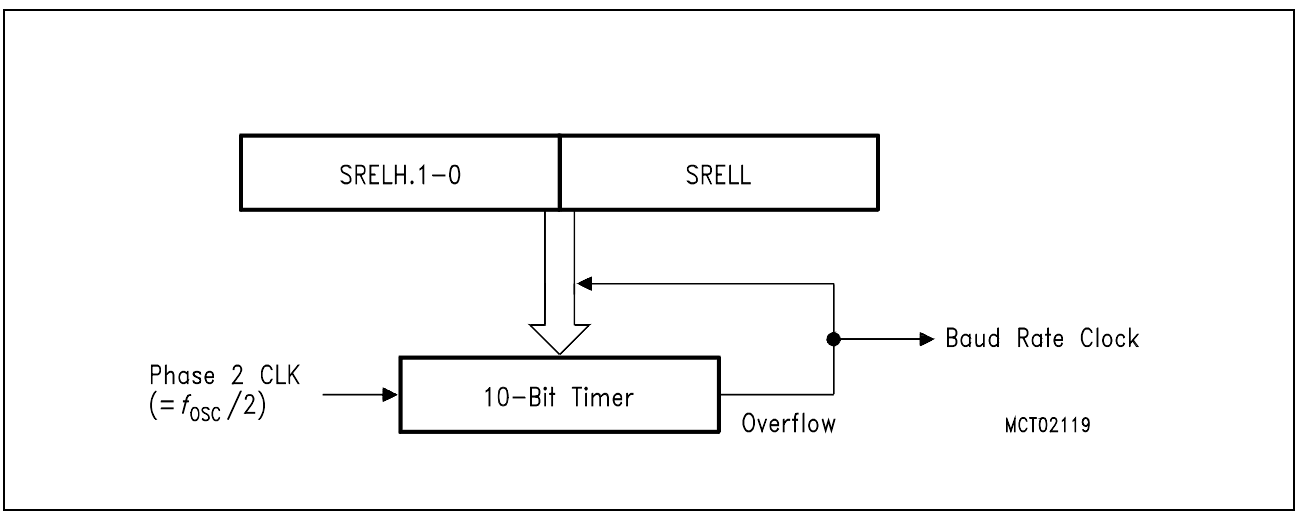
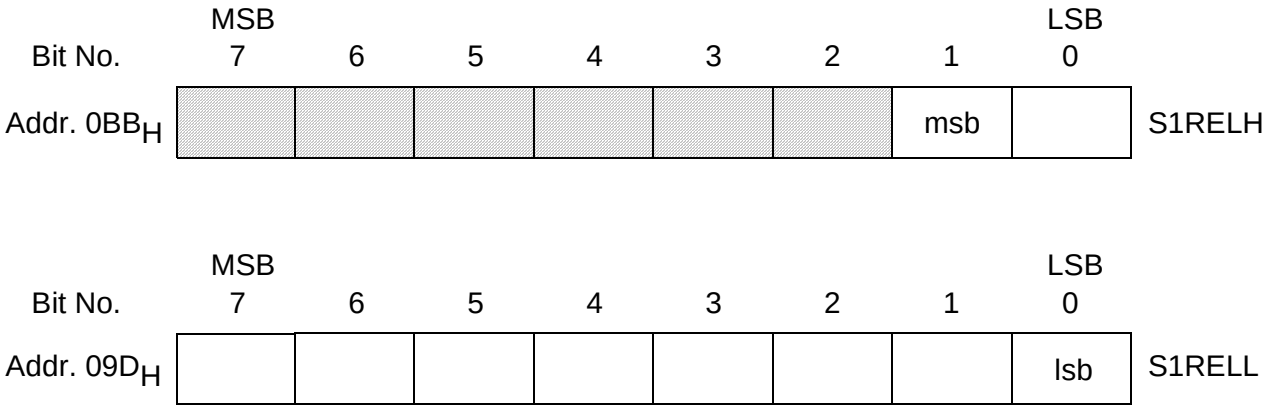


Figure 5-6
Baud Rate Generator for Serial Interface 1

Special Function Register SRELH, SRELL



shaded areas are not used for programming the baudrate timer

Bit	Function
S1RELH.0-1	Reload value. Upper two bits of the timer reload value.
S1RELL.0-7	Reload value. Lower 8 bit of timer reload value.

Reset value of S1RELL is 00_H, S1RELH contains XXXX XXX11B.

5.5 Modified Oscillator Watchdog Unit

The SAB 80C517A has a new oscillator watchdog unit that has an improved functionality with respect to the SAB 80C517's oscillator watchdog.

Use of the Oscillator Watchdog Unit

The unit serves three functions:

- Monitoring of the on-chip oscillator's function.
  The watchdog supervises the on-chip oscillator's frequency; if it is lower than the frequency of the auxiliary RC oscillator in the watchdog unit, the internal clock is supplied by the RC oscillator and the device is brought into reset; if the failure condition disappears (i.e. the on-chip oscillator has a higher frequency than the RC oscillator), the part executes a final reset phase of appr. 0.5 ms in order to allow the oscillatior to stabilize; then the oscillator watchdog reset is released and the part starts program execution again.
- Restart from the Hardware Power Down Mode.
  If the Hardware Power Down Mode is terminated the oscillator watchdog has to control the correct start-up of the on-chip oscillator and to restart the program. The oscillator watchdog function is only part of the complete Hardware Power Down sequence; however, the watchdog works identically to the monitoring function.
- Fast internal reset after power-on.
  In this function the oscillator watchdog unit provides a clock supply for the reset before the on-chip oscillator has started. In this case the oscillator watchdog unit also works identically to the monitoring function.

If the oscillator watchdog unit shall be used it must be enabled (this is done by applying high level to the control pin OWE).

Detailled Description of the Oscillator Watchdog Unit

Figure 5-7 shows the block diagram of the oscillator watchdog unit. It consists of an internal RC oscillator which provides the reference frequency for the comparison with the frequency of the on-chip oscillator. The RC oscillator can be enabled/disabled by the control pin OWE . If it is disabled the complete unit has no function.

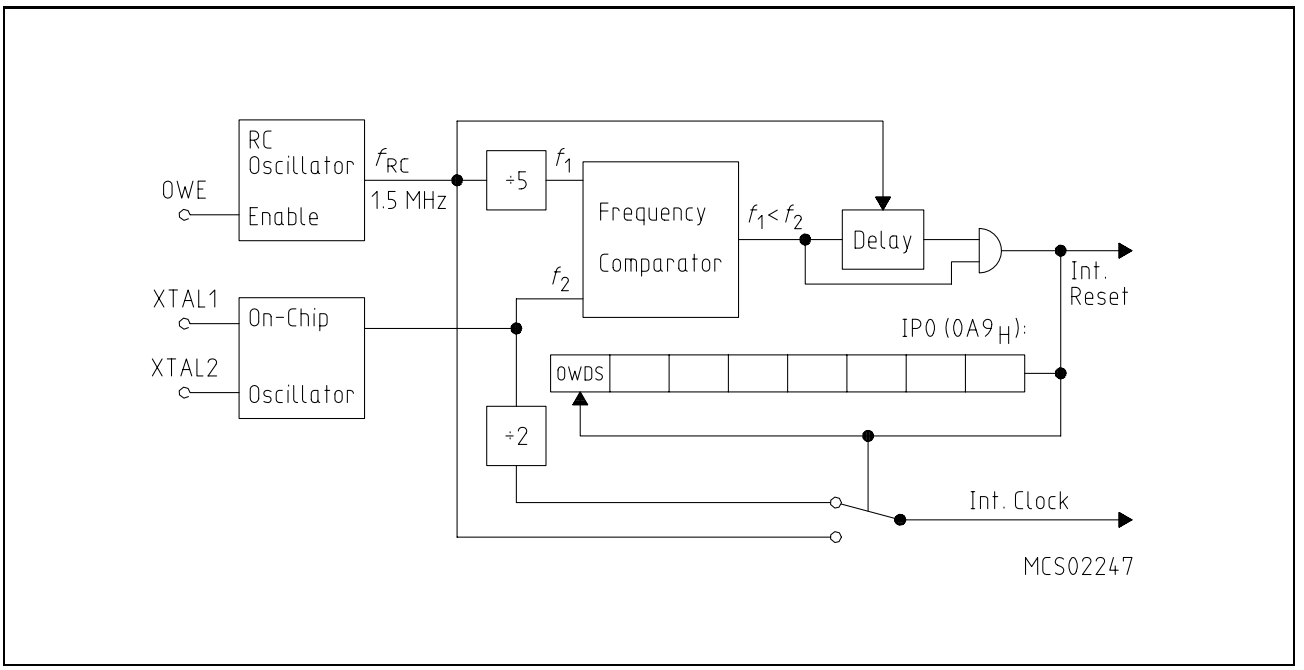


Figure 5-7
Oscillator Watchdog Unit

Special Function Register IP0 (Address 0A9H)

Bit No.	MSB 7	6	5	4	3	2	1	LSB 0	
0A9$_H$	OWDS	WDTS	IP0.5	IP0.4	IP0.3	IP0.2	IP0.1	IP0.0	IP0

▨ These bits are not used in controlling the fail safe mechanisms.

Bit	Function
OWDS	Oscillator watchdog timer status flag. Set by hardware when an oscillator watchdog reset occurred. Can be cleared or set by software.

Reset value of IP0 is 00_H.

The frequency coming from the RC oscillator is divided by 5 and compared to the on-chip oscillator's frequency. If the frequency coming from the on-chip oscillator is found lower than the frequency derived from the RC oscillator the watchdog detects a failure condition (the oscillation at the on-chip oscillator could stop because of crystal damage etc.). In this case it switches the input of the internal clock system to the output of the RC oscillator. This means that the part is being clocked even if the on-chip oscillator has stopped or has not yet started. At the same time the watchdog activates the internal reset in order to bring the part in its defined reset state. The reset is performed because clock is available from the RC oscillator. This internal watchdog reset has the same effects as an externally applied reset signal with the following exception: The Watchdog Timer Status flag WDTS (IP0.6) is not reset (the Watchdog Timer however is stopped) and bit OWDS is set. This allows the software to examine error conditions detected by the Watchdog Timer even if meanwhile an oscillator failure occured.

The oscillator watchdog is able to detect a recovery of the on-chip oscillator after a failure. If the frequency derived from the on-chip oscillator is again higher than the reference the watchdog starts a final reset sequence which takes typ. 1 ms. Within that time the clock is still supplied by the RC oscillator and the part is held in reset. This allows a reliable stabilization of the on chip oscillator. After that, the watchdog toggles the clock supply back to the on-chip oscillator and releases the reset request. If no external reset is applied in this moment the part will start program execution. If an external reset is active, however, the device will keep the reset state until also the external reset request disappears.

Furthermore, the status flag OWDS (IP0.7) is set if the oscillator watchdog was active. The status flag can be evaluated by software to detect that a reset was caused by the oscillator watchdog. The flag OWDS can be set or cleared by software. An external reset request, however, also resets OWDS (and WDTS).

6 Interrupt System

6.1 Additional Interrupt for Compare Registers CM0 to CM7

There is an additional interrupt which is vectored to on a compare match in one of the eight comparators of the compare registers CM0 to CM7, when compare mode 1 is selected for the corresponding channel (assigned to Timer 2 by control bit CMSEL.x). For that purpose the SAB 80C517A provides eight interrupt request flags (in SFR IRCON1, address 0D1H) which are ORed to form the interrupt request for that vector, i.e. each of the eight comparators has its own request flag. Thus the service routine may decide which compare match requested the interrupt.

The corresponding request flag is set by every match in the compare channel when the Compare Mode 1 is selected for this channel (assigned to Timer 2). If Compare Mode 0 is selected for a channel (assigned to the Compare Timer), the corresponding interrupt request flag will not be set on a compare match.

This interrupt is enabled by setting the enable bit ECMP in SFR IEN2. If this bit is set the program vectors to location $0A3_H$ if one of the eight request flags in IRCON 1 is set.

Figure 6-1 shows a functional block diagram of the new structure concerning the interrupts. The further functions of this compare unit keep full compatibility to the SAB 80C517.

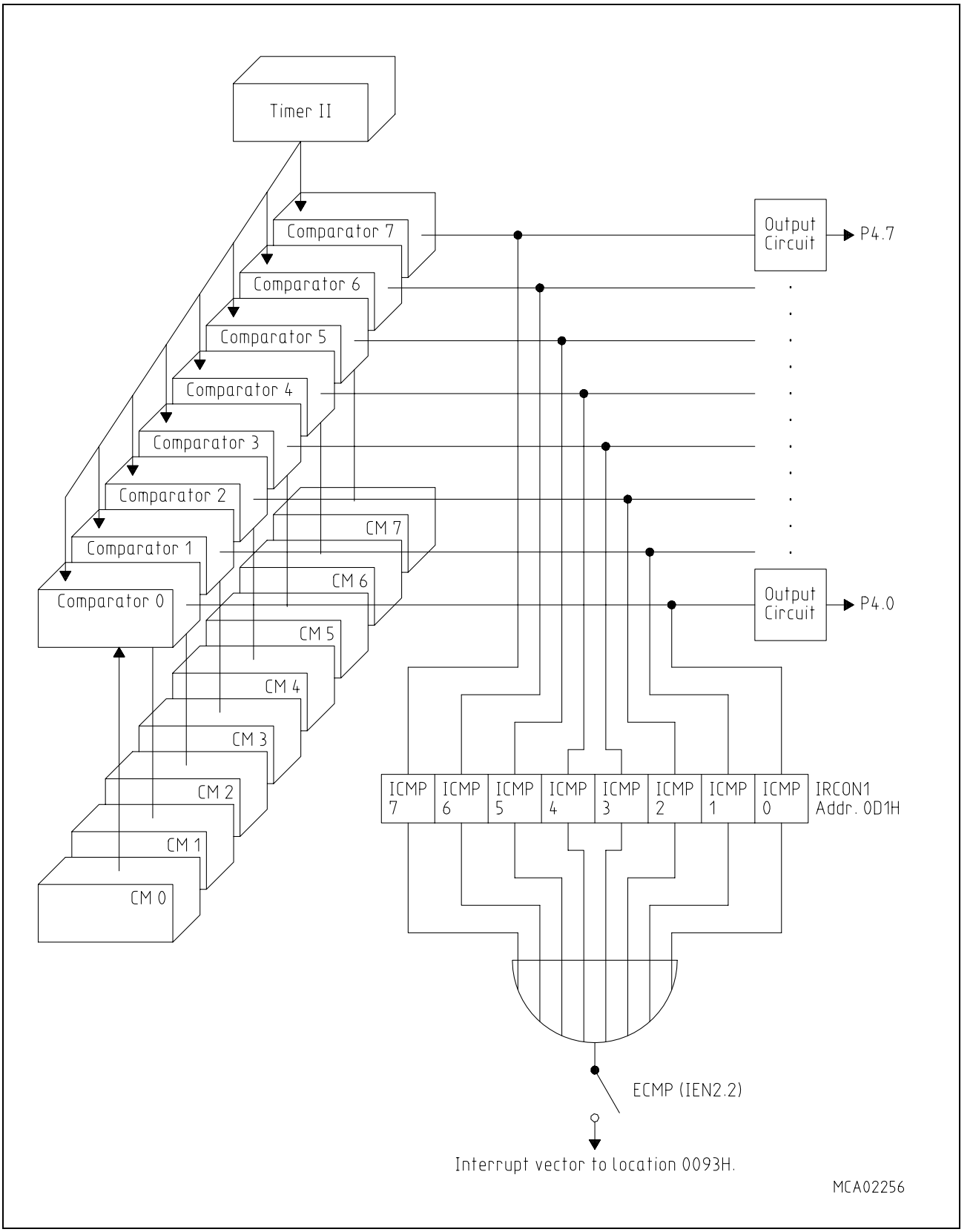


Figure 6-1
Interrupts of Compare Registers CM0-CM7 Assigned to Timer II

Special Function Register IRCON1

	MSB							LSB	
Bit No.	7	6	5	4	3	2	1	0	
$0D1_H$	ICMP7	ICMP6	ICMP5	ICMP4	ICMP3	ICMP2	ICMP1	ICMP0	IRCON1

Bit	Function
ICMPx	Compare x interrupt request flag. Set by hardware when a compare match in compare mode 1 with compare register CMx occured (only, if compare function enabled for CMx). ICMPx must be cleared by software (CMSEL.x = 0 and CMEN.x = 1).

The reset value of IRCON1 is 00_H.

6.2 Interrupt Structure

This section summarizes the expanded interrupt structure of the SAB 80C517A which has 3 new interrupt vectors in addition to the 14 vectors of the SAB 80C517. Thus, 17 vectors are available now.

The new interrupt sources are:

1. Request Flags
   ICMP0 to ICMP7: These eight request flags are set by compare matches in the compare registers CM0-7, if the compare function is enabled and compare mode 1 is selected for the corresponding register SCM0-7.
   Interrupt vector: 0093H
   Enable Bit: ECMP (IEN2.2)
   Priority: Same priority as IE1/IEX3, programmed by IP1.2/IP0.2

2. Request Flag:
   ICS This request flag is set by a compare match in compare register COMSET.
   Interrupt Vector: 00A3H
   Enable Bit: ECS (IEN2.4)
   Priority: Same priority as RI0+TI0/IEX5, programmed by IP1.4/IP0.4

3. Request Flag:
   ICR This request flag is set by a compare match in compare register COMCLR
   Interrupt Vector: 00ABH
   Enable Bit: ECR (IEN2.5)
   Priority: Same priority as TF2+EXF2/IEX6, programmed by IP1.5/IP0.5

3.1 Priority Level Structure

The following tables show the SFR IEN2, the priority level grouping (**table 6-1**) and the priority within level (**table 6-2**). The principle of the priority level selection is identical to the SAB 80C517, i.e. a pair or triple can be programmed to one of four priority levels.

Special Function Register IEN2

	MSB							LSB	
Bit No.	7	6	5	4	3	2	1	0	
$09A_H$	–	–	ECR	ECS	ECT	ECMP	–	ES1	IEN2

Bit	Function
ES1	Enable serial interrupt of interface 1. Enables or disables the interrupt of serial interface 1. If ES1 = 0, the interrupt is disabled.
ECMP	Enables interrupt on compare match in compare registers CM0 - CM7. If ECMP = 0, the interrupt is disabled.
ECT	Enable compare timer interrupt. Enables or disables the interrupt at compare timer overflow. If ECT = 0, the interrupt is disabled.
ECS	Enables interrupt on compare match in compare register COMSET. If ECS = 0, the interrupt is disabled.
ECR	Enabled interrupt on compare match in compare register COMCLR. If ECR = 0, the interrupt is disabled.

The reset value of IEN2 is XX00 00X0B.

Table 6-1, Pairs and triplets of interrupt sources

External Interrupt 0	Serial Channel 1 Interrupt	A/D Converter Interrupt
Timer 0 Interrupt	–	External Interrupt 2
External Interrupt 1	Match in CM0 - CM7	External Interrupt 3
Timer 1 Interrupt	Compare Timer Overflow	External Interrupt 4
Serial Channel 0 Interrupt	Match in COMSET	External Interrupt 5
Timer 2 Interrupt	Match in COMCLR	External Interrupt 6

Table 6-2, Priority within Level

Interrupt Source			**Priority**
High	→	**Low**	
IE0	RI1 + TI1	IADC	High
TF0	–	IEX2	
IE1	ICMP0-7	IEX3	
TF1	CTF	IEX4	↓
RI0 + TI0	ICS	IEX5	
TF2 + EXF2	ICR	IEX6	Low

High-Performance 8-Bit CMOS Single-Chip Microcontroller

SAB 80C517A/83C517A-5

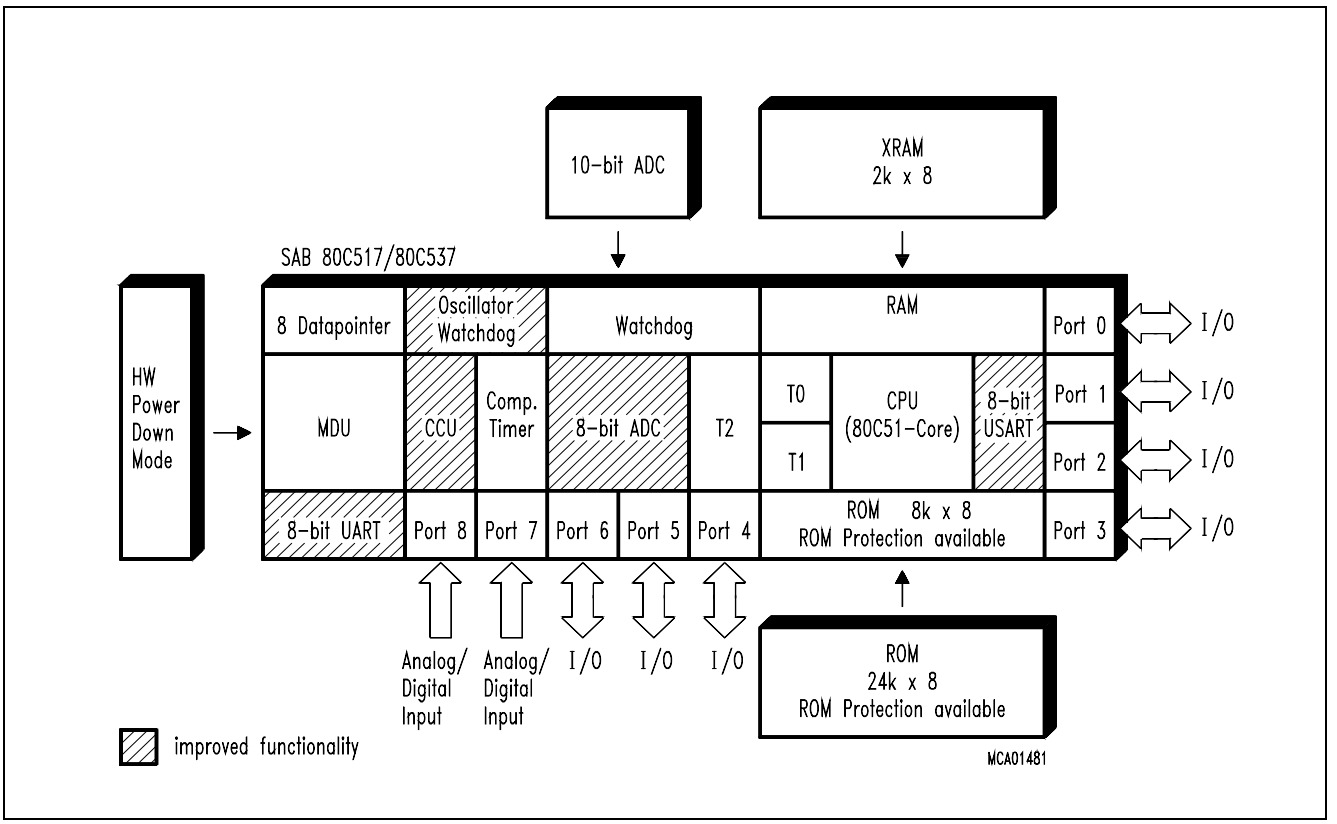
Preliminary

SAB 83C517A-5 Microcontroller with factory mask-programmable ROM
SAB 80C517A Microcontroller for external ROM

- SAB 80C517A/83C517A-5, up to 18 MHz operation
- 32 K × 8 ROM (SAB 83C517A-5 only, ROM-Protection available)
- 256 × 8 on-chip RAM
- 2 K × 8 on-chip RAM (XRAM)
- Superset of SAB 80C51 architecture:
  - 1 µs instruction cycle time at 12 MHz
  - 666 ns instruction cycle time at 18 MHz
  - 256 directly addressable bits
  - Boolean processor
  - 64 Kbyte external data and program memory addressing
- Four 16-bit timer/counters
- Powerful 16-bit compare/capture unit (CCU) with up to 21 high-speed or PWM output channels and 5 capture inputs
- Versatile "fail-safe" provisions
- Fast 32-bit division, 16-bit multiplication, 32-bit normalize and shift by peripheral MUL/DIV unit (MDU)
- Eight data pointers for external memory addressing
- Seventeen interrupt vectors, four priority levels selectable
- Genuine 10-bit A/D converter with 12 multiplexed inputs
- Two full duplex serial interfaces with programmable Baudrate-Generators
- Fully upward compatible with SAB 80C515, SAB 80C517, SAB 80C515A
- Extended power saving mode
- Fast Power-On Reset
- Nine ports: 56 I/O lines, 12 input lines
- Three temperature ranges available:
  0 to 70 °C (T1)
  – 40 to 85°C (T3)
  – 40 to 110°C (T4)
- Plastic packages: P-LCC-84, P-MQFP-100-2

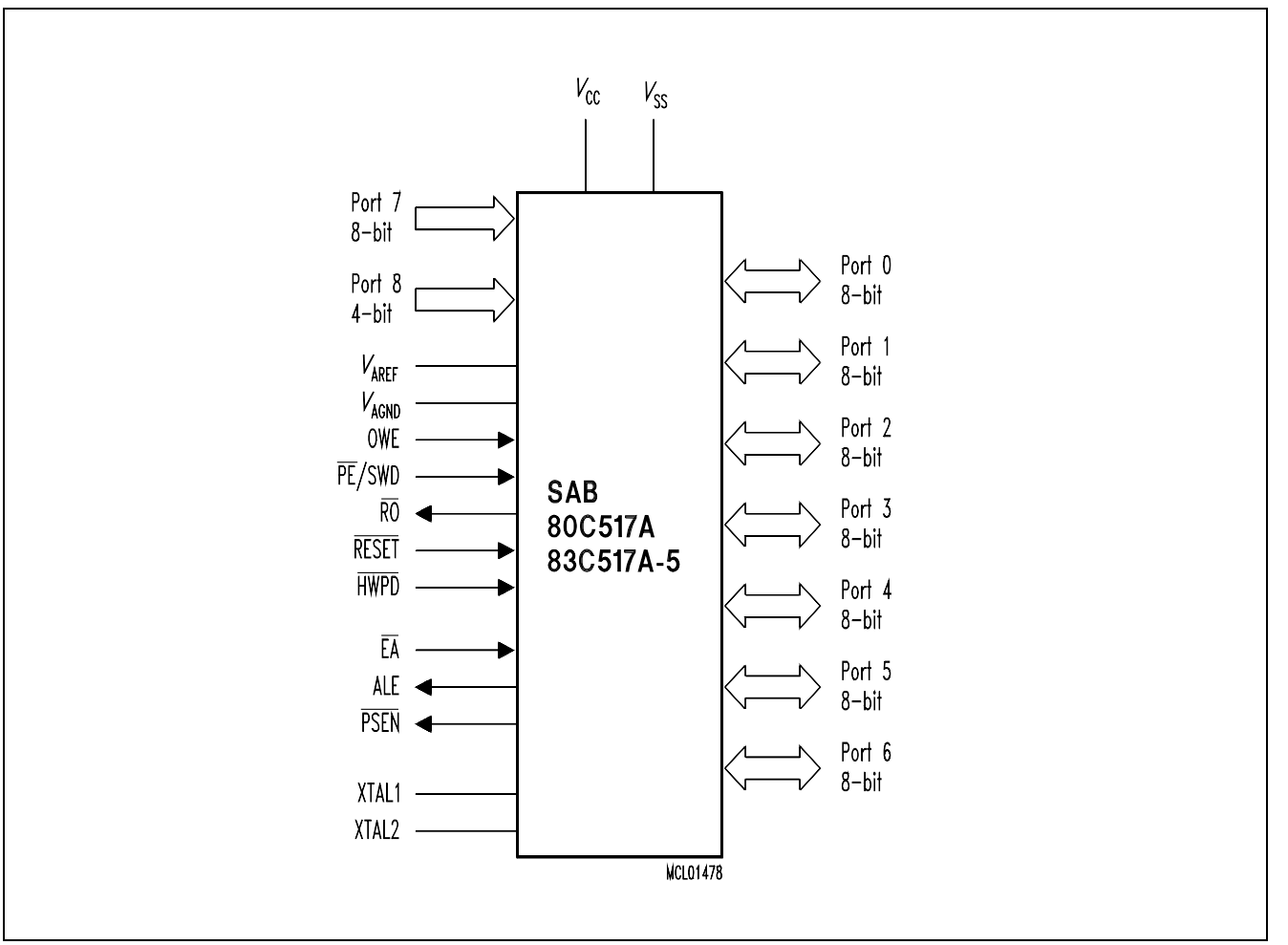
The SAB 80C517A/83C517A-5 is a high-end member of the Siemens SAB 8051 family of microcontrollers. It is designed in Siemens ACMOS technology and based on SAB 8051 architecture. ACMOS is a technology which combines high-speed and density characteristics with low-power consumption or dissipation.

While maintaining all the SAB 80C517 features and operating characteristics the SAB 80C517A is expanded in its "fail-safe" characteristics and timer capabilities.The SAB 80C517A is identical with the SAB 83C517A-5 except that it lacks the on-chip program memory. The SAB 80C517A/83C517A-5 is supplied in a 84-pin plastic leaded chip carrier package (P-LCC-84) and in a 100-pin plastic quad flat package (P-MQFP-100-2).



Ordering Information

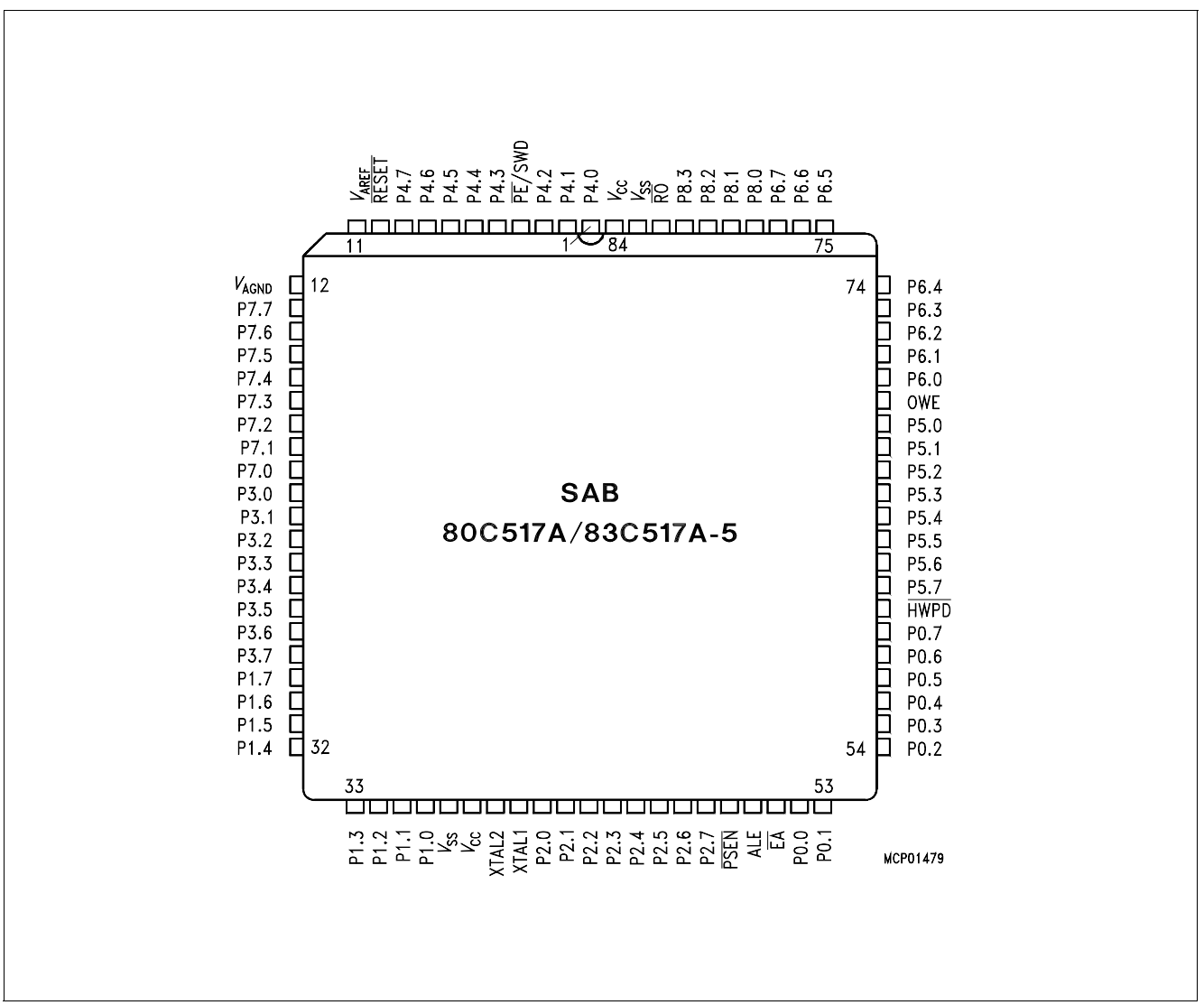
Type	Ordering code	Package	Description 8-bit CMOS microcontroller
SAB 80C517A-N18	Q67120-C583	P-LCC-84	for external memory,18 MHz
SAB 80C517A-M18	TBD	P-MRFP-100	
SAB 83C517A-5N18	Q67120-C582	P-LCC-84	with mask-programmable ROM, 18 MHz
SAB 80C517A-N18-T3	Q67120-C769	P-LCC-84	for external memory,18 MHz ext. temperature – 40 to 85 °C
SAB 83C517A-5N18-T3	Q67120-C771	P-LCC-84	with mask-programmable ROM, 18 MHz ext. temperature – 40 to 85 °C
SAB 83C517A-N18-T4	TBD	P-LCC-84	for external memory, 18 MHz ext. temperature -40 to +110°C
SAB 83C517A-5N18-T4	TBD	P-LCC-84	with mask-programmable ROM, 18 MHz ext. temperature -40 to +110°C



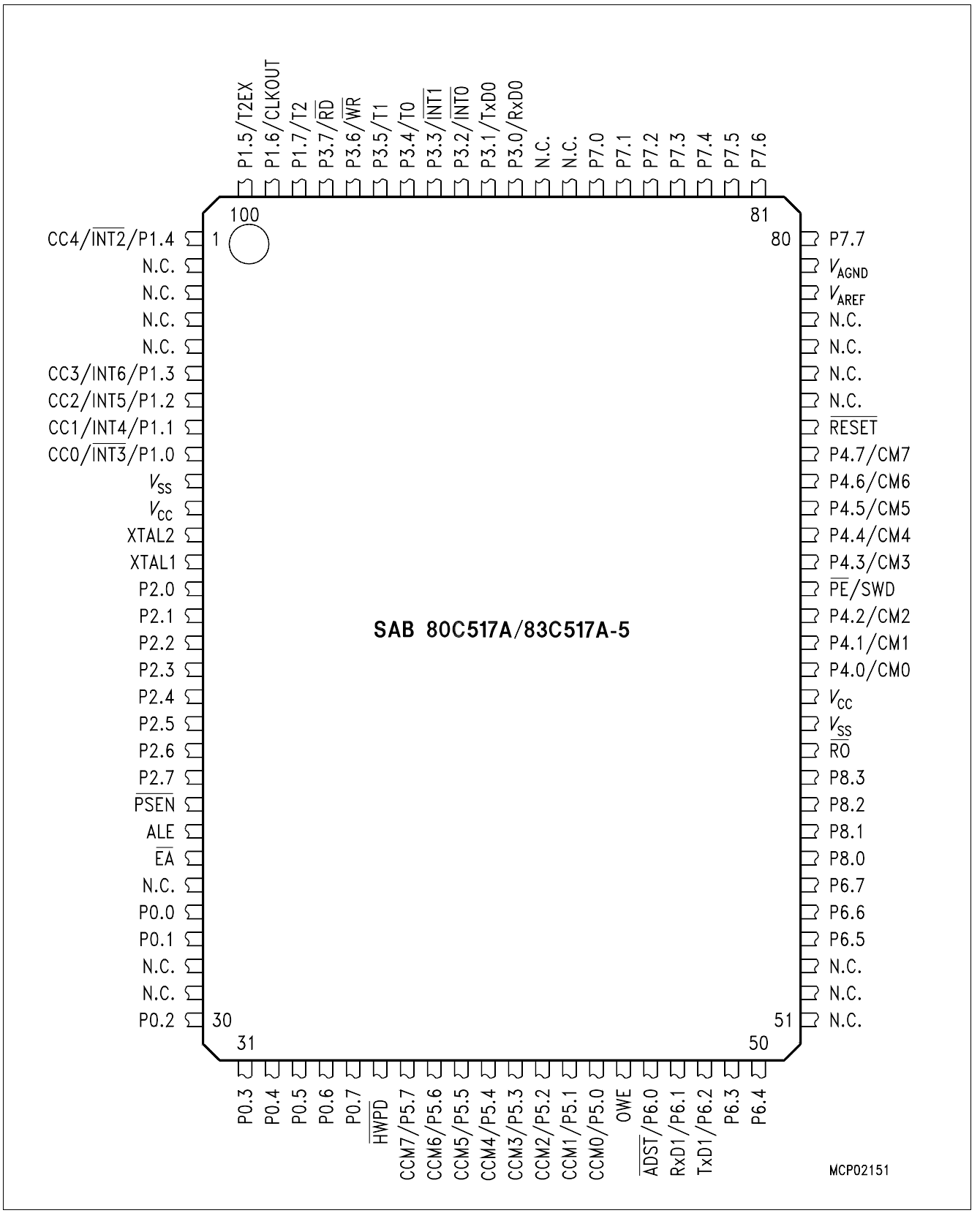
Logic Symbol

The pin functions of the SAB 80C517A are identical with those of the SAB 80C517/80C537 with one exception:

Typ	SAB 80C517A	SAB 80C517/80C537
P-LCC-84, Pin 60	$\overline{\text{HWPD}}$	N.C.
P-MQFP-100-2,Pin 36		



Pin Configuration
(P-LCC-84)



Pin Configuration
(P-MQFP-100-2)

Pin Definitions and Functions

Symbol	Pin Number		I/O *)	Function
	P-LCC-84	P-MQFP-100-2		
P4.0 – P4.7	1– 3, 5 – 9	64 - 66, 68 - 72	I/O	**Port 4** is a bidirectional I/O port with internal pull-up resistors. Port 4 pins that have 1 s written to them are pulled high by the internal pull-up resistors, and in that state can be used as inputs. As inputs, port 4 pins being externally pulled low will source current (I_{IL}, in the DC characteristics) because of the internal pull-up resistors. This port also serves alternate compare functions. The secondary functions are assigned to the pins of port 4 as follows: – CM0 (P4.0): Compare Channel 0 – CM1 (P4.1): Compare Channel 1 – CM2 (P4.2): Compare Channel 2 – CM3 (P4.3): Compare Channel 3 – CM4 (P4.4): Compare Channel 4 – CM5 (P4.5): Compare Channel 5 – CM6 (P4.6): Compare Channel 6 – CM7 (P4.7): Compare Channel 7
$\overline{PE}$/SWD	4	67	I	**Power saving modes $\overline{enable}$ Start Watchdog Timer** A low level on this pin allows the software to enter the power down, idle and slow down mode. In case the low level is also seen during reset, the watchdog timer function is off on default. Use of the software controlled power saving modes is blocked, when this pin is held on high level. A high level during reset performs an automatic start of the watchdog timer immediately after reset. When left unconnected this pin is pulled high by a weak internal pull-up resistor.

* I = Input
O = Output

Pin Definitions and Functions (cont'd)

Symbol	Pin Number		I/O *)	Function
	P-LCC-84	P-MQFP-100-2		
$\overline{\text{RESET}}$	10	73	I	$\overline{\text{RESET}}$ A low level on this pin for the duration of one machine cycle while the oscillator is running resets the SAB 80C517A. A small internal pull-up resistor permits power-on reset using only a capacitor connected to V_{SS}.
V_{AREF}	11	78		**Reference voltage** for the A/D converter.
V_{AGND}	12	79		**Reference ground** for the A/D converter.
P7.7 -P7.0	13 - 20	80 - 87	I	**Port 7** is an 8-bit unidirectional input port. Port pins can be used for digital input, if voltage levels meet the specified input high/low voltages, and for the lower 8-bit of the multiplexed analog inputs of the A/D converter, simultaneously.

* I = Input
O = Output

Pin Definitions and Functions (cont'd)

Symbol	Pin Number		I/O *)	Function
	P-LCC-84	P-MQFP-100-2		
P3.0 - P3.7	21 - 28	90 - 97	I/O	**Port 3** is a bidirectional I/O port with internal pull-up resistors. Port 3 pins that have 1 s written to them are pulled high by the internal pull-up resistors, and in that state can be used as inputs. As inputs, port 3 pins being externally pulled low will source current ($I_{IL,}$ in the DC characteristics) because of the internal pull-up resistors. Port 3 also contains the interrupt, timer, serial port 0 and external memory strobe pins that are used by various options. The output latch corresponding to a secondary function must be programmed to a one (1) for that function to operate. The secondary functions are assigned to the pins of port 3, as follows: – R × D0 (P3.0): receiver data input (asynchronous) or data input/output (synchronous) of serial interface – T × D0 (P3.1): transmitter data output (asynchronous) or clock output (synchronous) of serial interface 0 – $\overline{\text{INT0}}$ (P3.2): $\overline{\text{interrupt 0 input}}$/timer 0 gate control – $\overline{\text{INT1}}$ (P3.3): $\overline{\text{interrupt 1 input}}$/timer 1 gate control – T0 (P3.4): counter 0 input – T1 (P3.5): counter 1 input – $\overline{\text{WR}}$ (P3.6): the write control signal latches the data byte from port 0 into the external data memory – $\overline{\text{RD}}$ (P3.7): the read control signal enables the external data memory to port 0

* I = Input
O = Output

Pin Definitions and Functions (cont'd)

Symbol	Pin Number		I/O *)	Function
	P-LCC-84	P-MQFP-100-2		
P1.7 - P1.0	29 - 36	98 - 100, 1, 6 - 9	I/O	**Port 1** is a bidirectional I/O port with internal pull-up resistors. Port 1 pins that have 1 s written to them are pulled high by the internal pull-up resistors, and in that state can be used as inputs. As inputs, port 1 pins being externally pulled low will source current (I_{IL}, in the DC characteristics) because of the internal pull-up resistors. It is used for the low order address byte during program verification. It also contains the interrupt, timer, clock, capture and compare pins that are used by various options. The output latch must be programmed to a one (1) for that function to operate (except when used for the compare functions). The secondary functions are assigned to the port 1 pins as follows: – $\overline{\text{INT3}}$/CC0 (P1.0): $\overline{\text{interrupt 3 input}}$/ compare 0 output /capture 0 input – INT4/CC1 (P1.1): interrupt 4 input / compare 1 output /capture 1 input – INT5/CC2 (P1.2): interrupt 5 input / compare 2 output /capture 2 input – INT6/CC3 (P1.3): interrupt 6 input / compare 3 output /capture 3 input – $\overline{\text{INT2}}$/CC4 (P1.4): $\overline{\text{interrupt 2 input}}$ / compare 4 output /capture 4 input – T2EX (P1.5): timer 2 external reload trigger input – CLKOUT (P1.6): system clock output – T2 (P1.7): counter 2 input

* I = Input
O = Output

Pin Definitions and Functions (cont'd)

Symbol	Pin Number		I/O *)	Function
	P-LCC-84	P-MQFP-100-2		
XTAL2	39	12	–	**XTAL2** Input to the inverting oscillator amplifier and input to the internal clock generator circuits.
XTAL1	40	13	–	**XTAL1** Output of the inverting oscillator amplifier. To drive the device from an external clock source, XTAL2 should be driven, while XTAL1 is left unconnected. There are no requirements on the duty cycle of the external clock signal, since the input to the internal clocking circuitry is devided down by a divide-by-two flip-flop. Minimum and maximum high and low times as well as rise/fall times specified in the AC characteristics must be observed.
P2.0 - P2.7	41 - 48	14 - 21	I/O	**Port 2** is a bidirectional I/O port with internal pull-up resistors. Port 2 pins that have 1 s written to them are pulled high by the internal pull-up resistors, and in that state can be used as in-puts. As inputs, port 2 pins being externally pulled low will source current (I_{IL}, in the DC characteristics) because of the internal pull-up resistors. Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @DPTR). In this application it uses strong internal pull-up resistors when issuing1 s. During accesses to external data memory that use 8-bit addresses (MOVX @Ri), port 2 issues the contents of the P2 special function register.

* I = Input
O = Output

Pin Definitions and Functions (cont'd)

Symbol	Pin Number		I/O *)	Function
	P-LCC-84	P-MQFP-100-2		
$\overline{\text{PSEN}}$	49	22	O	The **Program Store Enable** output is a control signal that enables the external program memory to the bus during external fetch operations. It is activated every six oscillator periodes except during external data memory accesses. Remains high during internal program execution.
ALE	50	23	O	The **Address Latch Enable** output is used for latching the address into external memory during normal operation. It is activated every six oscillator periodes except during an external data memory access
$\overline{\text{EA}}$	51	24	I	**External Access Enable** When held at high level, instructions are fetched from the internal ROM (SAB 83C517A-5 only) when the PC is less than 8000H. When held at low level, the SAB 80C517A fetches all instructions from external program memory. For the SAB 80C517A this pin must be tied low
P0.0 - P0.7	52 - 59	26 - 27, 30 - 35	I/O	**Port 0** is an 8-bit open-drain bidirectional I/O port. Port 0 pins that have 1 s written to them float, and in that state can be used as high-impe-dance inputs. Port 0 is also the multiplexed low-order address and data bus during accesses to external program or data memory. In this application it uses strong internal pull-up resistors when issuing 1 s. Port 0 also out-puts the code bytes during program verification in the SAB 83C517A if ROM-Protection was not enabled. External pull-up resistors are required during program verification.

* I = Input
O = Output

Pin Definitions and Functions (cont'd)

Symbol	Pin Number		I/O *)	Function
	P-LCC-84	P-MQFP-100-2		
$\overline{\text{HWPD}}$	60	36	I	**$\overline{\text{Hardware Power Down}}$** A low level on this pin for the duration of one machine cycle while the oscillator is running resets the SAB 80C517A. A low level for a longer period will force the part to Power Down Mode with the pins floating. (see table 7)
P5.7 - P5.0	61 - 68	37 - 44	I/O I	**Port 5** is a bidirectional I/O port with internal pull-up resistors. Port 5 pins that have 1 s written to them are pulled high by the internal pull-up resistors, and in that state can be used as inputs. As inputs, port 5 pins being externally pulled low will source current (I_{IL}, in the DC characteristics) because of the internal pull-up resistors. This port also serves the alternate function "Concurrent Compare" and "Set/Reset Compare". The secondary functions are assigned to the port 5 pins as follows: – CCM0 to CCM7 (P5.0 to P5.7): concurrent compare or Set/Reset
OWE	69	45	I/O	**Oscillator Watchdog Enable** A high level on this pin enables the oscillator watchdog. When left unconnected this pin is pulled high by a weak internal pull-up resistor. When held at low level the oscillator watchdog function is off.

* I = Input
O = Output

Pin Definitions and Functions (cont'd)

Symbol	Pin Number		I/O *)	Function
	P-LCC-84	P-MQFP-100-2		
P6.0 - P6.7	70 - 77	46 - 50, 54 - 56	I/O	**Port 6** is a bidirectional I/O port with internal pull-up resistors. Port 6 pins that have 1 s written to them are pulled high by the internal pull-up resistors, and in that state can be used as inputs. As inputs, port 6 pins being externally pulled low will source current (I_{IL}, in the DC characteristics) because of the internal pull-up resistors. Port 6 also contains the external A/D converter control pin and the transmit and receive pins for serial channel 1. The output latch corresponding to a secondary function must be programmed to a one (1) for that function to operate. The secondary functions are assigned to the pins of port 6, as follows: – $\overline{ADST}$ (P6.0): external A/D converter start pin – R × D1 (P6.1): receiver data input of serial interface 1 – T × D1 (P6.2): transmitter data output of serial interface 1
P8.0 - P8.3	78 - 81	57 - 60	I	**Port 8** is a 4-bit unidirectional input port. Port pins can be used for digital input, if voltage levels meet the specified input high/low voltages, and for the higher 4-bit of the multiplexed analog inputs of the A/D converter, simultaneously

* I = Input
O = Output

Pin Definitions and Functions (cont'd)

Symbol	Pin Number		I/O *)	Function
	P-LCC-84	P-MQFP-100-2		
$\overline{RO}$	82	61	O	**$\overline{\text{Reset Output}}$** This pin outputs the internally synchronized reset request signal. This signal may be generated by an external hardware reset, a watchdog timer reset or an oscillator watch-dog reset. The reset output is active low.
V_{SS}	37, 83	10, 62	–	**Circuit ground potential**
V_{CC}	38, 84	11, 63	–	**Supply Terminal** for all operating modes
N.C.	–	2 - 5, 25, 28 - 29, 51 - 53, 74 - 77, 88 - 89	–	Not connected

* I = Input
O = Output

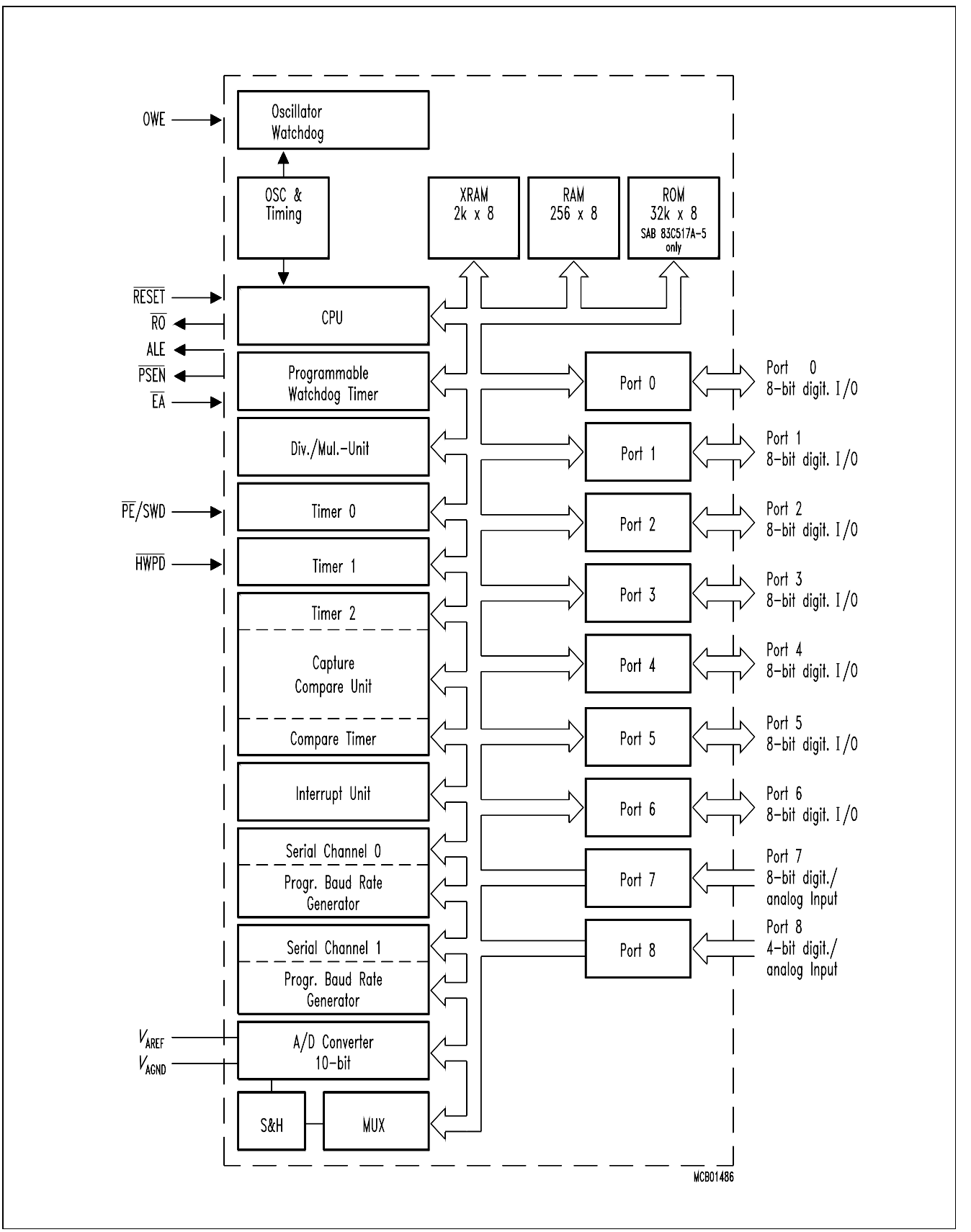


Figure 1
Block Diagram

Functional Description

The SAB 80C517A is based on 8051 architecture. It is a fully compatible member of the Siemens SAB 8051/80C51 microcontroller family being an significantly enhanced SAB 80C517. The SAB 80C517A is therefore compatible with code written for the SAB 80C517.

Having an 8-bit CPU with extensive facilities for bit-handling and binary BCD arithmetics the SAB 80C517A is optimized for control applications. With a 18 MHz crystal, 58 % of the instructions are executed in 666.67 ns.

Being designed to close the performance gap to the 16-bit microcontroller world, the SAB 80C517A's CPU is supported by a powerful 32-/16-bit arithmetic unit and a more flexible addressing of external memory by eight 16-bit datapointers.

Memory Organisation

According to the SAB 8051 architecture, the SAB 80C517A has separate address spaces for program and data memory. Figure 2 illustrates the mapping of address spaces.

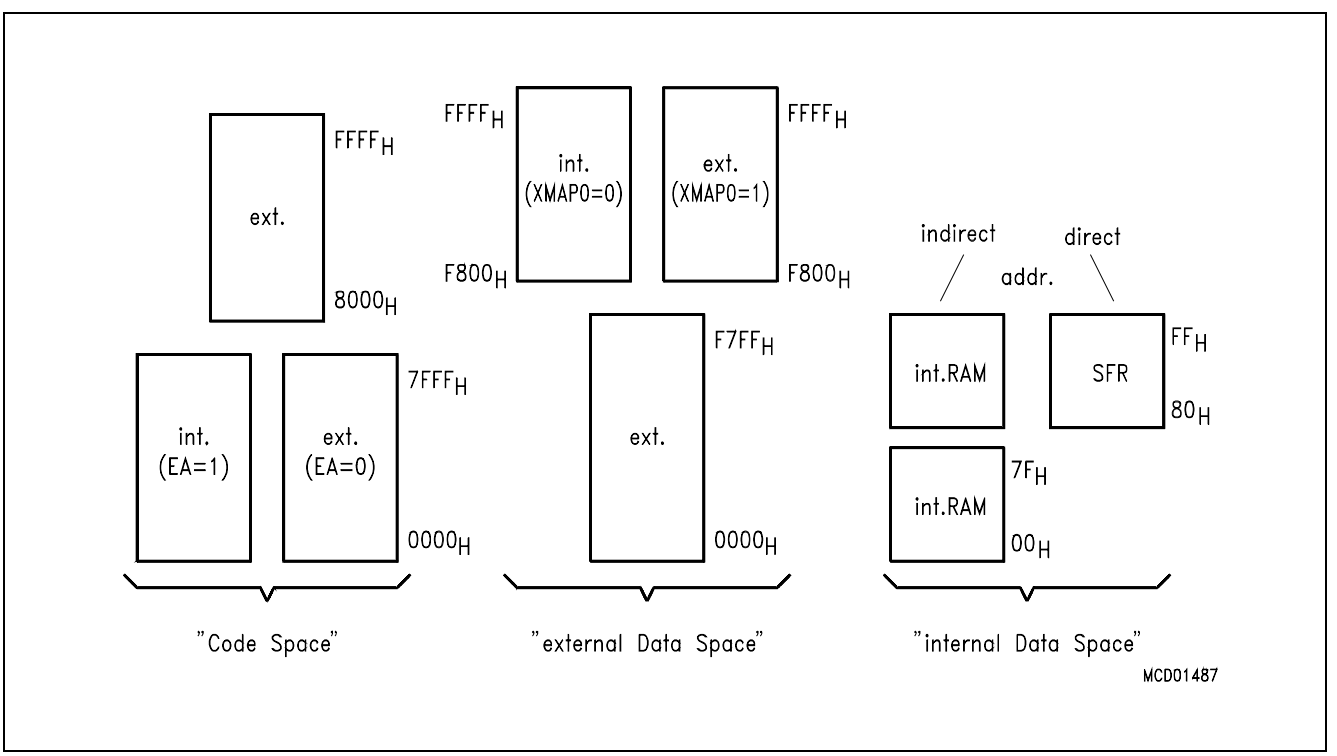


Figure 2
Memory Map

Program Memory (’Code Space’)

The SAB 83C517A-5 has 32 Kbyte of on-chip ROM, while the SAB 80C517A has no internal ROM. The program memory can externally be expanded up to 64 Kbyte. Pin $\overline{EA}$ controls whether program fetches below address 8000H are done from internal or external memory.

As a new feature the SAB 83C517A-5 offers the possibility of protecting the internal ROM against unauthorized access. This protection is implemented in the ROM-Mask.Therefore, the decision ROM-Protection ’yes’ or ’no’ has to be made when delivering the ROM-Code. Once enabled, there is no way of disabling the ROM-Protection.

Effect: The access to internal ROM done by an externally fetched MOVC instruction is disabled. Nevertheless, an access from internal ROM to external ROM is possible.

To verify the read protected ROM-Code a special ROM-Verify-Mode is implemented. This mode also can be used to verify unprotected internal ROM.

ROM -Protection	ROM-Verification Mode (see ’AC Characteristics’)	Restrictions
no	ROM-Verification Mode 1 (standard 8051 Verification Mode) ROM-Verification Mode 2	–
yes	ROM-Verification Mode 2	– standard 8051 Verification Mode is disabled – externally applied MOVC accessing internal ROM is disabled

Data Memory ('Code Space')

The data memory space consists of an internal and an external memory space. The SAB 80C517A contains another 2 Kbyte on On-Chip RAM above the 256-bytes internal RAM of the base type SAB 80C517. This RAM is called XRAM in this document.

External Data Memory

Up to 64 Kbyte external data memory can be addressed by instructions that use 8-bit or 16-bit indirect addressing. For 8-bit addressing MOVX instructions in combination with registers R0 and R1 can be used. A 16-bit external memory addressing is supported by eight 16-bit datapointers. Registers XPAGE and SYSCON are controlling whether data fetches at addresses $F800_H$ to $FFFF_H$ are done from internal XRAM or from external data memory.

Internal Data Memory

The internal data memory is divided into four physically distinct blocks:

– the lower 128 bytes of RAM including four banks containing eight registers each

– the upper 128 byte of RAM

– the 128 byte special function register area.

– a 2 K $\times$ 8 area which is accessed like external RAM (MOVX-instructions), implemented on chip at the address range from $F800_H$ to $FFFF_H$. Special Function Register SYSCON controls whether data is read or written to XRAM or external RAM.

A mapping of the internal data memory is also shown in figure 2. The overlapping address spaces are accessed by different addressing modes (see User's Manual SAB 80C517). The stack can be located anywhere in the internal data memory.

Architecture for the XRAM

The contents of the XRAM is not affected by a reset or HW Power Down. After power-up the contents is undefined, while it remains unchanged during and after a reset or HW Power Down if the power supply is not turned off.

The additional On-Chip RAM is logically located in the "external data memory" range at the upper end of the 64 Kbyte address range ($F800_H$-$FFFF_H$). It is possible to enable and disable (only by reset) the XRAM. If it is disabled the device shows the same behaviour as the parts without XRAM, i.e. all MOVX accesses use the external bus to physically external data memory.

Accesses to XRAM

Because the XRAM is used in the same way as external data memory the same instruction types must be used for accessing the XRAM.

Note: *If a reset occurs during a write operation to XRAM, the effect on XRAM depends on the cycle which the reset is detected at (MOVX is a 2-cycle instruction):*

Reset detection at cycle 1: *The new value will not be written to XRAM. The old value is not affected.*

Reset detection at cycle 2: *The old value in XRAM is overwritten by the new value.*

Accesses to XRAM using the DPTR

There are a Read and a Write instruction from and to XRAM which use one of the 16-bit DPTR for indirect addressing. The instructions are:

MOVX A, @DPTR (Read)

MOVX @DPTR, A (Write)

Normally the use of these instructions would use a physically external memory. However, in the SAB 80C517A the XRAM is accessed if it is enabled and if the DPTR points to the XRAM address space (DPTR $\geqq F800_H$).

Accesses to XRAM using the Registers R0/R1

The 8051 architecture provides also instructions for accesses to external data memory range which use only an 8-bit address (indirect addressing with registers R0 or R1). The instructions are:

MOVX A, @Ri (Read)

MOVX @Ri, A (Write)

In application systems, either a real 8-bit bus (with 8-bit address) is used or Port 2 serves as page register which selects pages of 256-byte. However, the distinction, whether Port 2 is used as general purpose I/O or as "page address" is made by the external system design. From the device's point of view it cannot be decided whether the Port 2 data is used externally as address or as I/O data!

Hence, a special page register is implemented into the SAB 80C517A to provide the possibility of accessing the XRAM also with the MOVX @Ri instructions, i.e. XPAGE serves the same function for the XRAM as Port 2 for external data memory.

Special Function Register XPAGE

Addr. 91_H									XPAGE

The reset value of XPAGE is 00_H.

XPAGE can be set and read by software.

The register XPAGE provides the upper address byte for accesses to XRAM with MOVX @Ri instructions. If the address formed from XPAGE and Ri is less than the XRAM address range, then an external access is performed. For the SAB 80C517A the contents of XPAGE must be greater or equal than $F8_H$ in order to use the XRAM. Of course, the XRAM must be enabled if it shall be used with MOVX @Ri instructions.

Thus, the register XPAGE is used for addressing of the XRAM; additionally its contents are used for generating the internal XRAM select. If the contents of XPAGE is less than the XRAM address range then an external bus access is performed where the upper address byte is provided by P2 and not by XPAGE!

Therefore, the software has to distinguish two cases, if the MOVX @Ri instructions with paging shall be used:

a) Access to XRAM:	The upper address byte must be written to XPAGE or P2; both writes selects the XRAM address range.
b) Access to external memory:	The upper address byte must be written to P2; XPAGE will be loaded with the same address in order to deselect the XRAM.

Control of XRAM in the SAB 80C517A

There are two control bits in register SYSCON which control the use and the bus operation during accesses to the additional On-Chip RAM (XRAM).

Special Function Register SYSCON

Addr. $0B1_H$	—	—	—	—	—	—	XMAP1	XMAP0	SYSCON

Bit	Function
XMAP0	Global enable/disable bit for XRAM memory. XMAP0 = 0: The access to XRAM (= On-Chip XDATA memory) is enabled. XMAP0 = 1: The access to XRAM is disabled. All MOVX accesses are performed by the external bus (reset state).
XMAP1	Control bit for $\overline{RD}$/$\overline{WR}$ signals during accesses to XRAM; this bit has no effect if XRAM is disabled (XMAP0 = 1) or if addresses exceeding the XRAM address range are used for MOVX accesses. XMAP1 = 0: The signals $\overline{RD}$ and $\overline{WR}$ are not activated during accesses to XRAM. XMAP1 = 1: The signals $\overline{RD}$ and $\overline{WR}$ are activated during accesses to XRAM.

Reset value of SYSCON is xxxx xx01B.

The control bit XMAP0 is a global enable/disable bit for the additional On-Chip RAM (XRAM). If this bit is set, the XRAM is disabled, all MOVX accesses use external memory via the external bus. In this case the SAB 80C517A does not use the additional On-Chip RAM and is compatible with the types without XRAM.

XMAP0 is hardware protected by an unsymmetric latch. An unintentional disabling of XRAM could be dangerous since indeterminate values would be read from external bus. To avoid this the XMAP-bit is forced to ’1’ only by reset. Additionally, during reset an internal capacitor is loaded. So after reset state XRAM is disabled. Because of the load time of the capacitor XMAP0-bit once written to ’0’ (that is, discharging capacitor) cannot be set to ’1’ again by software. On the other hand any distortion (software hang up, noise, ...) is not able to load this capacitor, too. That is, the stable status is XRAM enabled. The only way to disable XRAM after it was enabled is a reset.

The clear instruction for XMAP0 should be integrated in the program initialization routine before XRAM is used. In extremely noisy systems the user may have redundant clear instructions.

The control bit XMAP1 is relevant only if the XRAM is accessed. In this case the externa $\overline{RD}$ and $\overline{WR}$ signals at P3.6 and P3.7 are not activated during the access, if XMAP1 is cleared. For debug purposes it might be useful to have these signals and the addresses at Ports 0.2 available. This is performed if XMAP1 is set.

The behaviour of Port 0 and P2 during a MOVX access depends on the control bits in register SYSCON and on the state of pin $\overline{EA}$. The table 1 lists the various operating conditions. It shows the following characteristics:

a) Use of P0 and P2 pins during the MOVX access.

   Bus: The pins work as external address/data bus. If (internal) XRAM is accessed, the data written to the XRAM can be seen on the bus in debug mode.

   I/0: The pins work as Input/Output lines under control of their latch.

b) Activation of the $\overline{RD}$ and $\overline{WR}$ pin during the access.

c) Use of internal or external XDATA memory.

The shaded areas describe the standard operation as each 80C51 device without on-chip XRAM behaves.

s

Table 1:
Behaviour of P0/P2 and $\overline{RD}/\overline{WR}$ during MOVX accesses

		$\overline{EA}$ = 0			$\overline{EA}$ = 1		
		XMAP1, XMAP0			XMAP1, XMAP0		
		00	10	X1	00	10	X1
MOVX @DPTR	DPTR < XRAM address range	a) P0/P2→Bus b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0/P2→Bus b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0/P2→Bus b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0/P2→Bus b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0/P2→Bus b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0/P2→Bus b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used
	DPTR ≥ XRAM address range	a) P0/P2→BUS ($\overline{WR}$ -Data only) b) $\overline{RD}/\overline{WR}$ inactive c) XRAM is used	a) P0/P2→BUS ($\overline{WR}$ -Data only) b) $\overline{RD}/\overline{WR}$ active c) XRAM is used	a) P0/P2→Bus b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0/P2→I/0 b) $\overline{RD}/\overline{WR}$ inactive c) XRAM is used	a) P0/P2→BUS ($\overline{WR}$ -Data only) b) $\overline{RD}/\overline{WR}$ active c) XRAM is used	a) P0/P2→Bus b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used
MOVX @Ri	XPAGE < XRAM addr. page range	a) P0→Bus P2→I/0 b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0→Bus P2→I/0 b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0→Bus P2→I/0 b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0→Bus P2→I/0 b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0→Bus P2→I/0 b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0→Bus P2→I/0 b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used
	XPAGE ≥ XRAM addr. page range	a) P0/P2→BUS ($\overline{WR}$ -Data only) P2→I/0 b) $\overline{RD}/\overline{WR}$ inactive c) XRAM is used	a) P0/P2→BUS ($\overline{WR}$ -Data only) P2→I/0 b) $\overline{RD}/\overline{WR}$ active c) XRAM is used	a) P0→Bus P2→I/0 b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used	a) P0/P2→I/0 b) $\overline{RD}/\overline{WR}$ inactive c) XRAM is used	a) P0→BUS ($\overline{WR}$ -Data only) P2→I/0 b) $\overline{RD}/\overline{WR}$ active c) XRAM is used	a) P0→Bus P2→I/0 b) $\overline{RD}/\overline{WR}$ active c) ext. memory is used

(grey shading) modes compatible to 8051 - family

Multiple Datapointers

As a functional enhancement to standard 8051 controllers, the SAB 80C517A contains eight 16-bit datapointers. The instruction set uses just one of these datapointers at a time. The selection of the actual datapointer is done in special function register DPSEL (data pointer select, addr. 92_H). Figure 3 illustrates the addressing mechanism.

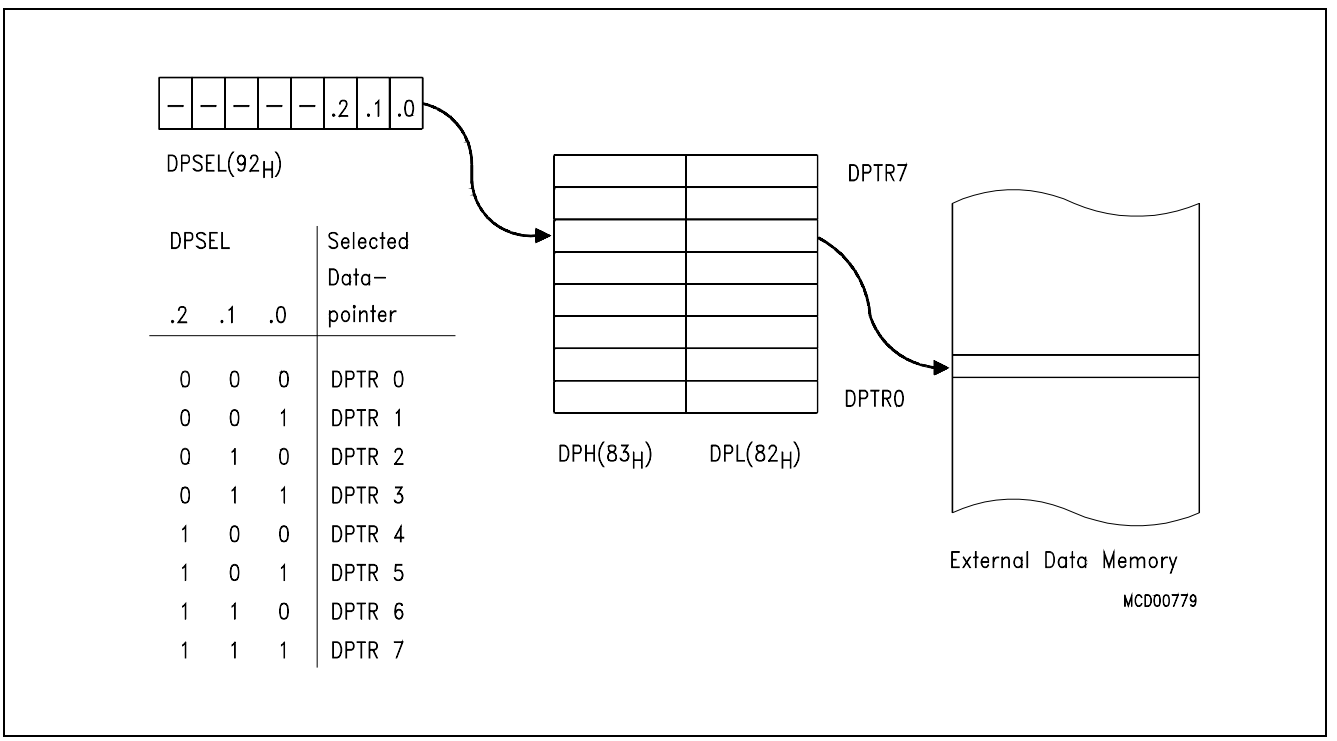


Figure 3
Addressing of External Data Memory

Special Function Registers

All registers, except the program counter and the four general purpose register banks, reside in the special function register area. The 81 special function registers include arithmetic registers, pointers, and registers that provide an interface between the CPU and the on-chip peripherals. There are also 128 directly addressable bits within the SFR area. All special function registers are listed in table 1 and table 2.

In table 1 they are organized in numeric order of their addresses. In table 2 they are organized in groups which refer to the functional blocks of the SAB 80C517A.

Table 2
Special Function Register

Address	Register	Contents after Reset	Address	Register	Contents after Reset
80_H	**P0** [1]	**$0FF_H$**	**98_H**	**S0CON** [1]	**00_H**
81_H	SP	07_H	99_H	S0BUF	XX_H
82_H	DPL	00_H	$9A_H$	IEN2	XX00 00X0B
83_H	DPH	00_H	$9B_H$	S1CON	0X00 0000B
84_H	(WDTL) [3]	(00_H)	$9C_H$	S1BUF	XX_H
85_H	(WDTH) [3]	(00_H)	$9D_H$	S1RELL	00_H
86_H	WDTREL	00_H	$9E_H$	reserved	XX_H
87_H	PCON	00_H	$9F_H$	reserved	XX_H
88_H	**TCON** [1]	**00_H**	**$A0_H$**	**P2** [1]	**$0FF_H$**
89_H	TMOD	00_H	$A1_H$	COMSETL	00_H
$8A_H$	TL0	00_H	$A2_H$	COMSETH	00_H
$8B_H$	TL1	00_H	$A3_H$	COMCLRL	00_H
$8C_H$	TH0	00_H	$A4_H$	COMCLRH	00_H
$8D_H$	TH1	00_H	$A5_H$	SETMSK	00_H
$8E_H$	reserved	XX_H [2]	$A6_H$	CLRMSK	00_H
$8F_H$	reserved	XX_H [2]	$A7_H$	reserved	XX_H [2]
90_H	**P1** [1]	**$0FF_H$**	**$A8_H$**	**IEN0** [1]	**00_H**
91_H	XPAGE	00_H	$A9_H$	IP0	00_H
92_H	DPSEL	XXXXX000B	AA_H	S0RELL	$0D9_H$
93_H	reserved	XX_H [2]	AB_H	reserved	XX_H [2]
94_H	reserved	XX_H [2]	AC_H	reserved	XX_H [2]
95_H	reserved	XX_H [2]	AD_H	reserved	XX_H [2]
96_H	reserved	XX_H [2]	AE_H	reserved	XX_H [2]
97_H	reserved	XX_H [2]	AF_H	reserved	XX_H [2]

[1] Bit-addressable special function registers

[2] X means that the value is indeterminate and the location is reserved

[3] ( )... SFRs not user accessable

Table 2
Special Function Register (cont'd)

Address	Register	Contents after Reset	Address	Register	Contents after Reset
$B0_H$	**P3** [1]	**$0FF_H$**	**$D0_H$**	**PSW** [1]	**00_H**
$B1_H$	SYSCON	XXXX XX01B	$D1_H$	IRCON1	00_H
$B2_H$	reserved	XX_H [2]	$D2_H$	CML0	00_H
$B3_H$	reserved	XX_H [2]	$D3_H$	CMH0	00_H
$B4_H$	reserved	XX_H [2]	$D4_H$	CML1	00_H
$B5_H$	reserved	XX_H [2]	$D5_H$	CMH1	00_H
$B6_H$	reserved	XX_H [2]	$D6_H$	CML2	00_H
$B7_H$	reserved	XX_H [2]	$D7_H$	CMH2	00_H
$B8_H$	**IEN1** [1]	**00_H**	**$D8_H$**	**ADCON0** [1]	**00_H**
$B9_H$	IP1	XX00 0000B	$D9_H$	ADDATH	00_H
BA_H	S0RELH	XXXX XX11B	DA_H	ADDATL	00_H
BB_H	S1RELH	XXXX XX11B	DB_H	P7	XX_H
BC_H	reserved	XX_H	DC_H	ADCON1	XXXX 0000B
BD_H	reserved	XX_H	DD_H	P8	XX_H
BS_H	reserved	XX_H	DE_H	CTRELL	00_H
BF_H	reserved	XX_H	DF_H	CTRELH	00_H
$C0_H$	**IRCON0** [1]	**00_H**	**$E0_H$**	**ACC** [1]	**00_H**
$C1_H$	CCEN	00_H	$E1_H$	CTCON	0X00 000B
$C2_H$	CCL1	00_H	$E2_H$	CML3	00_H
$C3_H$	CCH1	00H	$E3_H$	CMH3	00_H
$C4_H$	CCL2	00_H	$E4_H$	CML4	00_H
$C5_H$	CCH2	00_H	$E5_H$	CMH4	00_H
$C6_H$	CCL3	00_H	$E6_H$	CML5	00_H
$C7_H$	CCH3	00_H	$E7_H$	CMH5	00_H
$C8_H$	**T2CON** [1]	**00_H**	**$E8_H$**	**P4** [1]	**$0FF_H$**
$C9_H$	CC4EN	00_H	$E9_H$	MD0	XX_H
CA_H	CRCL	00_H	EA_H	MD1	XX_H
CB_H	CRCH	00_H	EB_H	MD2	XX_H
CC_H	TL2	00_H	EC_H	MD3	XX_H
CD_H	TH2	00_H	ED_H	MD4	XX_H
CE_H	CCL4	00_H	EE_H	MD5	XX_H
CF_H	CCH4	00_H	EF_H	ARCON	0XXX XXXXB

[1] Bit-addressable special function registers
[2] X means that the value is indeterminate and the location is reserved
[3] ( )... SFRs not user accessable

Table 2
Special Function Register (cont'd)

Address	Register	Contents after Reset	Address	Register	Contents after Reset
$F0_H$	**B** [1]	**00_H**	**$F8_H$**	**P5** [1]	**$0FF_H$**
$F1_H$	reserved	XX_H	$F9_H$	reserved	XX_H
$F2_H$	CML6	00_H	FA_H	P6	$0FF_H$
$F3_H$	CMH6	00_H	FB_H	reserved	XX_H
$F4_H$	CML7	00_H	FC_H	reserved	XX_H
$F5_H$	CMH7	00_H	FD_H	(IS0)	XX_H
$F6_H$	CMEN	00_H	FE_H	(IS1)	XX_H
$F7_H$	CMSEL	00_H	FF_H	reserved	XX_H

[1] Bit-addressable special function registers
[2] X means that the value is indeterminate and the location is reserved
[3] ( )... SFRs not user accessable

Table 3
Special Function Registers - Functional Blocks

Block	Symbol	Name	Address	Contents after Reset
CPU	ACC	Accumulator	**$0E0_H$** [1]	00_H
	B	B-Register	**$0F0_H$** [1]	00_H
	DPH	Data Pointer, High Byte	83_H	00_H
	DPL	Data Pointer, Low Byte	82_H	00_H
	DPSEL	Data Pointer Select Register	92_H	XXXX X000B[3]
	PSW	Program Status Word Register	**$0D0_H$** [1]	00_H
	SP	Stack Pointer	81_H	07_H
A/D-Converter	ADCON0	A/D Converter Control Register 0	**$0D8_H$** [1]	00_H
	ADCON1	A/D Converter Control Register 1	$0DC_H$	00_H
	ADDATH	A/D Converter Data Reg. High Byte	$0D9_H$	00_H
	ADDATL	A/D Converter Data Reg. Low Byte	$0DA_H$	00_H
Interrupt System	IEN0	Interrupt Enable Register 0	**$0A8_H$** [1]	00_H
	CTCON [2]	Com. Timer Control Register	$0E1_H$	0X00 0000B
	IEN1	Interrupt Enable Register 1	**$0B8_H$** [1]	00_H
	IEN2	Interrupt Enable Register 2	$9A_H$	XX00 00X0B [3]
	IP0	Interrupt Priority Register 0	$0A9_H$	00_H
	IP1	Interrupt Priority Register 1	$0B9_H$	XX00 0000B
	IRCON0	Interrupt Request Control Register	**$0C0_H$** [1]	00_H
	IRCON1	Interrupt Request Control Register	$0D1_H$	00_H
	TCON [2]	Timer Control Register	**88_H** [1]	00_H
	TCON [2]	Timer 2 Control Register	**$0C8_H$**	00_H
MUL/DIV Unit	ARCON	Arithmetic Control Register	$0EF_H$	0XXXX XXXXB
	MD0	Multiplication/Division Register 0	$0E9_H$	XX_H
	MD1	Multiplication/Division Register 1	$0EA_H$	XX_H
	MD2	Multiplication/Division Register 2	$0EB_H$	XX_H
	MD3	Multiplication/Division Register 3	$0EC_H$	XX_H
	MD4	Multiplication/Division Register 4	$0ED_H$	XX_H
	MD5	Multiplication/Division Register 5	$0EE_H$	XX_H

[1] Bit-addressable special function registers
[2] This special function register is listed repeatedly since some bits of it also belong to other functional blocks.
[3] X means that the value is indeterminate and the location is reserved

Table 3
Special Function Registers - Functional Blocks (cont'd)

Block	Symbol	Name	Address	Contents after Reset
Compare/ Capture-Unit (CCU) Timer 2	CCEN	Comp./Capture Enable Reg.	$0C1_H$	00_H
	CC4EN	Comp./Capture Enable 4 Reg.	$0C9_H$	00_H
	CCH1	Comp./Capture Reg. 1, High Byte	$0C3_H$	00_H
	CCH2	Comp./Capture Reg. 2, High Byte	$0C5_H$	00_H
	CCH3	Comp./Capture Reg. 3, High Byte	$0C7_H$	00_H
	CCH4	Comp./Capture Reg. 4, High Byte	$0CF_H$	00_H
	CCL1	Comp./Capture Reg. 1, Low Byte	$0C2_H$	00_H
	CCL2	Comp./Capture Reg. 2, Low Byte	$0C4_H$	00_H
	CCL3	Comp./Capture Reg. 3, Low Byte	$0C6_H$	00_H
	CCL4	Comp./Capture Reg. 4, Low Byte	$0CE_H$	00_H
	CMEN	Compare Enable Register	$0F6_H$	00_H
	CMH0	Compare Register 0, High Byte	$0D3_H$	00_H
	CMH1	Compare Register 1, High Byte	$0D5_H$	00_H
	CMH2	Compare Register 2, High Byte	$0D7_H$	00_H
	CMH3	Compare Register 3, High Byte	$0E3_H$	00_H
	CMH4	Compare Register 4, High Byte	$0E5_H$	00_H
	CMH5	Compare Register 5, High Byte	$0E7_H$	00_H
	CMH6	Compare Register 6, High Byte	$0F3_H$	00_H
	CMH7	Compare Register 7, High Byte	$0F5_H$	00_H
	CML0	Compare Register 0, Low Byte	$0D2_H$	00_H
	CML1	Compare Register 1, Low Byte	$0D4_H$	00_H
	CML2	Compare Register 2, Low Byte	$0D6_H$	00_H
	CML3	Compare Register 3, Low Byte	$0E2_H$	00_H
	CML4	Compare Register 4, Low Byte	$0E4_H$	00_H
	CML5	Compare Register 5, Low Byte	$0E6_H$	00_H
	CML6	Compare Register 6, Low Byte	$0F2_H$	00_H
	CML7	Compare Register 7, Low Byte	$0F4_H$	00_H
	CMSEL	Compare Input Select	$0F7_H$	00_H
	CRCH	Com./Rel./Capt. Reg. High Byte	$0CB_H$	00_H
	CRCL	Com./Rel./Capt. Reg. Low Byte	$0CA_H$	00_H
	COMSETL	Compare Register, Low Byte	$0A1_H$	00_H
	COMSETH	Compare Register, High Byte	$0A2_H$	00_H
	COMCLRL	Compare Register, Low Byte	$0A3_H$	00_H
	COMCLRH	Compare Register, High Byte	$0A4_H$	00_H
	SETMSK	Mask Register, concerning COMSET	$0A5_H$	00_H

[1] Bit-addressable special function registers
[2] This special function register is listed repeatedly since some bits of it also belong to other functional blocks.
[3] X means that the value is indeterminate and the location is reserved

Table 3
Special Function Registers - Functional Blocks (cont'd)

Block	Symbol	Name	Address	Contents after Reset
Compare/ Capture- Unit (CCU), (cont'd)	CLRMSK	Mask Register, concerning COMCLR	$0A6_H$	00_H
	CTCON	Com. Timer Control Reg.	$0E1_H$	0X00 0000B [3]
	CTRELH	Com. Timer Rel. Reg., High Byte	$0DF_H$	00_H
	CTRELL	Com. Timer Rel. Reg., Low Byte	$0DE_H$	00_H
	TH2	Timer 2, High Byte	$0CD_H$	00_H
	TL2	Timer 2, Low Byte	$0CC_H$	00_H
	T2CON	Timer 2 Control Register	**$0C8_H$** [1]	00_H
Ports	P0	Port 0	**80_H** [1]	$0FF_H$
	P1	Port 1	**90_H** [1]	$0FF_H$
	P2	Port 2	**$0A0_H$** [1]	$0FF_H$
	P3	Port 3	**$0B0_H$** [1]	$0FF_H$
	P4	Port 4	**$0E8_H$** [1]	$0FF_H$
	P5	Port 5	**$0F8_H$** [1]	$0FF_H$
	P6	Port 6,	$0FA_H$	$0FF_H$
	P7	Port 7, Analog/Digital Input	$0DB_H$	
	P8	Port 8, Analog/Digital Input, 4-bit	$0DD_H$	
Pow.Sav. Modes	PCON	Power Control Register	87_H	00_H
Serial Channels	ADCON [02]	A/D Converter Control Reg.	**$0D8_H$** [1]	00_H
	PCON [2]	Power Control Register	87_H	00_H
	S0BUF	Serial Channel 0 Buffer Reg.	99_H	$0XX_H$ [3]
	S0CON	Serial Channel 0 Control Reg.	**98_H** [1]	00_H
	S0RELL	Serial Channel 0 Reload Reg., low byte	$B2_H$	$D9_H$
	S0RELH	Serial Channel 0 Reload Reg., high byte	BA_H	XXXX.XX11B [3]
	S1BUF	Serial Channel 1 Buffer Reg.,	$9C_H$	$0XX_H$ [3]
	S1CON	Serial Channel 1 Control Reg.	$9B_H$	0X00 000B [3]
	S1RELL	Serial Channel 1 Reload Reg., low byte	$9D_H$	00_H
	S1RELH	Serial Channel 1 Relaod Reg., high byte	BB_H	XXXX.XX11B [3]

[1] Bit-addressable special function registers
[2] This special function register is listed repeatedly since some bits of it also belong to other functional blocks.
[3] X means that the value is indeterminate and the location is reserved

Table 3
Special Function Registers - Functional Blocks (cont'd)

Block	Symbol	Name	Address	Contents after Reset
Timer 0/ Timer 1	TCON	Timer Control Register	**88_H** [1]	00_H
	TH0	Timer 0, High Byte	$8C_H$	00_H
	TH1	Timer 1, High Byte	$8D_H$	00_H
	TL0	Timer 0, Low Byte	$8A_H$	00_H
	TL1	Timer 1, Low Byte	$8B_H$	00_H
	TMOD	Timer Mode Register	89_H	00_H
Watchdog	IEN0 [2]	Interrupt Enable Register 0	**$0A8_H$** [1]	00_H
	IEN1 [2]	Interrupt Enable Register 1	**$0B8_H$** [1]	00_H
	IP0 [2]	Interrupt Priority Register 0	$0A9_H$	00_H
	IP1 [2]	Interrupt Priority Register 1	$0B9_H$	XX00 0000B [3]
	WDTREL	Watchdog Timer Reload Reg.	86_H	00_H

[1] Bit-addressable special function registers
[2] This special function register is listed repeatedly since some bits of it also belong to other functional blocks.
[3] X means that the value is indeterminate and the location is reserved

A/D Converter

In the SAB 80C517A a new high performance / high-speed 12-channel 10-bit A/D-Converter is implemented. Its successive approximation technique provides 7 µs con-version time (f_{OSC}= 16 MHz). The conversion principle is upward compatible to the one used in the SAB 80C517. The main functional blocks are shown in figure 4.

The comparator is a fully differential comparator for a high power supply rejection ratio and very low offset voltages. The capacitor network is binary weighted providing genuine 10-bit resolution.

The table below shows the sample time T_S and the conversion time T_C, which are dependend on f_{OSC} and a new prescaler (see also Bit ADCL in SFR ADCON 1).

f_{OSC} [MHz]	Prescaler	f_{ADC} [MHz]	Sample Time T_S [µs]	Conversion Time (incl. sample time) T_C [µs]
12	÷ 8	1.5	2.67	9.33
	÷ 16	0.75	5.33	18.66
16	÷ 8	2.0	2.0	7.0
	÷ 16	1.0	4.0	14.0
18	÷ 8	–	–	–
	÷ 16	1.125	3.55	12.4

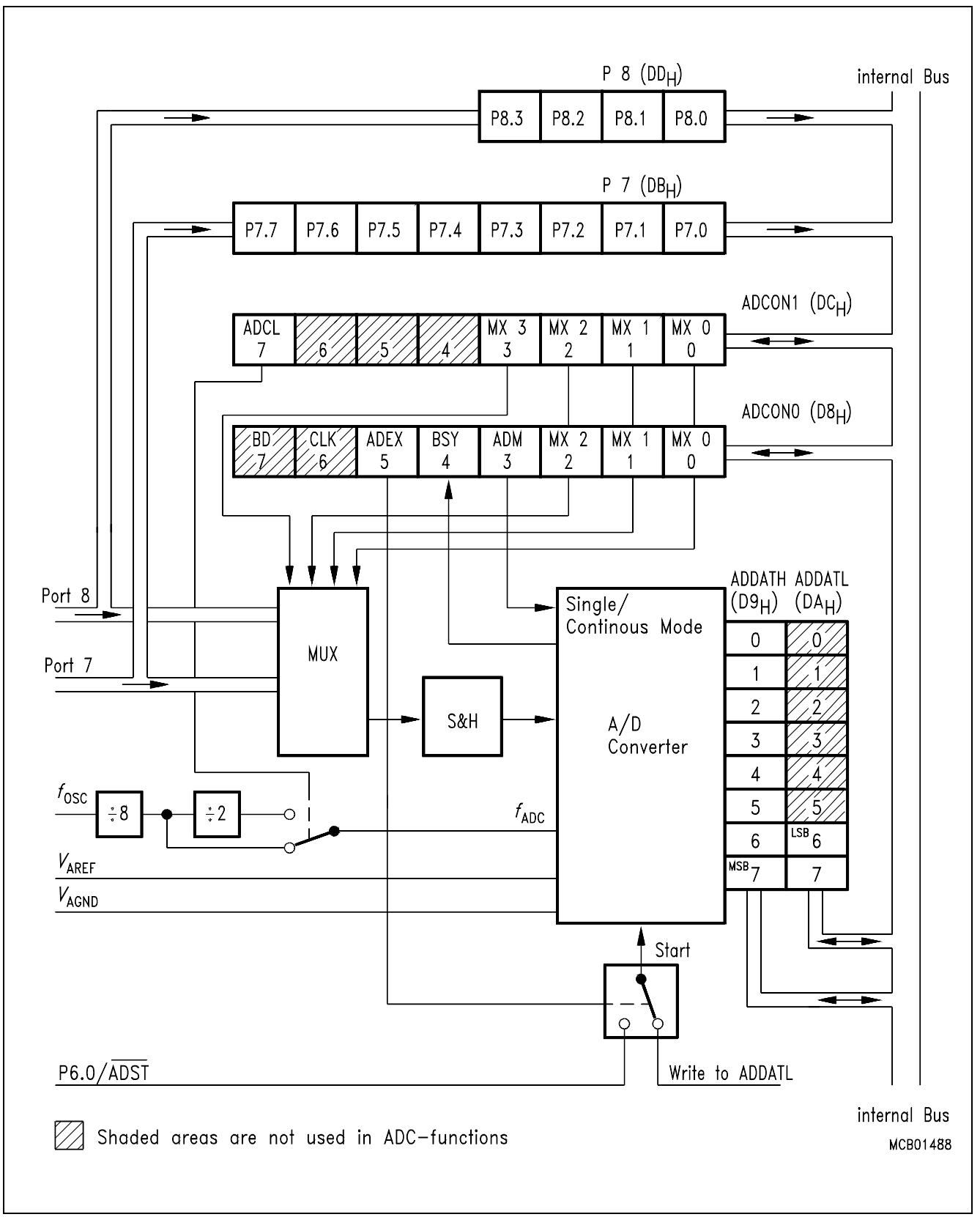


Figure 4
Block Diagram A/D Converter

Compare/Capture Unit (CCU)

The compare/capture unit is a complex timer/register array for applications that require high speed I/O pulse width modulation and more timer/counter capabilities.
The CCU contains

- one 16-bit timer/counter **(timer2)** with 2-bit prescaler, reload capability and a max. clock frequency of $f_{OSC/12}$ (1 MHz with a 12 MHz crystal).
- one 16-bit timer **(compare timer)** with 8-bit prescaler, reload capability and a max. clock frequency of $f_{OSC/2}$ (6 MHz with a 12 MHz crystal).
- fifteen 16-bit compare registers.
- five of which can be used as 16-bit capture registers.
- up to 21 output lines controlled by the CCU.
- nine interrupts which can be generated by CCU-events.

Figure 5 shows a block diagram of the CCU. Eight compare registers (CM0 to CM7) can individually be assigned to either timer 2 or the compare timer. Diagrams of the two timers are shown in figures 6 and 7. The four compare/capture registers, the compare/reload/capture register and the comset/comclr register are always connected to timer 2. Depending on the register type and the assigned timer three different compare modes can be selected.
Table 3 illustrates possible combinations and the corresponding output lines.

Table 4
CCU Compare Configuration

Assigned Timer	Compare Register	Compare Output	Possible Modes
Timer 2	CRCH/CRCL	P1.0/$\overline{\text{INT3}}$/CC0	Comp. mode 0, 1 + Reload
	CC1H/CC1L	P1.1/INT4/CC1	Comp. mode 0, 1
	CC2H/CC2L	P1.2/INT5/CC2	Comp. mode 0, 1
	CC3H/CC3L	P1.3/INT6/CC3	Comp. mode 0, 1
	CC4H/CC4L	P1.4/$\overline{\text{INT2}}$/CC4	Comp. mode 0, 1
	CC4H/CC4L	P5.0/CCM0	Comp. mode 1
	:	:	:
	CC4H/CC4L	P5.7/CCM7	Comp. mode 1
	COMSETL/COMSETH	P5.0/CCM0	Comp. mode 2
		:	:
		P5.7/CCM7	Comp. mode 2
	COMCLRL/	P5.0/CCM0	Comp. mode 2
	COMCLRH	:	:
		P5.7/CCM7	Comp. mode 2
		P4.0/CM0	Comp. mode 1
	CM0H/CM0L	:	:
	:	P4.7/CM7	Comp. mode 1
	CM7H/CM7L		
Compare timer	CM0H/CM0L	P4.0/CM0	Comp. mode 0 (with shadow latches)
	:	:	:
	CM7H/CM7L	P4.7/CM7	Comp. mode 0 (with shadow latches)

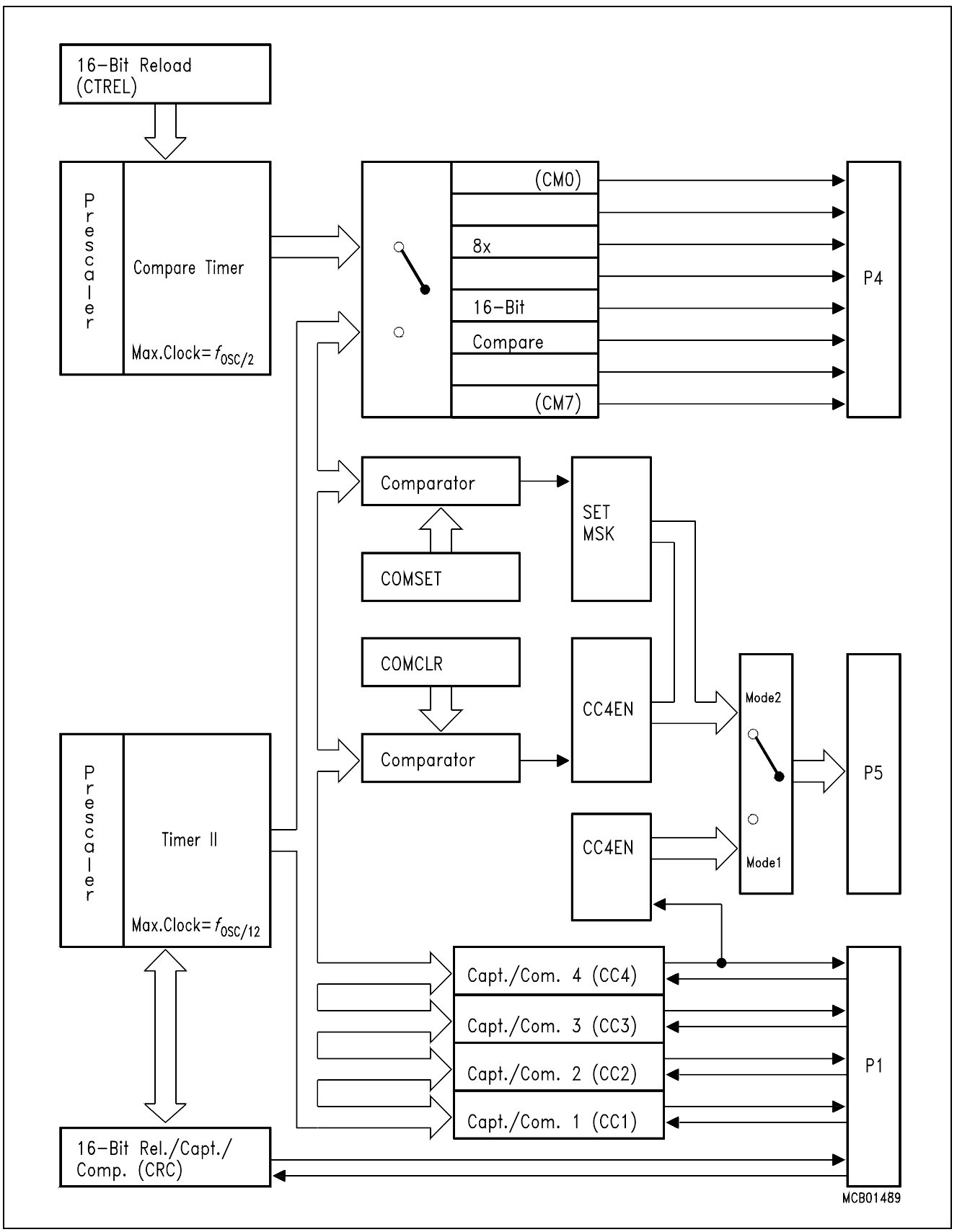


Figure 5
Block Diagram of the Compare/Capture Unit

Compare

In compare mode, the 16-bit values stored in the dedicated compare registers are compared to the contents of the timer 2 register or the compare timer register. If the count value in the timer registers matches one of the stored value, an appropriate output signal is generated at the corresponding pin(s) and an interrupt is requested. Three compare modes are provided:

Mode 0: Upon a match the output signal changes from low to high. It returns to low level at timer overflow.

Mode 1: The transition of the output signal can be determined by software. A timer overflow signal does not affect the compare-output.

Mode 2: In compare mode 2 the concurrent compare output pins on Port 5 are used as follows (see figure 9)

- When a compare match occurs with register COMSET, a high level appears at the pins of port 5 whose corresponding bits in the mask register SETMSK (address $0A5_H$) are set.
- When a compare match occurs in register COMCLR, a low level appears at the pins of port 5 whose corresponding bits in the mask register CLRMSK (address $0A6_H$) are set.

  Additionally the Port 5 pins used for compare mode 2 may also be directly written to by write instructions to SFR P5. Of course, the pins can also be read under program control.

Compare registers CM0 to CM7 use additional compare latches when operated in mode 0. Figure 8 shows the function of these latches. The latches are implemented to prevent from loss of compare matches which may occur when loading of the compare values is not correlated with the timer count. The compare latches are automatically loaded from the compare registers at every timer overflow.

Capture

This feature permits saving of the actual timer/counter contents into a selected register upon an external event or a software write operation. Two modes are provided to 'freeze' the current 16-bit value of timer 2 registers into a dedicated capture register.

Mode 0: Capture is performed in response to a transition at the corresponding port 1 pins CC0 to CC3.

Mode 1: Write operation into the low-order byte of the dedicated capture register causes the timer 2 contents to be latched into this register.

Reload of Timer 2

A 16-bit reload can be performed with the 16-bit CRC register, which is a concatenation of the 8-bit registers CRCL and CRCH. There are two modes from which to select:

Mode 0: Reload is caused by a timer overflow (auto-reload).

Mode 1: Reload is caused in response to a negative transition at pin T2EX (P1.5), which can also request an interrupt.

Timer/Counters 0 and 1

These timer/counters are fully compatible with timer/counter 0 or 1 of the SAB 8051 and can operate in four modes:

Mode 0: 8-bit timer/counter with 32:1 prescaler

Mode 1: 16-bit timer/counter

Mode 2: 8-bit timer/counter with 8-bit auto reload

Mode 3: Timer/counter 0 is configured as one 8-bit timer; timer/counter 1 in this mode holds its count.

External inputs $\overline{\text{INT0}}$ and $\overline{\text{INT1}}$ can be programmed to function as a gate for timer/counters 0 and 1 to facilitate pulse width measurements.

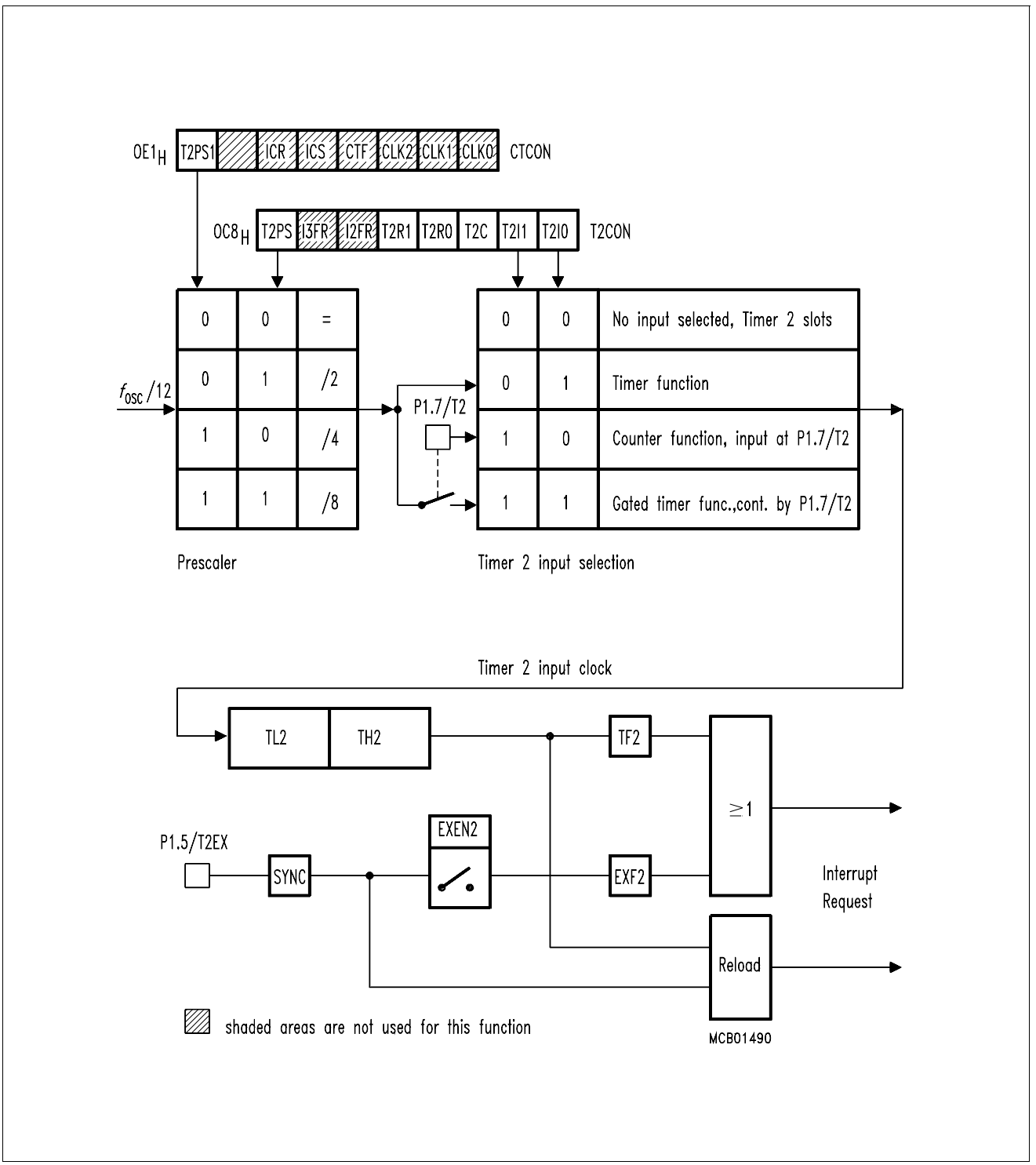


Figure 6
Block Diagram of Timer 2

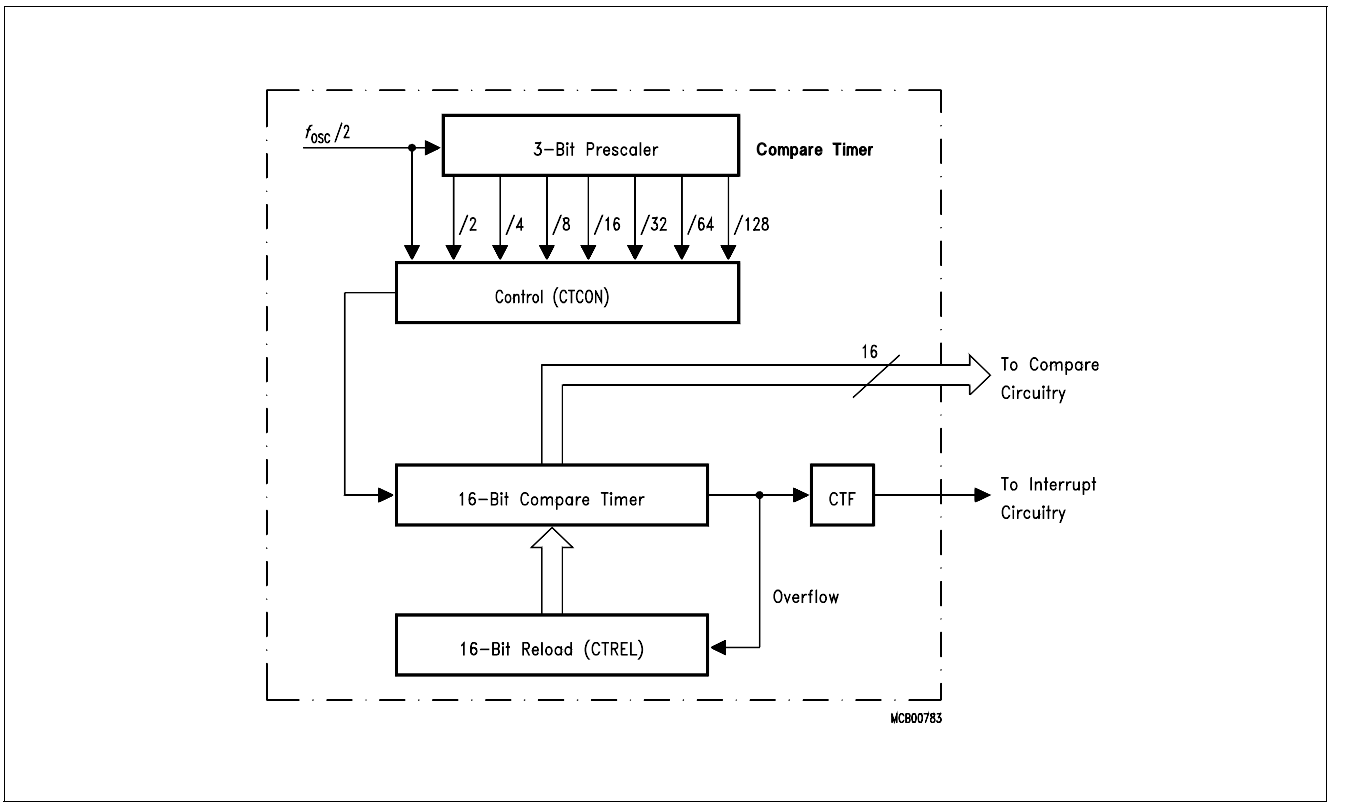


Figure 7
Block Diagram of the Compare Timer

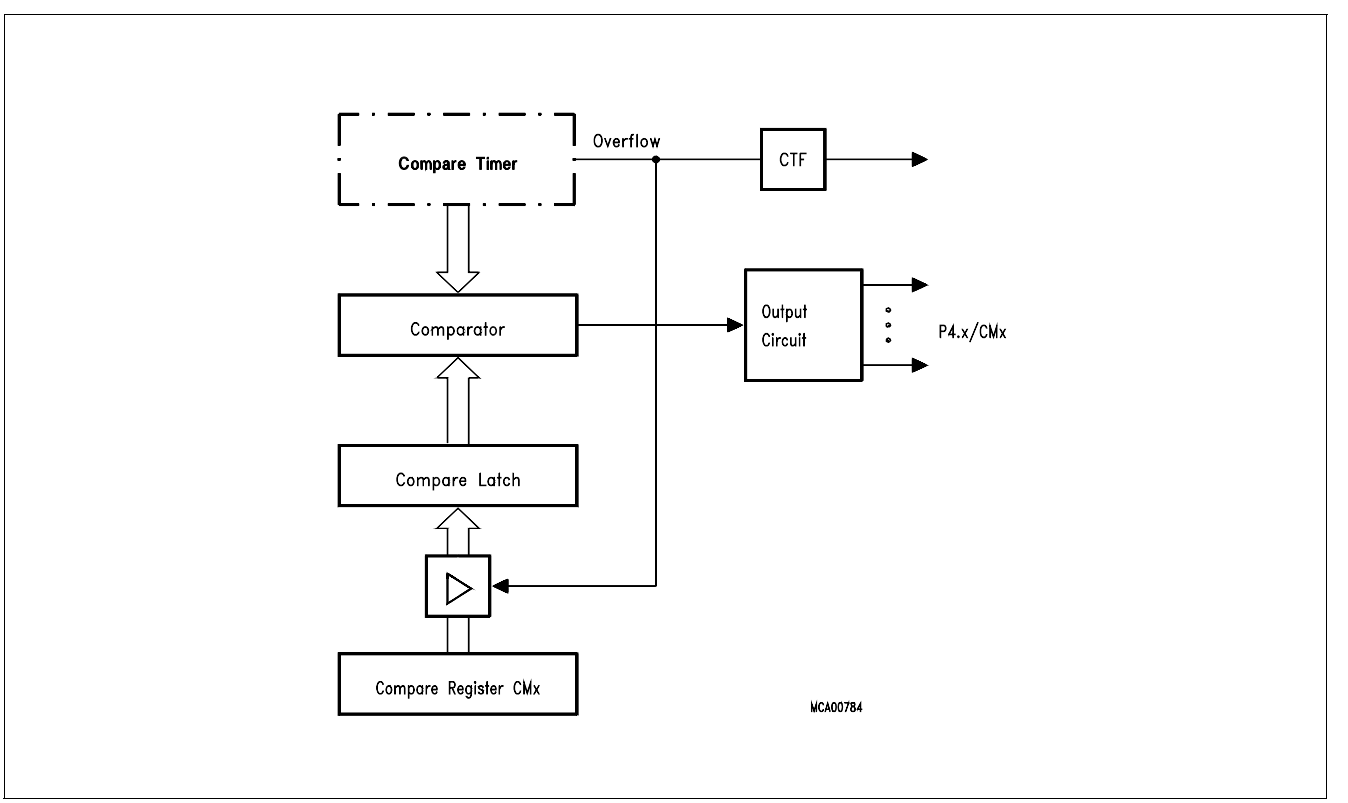


Figure 8
Compare-Mode 0 with Registers CM0 to CM7

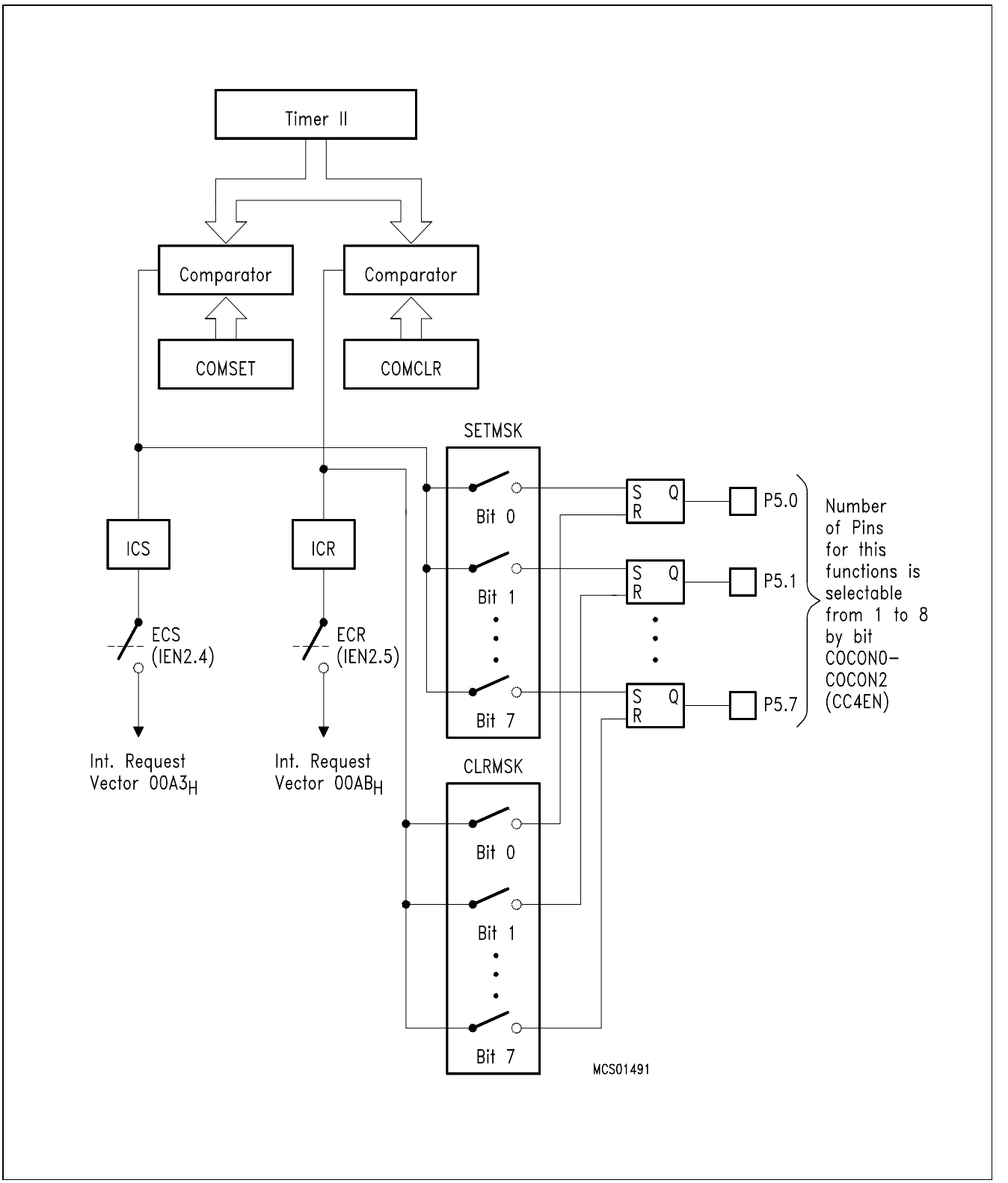


Figure 9
Compare-Mode 2 (Port 5 only)

Interrupt Structure

The SAB 80C517A has 17 interrupt vectors with the following vector addresses and request flags.

Table 5
Interrupt Sources and Vectors

Interrupt Request Flags	Interrupt Vector Address	Interrupt Source
IE0	0003_H	External interrupt 0
TF0	$000B_H$	Timer 0 overflow
IE1	0013_H	External interrupt 1
TF1	$001B_H$	Timer 1 overflow
RI0 + TI0	0023_H	Serial channel 0
TF2 + EXF2	$002B_H$	Timer 2 overflow/ext. reload
IADC	0043_H	A/D converter
IEX2	$004B_H$	External interrupt 2
IEX3	0053_H	External interrupt 3
IEX4	$005B_H$	External interrupt 4
IEX5	0063_H	External interrupt 5
IEX6	$006B_H$	External interrupt 6
RI1/TI1	0083_H	Serial channel 1
ICMP0 to ICMP7	0093_H	Compare match interrupt of Compare Registers CM0-CM7 assigned to Timer 2
CTF	$009B_H$	Compare timer overflow
ICS	$00A3_H$	Compare match interrupt of Compare Register COMSET
ICR	$00AB_H$	Compare match interrupt of Compare Register COMCLR

Each interrupt vector can be individually enabled/disabled. The response time to an interrupt request is more than 3 machine cycles and less than 9 machine cycles.

External interrupts 0 and 1 can be activated by a low-level or a negative transition (selectable) at their corresponding input pin, external interrupts 2 and 3 can be programmed for triggering on a negative or a positive transition. The external interrupts 2 to 6 are combined with the corresponding alternate functions compare (output) and capture (input) on port 1.

For programming of the priority levels the interrupt vectors are combined to pairs or triples. Each pair or triple can be programmed individually to one of four priority levels by setting or clearing one bit in special function register IP0 and one in IP1. Figure 9 shows the interrupt request sources, the enabling and the priority level structure.

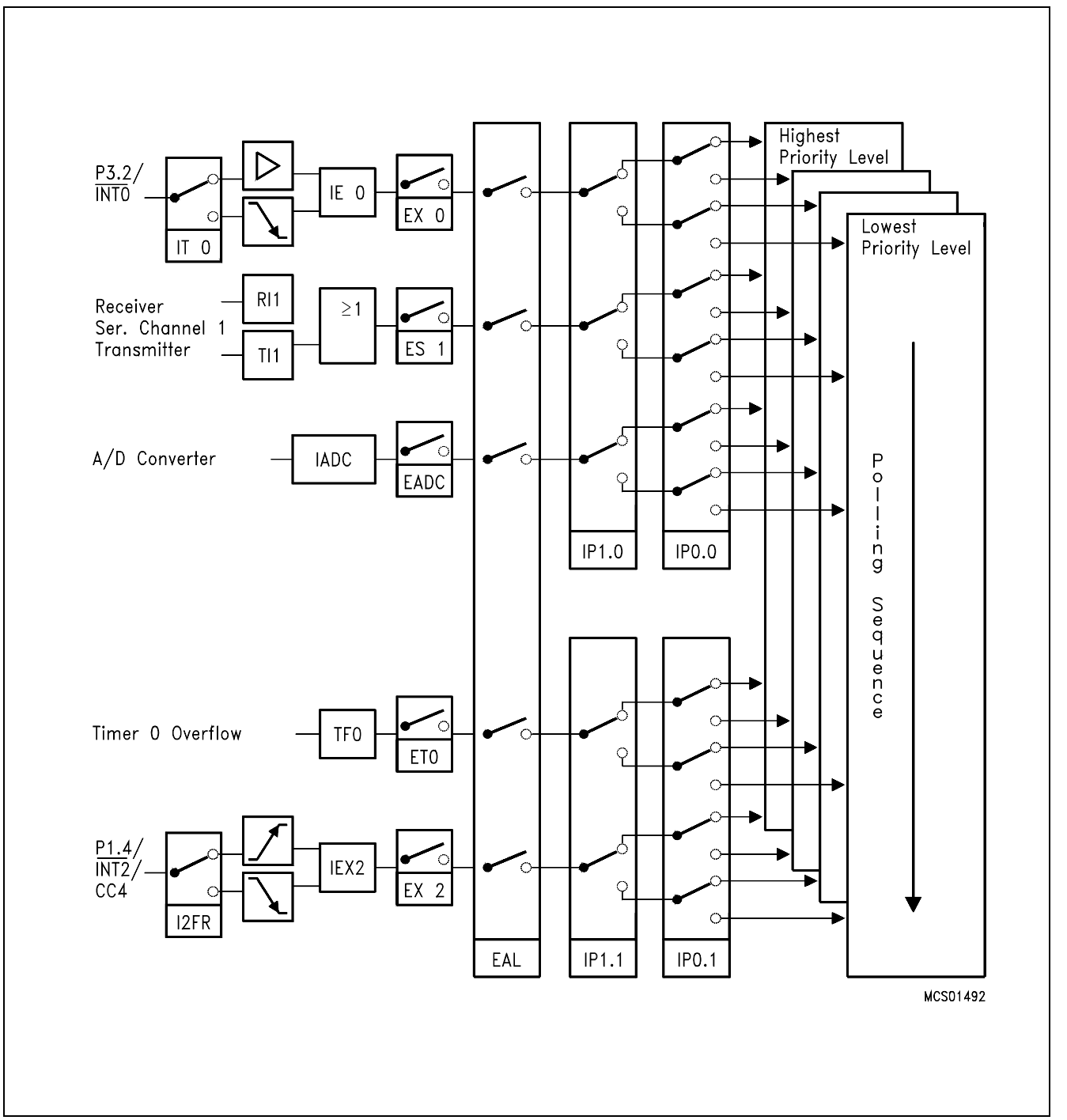


Figure 10
Interrupt Structure of the SAB 80C517A

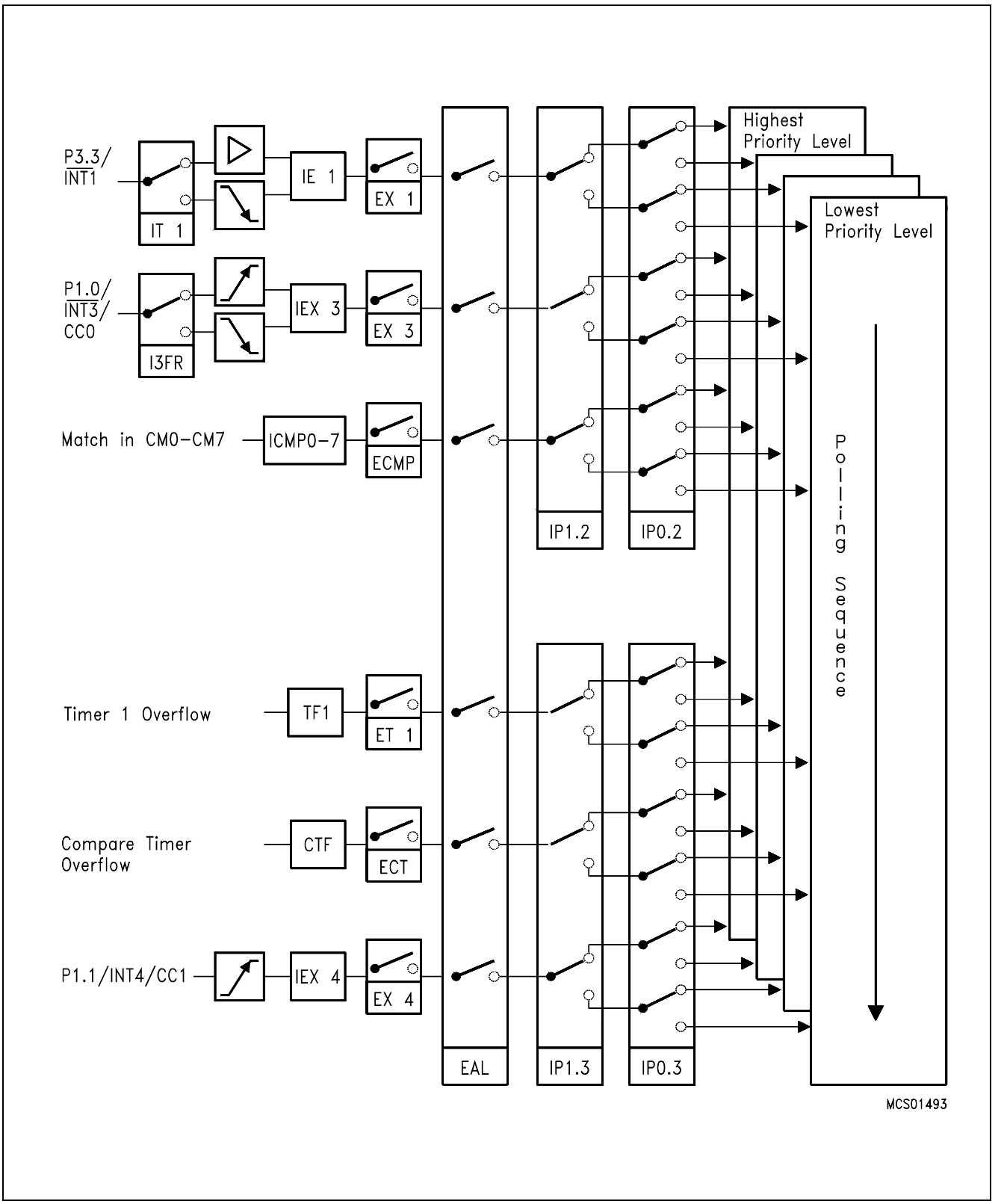


Figure 10
Interrupt Structure of the SAB 80C517A (cont'd)

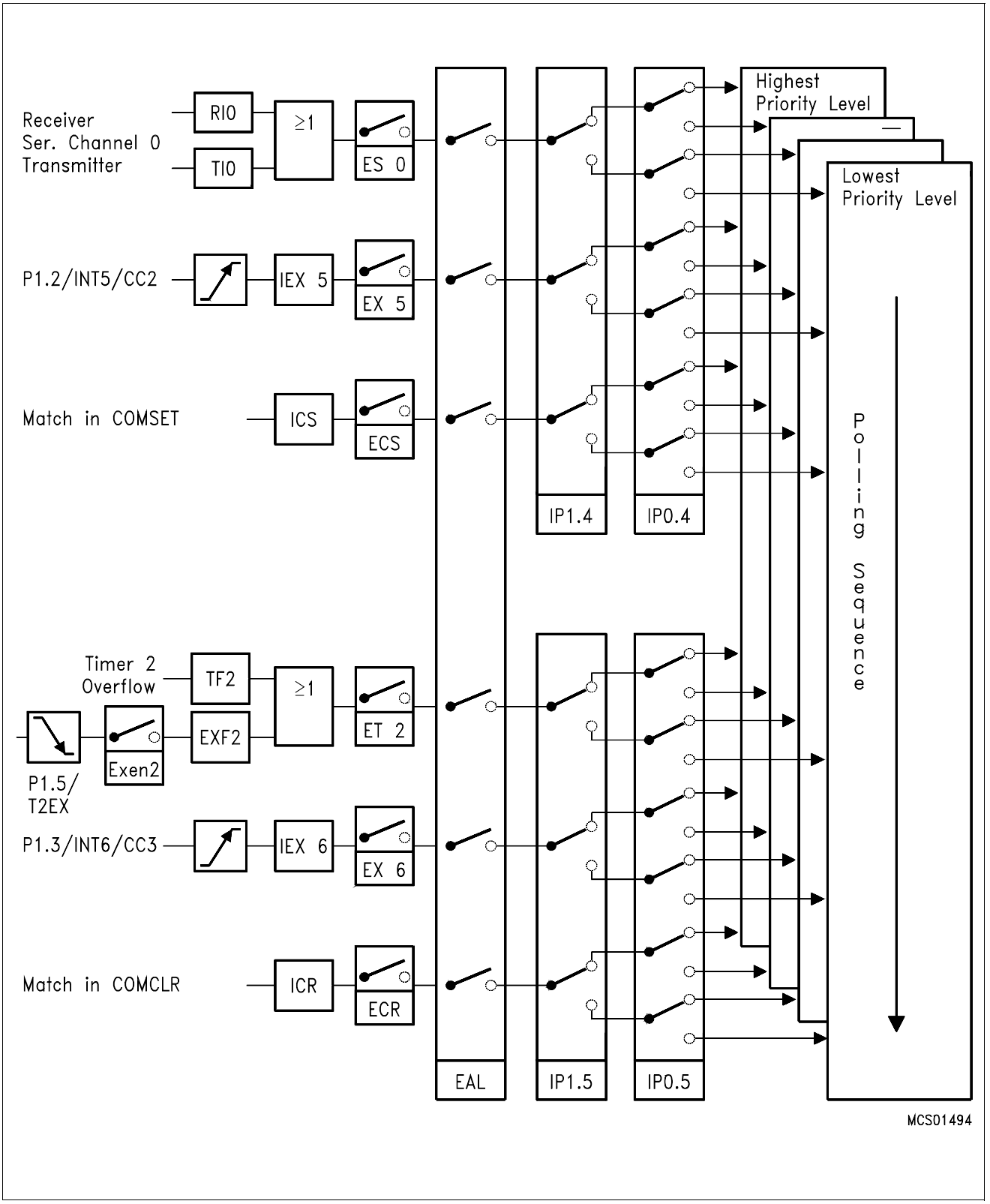


Figure 10
Interrupt Structure of the SAB 80C517A (cont'd)

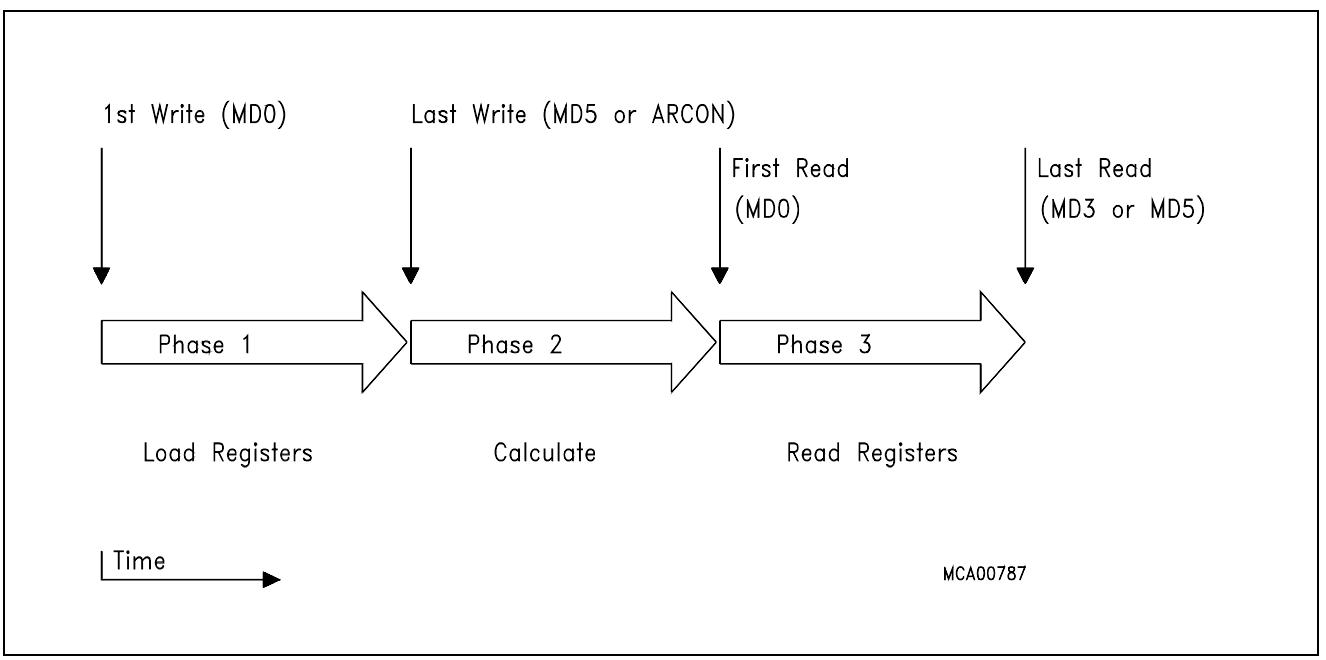
Multiplication/Division Unit

This on-chip arithmetic unit provides fast 32-bit division, 16-bit multiplication as well as shift and normalize features. All operations are integer operation.

Operation	Result	Remainder	Execution Time
32-bit/16-bit	32-bit	16-bit	6 t_{cy} [1]
16-bit/16-bit	16-bit	16-bit	4 t_{cy}
16-bit *16-bit	32-bit	–	4 t_{cy}
32-bit normalize	–	–	6 t_{cy} [2]
32-bit shift left/right	–	–	6 t_{cy} [2]

[1] 1 t_{cy} = 1 µs @ 12 MHz oscillator frequency.
[2] The maximal shift speed is 6 shifts/cycle.

The MDU consists of six registers used for operands and results and one control register. Operation of the MDU can be divided in three phases:



Operation of the MDU

To start an operation, register MD0 to MD5 (or ARCON) must be written to in a certain sequence according to table 5 or 6. The order the registers are accessed determines the type of the operation. A shift operation is started by a final write operation to register ARCON (see also the register description).

Table 6
Performing a MDU-Calculation

Operation	32 Bit/16 Bit		16 Bit/16 Bit		16 Bit * 16 Bit	
First Write	MD0	D'endL	MD0	D'endL	MD0	M'andL
	MD1	D'end	MD1	D'endH	MD4	M'orL
	MD2	D'end				
	MD3	D'endH	MD4	D'orL	MD1	M'andH
	MD4	D'orL				
Last Write	MD5	D'orH	MD5	D'orH	MD5	M'orH
First Read	MD0	QuoL	MD0	QuoL	MD0	PrL
	MD1	Quo	MD1	QuoH	MD1	
	MD2	Quo				
	MD3	QuoH	MD4	RemL	MD2	
	MD4	RemL				
Last Read	MD5	RemH	MD5	RemH	MD3	PrH

Table 7
Shift Operation with the MDU

Operation	Normalize, Shift Left, Shift Right	
First Write	MD0	least significant byte
	MD1	
	MD2	
	MD3	most significant byte
Last Write	ARCON	start of conversion
First Read	MD0	least significant byte
	MD1	
	MD2	
Last Read	MD3	most significant byte

Abbreviations

D'end : Dividend, 1st operand of division
D'or : Divisor, 2nd operand of division
M'and : Multiplicand, 1st operand of multiplication
M'or : Multiplicator, 2nd operand of multiplication
Pr : Product, result of multiplication
Rem : Remainder
Quo : Quotient, result of division
...L : means, that this byte is the least significant of the 16-bit or 32-bit operand
...H : means, that this byte is the most significant of the 16-bit or 32-bit operand

I/O Ports

The SAB 80C517A has seven 8-bit I/O ports and two input ports (8-bit and 4-bit wide).

Port 0 is an open-drain bidirectional I/O port, while ports 1 to 6 are quasi-bidirectional I/O ports

with internal pull-up resistors. That means, when configured as inputs, ports 1 to 6 will be pulled high and will source current when externally pulled low. Port 0 will float when configured as input.

Port 0 and port 2 can be used to expand the program and data memory externally. During an access to external memory, port 0 emits the low-order address byte and reads/writes the data byte, while port 2 emits the high-order address byte. In this function, port 0 is not an open-drain port, but uses a strong internal pull-up FET. Port 1, 3, 4, 5 and port 6 provide several alternate functions. Please see the "Pin Description" for details.

Port pins show the information written to the port latches, when used as general purpose port. When an alternate function is used, the port pin is controlled by the respective peripheral unit. Therefore the port latch must contain a "one" for that function to operate. The same applies when the port pins are used as inputs. Ports 1, 3, 4 and 5 are bit- addressable.

The SAB 80C517A has two dual-purpose input ports. The twelve port lines at port 7 and port 8 can be used as analog inputs for the A/D converter. If input voltages at P7 and P8 meet the specified digital input levels (V_{IL} and V_{IH}) the port can also be used as digital input port.

In Hardware Power Down Mode the port pins and several control lines enter a floating state. For more details see the section about Hardware Power Down Mode.

Power Saving Modes

The SAB 80C517A provides – due to Siemens ACMOS technology – four modes in which power consumption can be significantly reduced.

- The **Slow Down Mode**
  The controller keeps up the full operating functionality, but is driven with one eighth of its normal operating frequency. Slowing down the frequency remarkable reduces power consumption.
- The **Idle Mode**
  The CPU is gated off from the oscillator, but all peripherals are still supplied with the clock and continue working.
- The **Power Down Mode**
  Operation of the SAB 80C517A is stopped, the on-chip oscillator and the RC-oscillator are turned off. This mode is used to save the contents of the internal RAM with a very low standby current.
- **The Hardware Power Down Mode**
  Operation of the SAB 80C517A is stopped, the on-chip oscillator and the RC-Oscillator are turned off. The pin $\overline{\text{HWPD}}$ controls this mode. Port pins and several control lines enter a floating state. The Hardware Power Down Mode is independent of the state of pin $\overline{\text{PE}}$/SWD.

Hardware Enable for Software controlled Power Saving Modes

A dedicated Pin $\overline{\text{PE}}$/SWD) of the SAB 80C517A allows to block the Software controlled power saving modes. Since this pin is mostly used in noise-critical application it is combined with an automatic start of the Watchdog Timer.

$\overline{\text{PE}}$/SWD = V_{IH} (logic high level):	Using of the power saving modes is not possible. The watchdog timer starts immediately after reset. The instruction sequences used for entering of power saving modes will not affect the normal operation of the device.
$\overline{\text{PE}}$/SWD = V_{IL} (logic low level):	All power saving modes can be activated by software.

When left unconnected, Pin /$\overline{\text{PE}}$/SWD is pulled high by a weak internal pullup. This is done to provide system protection on default.

The logic-level applied to pin $\overline{\text{PE}}$/SWD can be changed during program execution to allow or to block the use of the power saving modes without any effect on the on-chip watchdog circuitry.

Requirements for Hardware Power Down Mode

There is no dedicated pin to enable the Hardware Power Down Mode. Nevertheless for a correct function of the Hardware Power Down Mode the oscillator watchdog unit including its internal RC oscillator is needed. Therefore this unit must be enabled by pin OWE (OWE = high). However, the control pin $\overline{PE}$/SWD has no control function in this mode. It enables and disables only the use of software controlled power saving modes.

Software controlled power saving modes

All of these modes are entered by software. Special function register PCON (power control register, address is 87_H) is used to select one of these modes.

Slow Down Mode

During slow down operation all signal frequencies that are derived from the oscillator clock, are divided by eight, also the clockout signal and the watchdog timer count.

The slow down mode is enabled by setting bit SD. The controller actually enters the slow down mode after a short synchronisation period (max. 2 machine cycles).

The slow down mode is disabled by clearing bit SD.

Idle Mode

During idle mode all peripherals of the SAB 80C517A (except for the watchdog timer) are still supplied by the oscillator clock. Thus the user has to take care which peripheral should continue to run and which has to be stopped during Idle.

The procedure to enter the idle mode is similar to the one entering the power down mode. The two bits IDLE and IDLS must be set by two consecutive instructions to minimize the chance of unintentional activating of the idle mode.

There are two ways to terminate the idle mode:

– The idle mode can be terminated by activating any enabled interrupt. This interrupt will be serviced and the instruction to be executed following the RETI instruction will be the one following the instruction that set the bit IDLS.

– The other way to terminate the idle mode, is a hardware reset. Since the oscillator is still running, the hardware reset must be held active only for two machine cycles for a complete reset.

Normally the port pins hold the logical state they had at the time idle mode was activated. If some pins are programmed to serve their alternate functions they still continue to output during idle mode if the assigned function is on. The control signals ALE and hold at logic high levels $\overline{PSEN}$ (see table 8).

Power Down Mode

The power down mode is entered by two consecutive instructions directly following each other. The first instruction has to set the flag PDE (power down enable) and must not set PDS (power down set). The following instruction has to set the start bit PDS. Bits PDE and PDS will automatically be cleared after having been set.

The instruction that sets bit PDS is the last instruction executed before going into power down mode. The only exit from power down mode is a hardware reset.

The status of all output lines of the controller can be looked up in table 8.

Hardware Controlled Power Down Mode

The pin $\overline{\text{HWPD}}$ controls this mode. If it is on logic high level (inactive) the part is running in the normal operating modes. If pin $\overline{\text{HWPD}}$ gets active (low level) the part enters the Hardware Power Down Mode; this is independent of the state of pin $\overline{\text{PE}}$/SWD.

$\overline{\text{HWPD}}$ is sampled once per machine cycle. If it is found active, the device starts a complete internal reset sequence. The watchdog timer is stopped and its status flag WDTS is cleared exactly the same effects as a hardware reset. In this phase the power consumption is not yet reduced. After completion of the internal reset both oscillators of the chip are disabled. At the same time the port pins and several control lines enter a floating state as shown in table 8. In this state the power consumption is reduced to the power down current IPD. Also the supply voltage can be reduced. Table 8 also lists the voltages which may be applied at the pins during Hardware Power Down Mode without affecting the low power consumption.

Termination of HWPD Mode:

This power down state is maintained while pin $\overline{\text{HWPD}}$ is held active. If HWPD goes to high level (inactive state) an automatic start up procedure is performed:

- First the pins leave their floating condition and enter their default reset state (as they had immediately before going to float state).
- Both oscillators are enabled (only if OWE = high). The oscillator watchdog's RC oscillator starts up very fast (typ. less than 2 microseconds).
- Because the oscillator watchdog is active it detects a failure condition if the on-chip oscillator hasn't yet started. Hence, the watchdog keeps the part in reset and supplies the internal clock from the RC oscillator.
- Finally, when the on-chip oscillator has started, the oscillator watchdog releases the part from reset with oscillator watchdog status flag not set.
  When automatic start of the watchdog was enabled ($\overline{\text{PE}}$/SWD connected to V_{CC}), the Watchdog Timer will start, too (with its default reload value for time-out period).
- The $\overline{\text{Reset}}$ pin overrides the Hardware Power Down function, i.e. if reset gets active during Hardware Power Down it is terminated and the device performs the normal reset function. (Thus, pin $\overline{\text{Reset}}$ has to be inactive during Hardware Power Down Mode).

Table 8
Status of all pins during Idle Mode, Power Down Mode and Hardware Power Down Mode

Pins	Idle Mode Last instruction executed from		Power Down Mode Last instruction executed from		Hardware Power Down	
	internal ROM	external ROM	internal ROM	external ROM	Status	Voltage range at pin
P0	Data	float	Data	float		
P1	Data alt outputs	Data alt outputs	Data last outputs	Data last outputs	floating	
P2	Data	Address	Data	Data	output	
P3	Data alt outputs	Data alt outputs	Data last output	Data last output	outputs	
P4	Data alt outputs	Data alt outputs	Data last outputs	Data last output	disabled	$V_{SS} \leq V_{IN} \leq V_{CC}$
P5	Data alt output	Data alt output	Data last output	Data last output	input	
P6	Data alt output	Data alt output	Data last output	Data last output	function	
P7						
P8						
EA					active input	$V_{IN} = V_{CC}$ or $V_{IN} = V_{SS}$
$\overline{PE}$/SWD					active input pull-up disabled	$V_{IN} = V_{CC}$ or $V_{IN} = V_{SS}$
XTAL1					active output	pin may not be driven
XTAL2					disabled input functions	$V_{SS} \leq V_{IN} \leq V_{CC}$

Table 8
Status of all pins during Idle Mode, Power Down Mode and Hardware Power Down Mode (cont'd)

Pins	Idle Mode Last instruction executed from		Power Down Mode Last instruction executed from		Hardware Power Down	
	internal ROM	**external ROM**	**internal ROM**	**external ROM**	**Status**	**Voltage range at pin**
$\overline{\text{PSEN}}$					floating outp. disabled input functions	$V_{SS} \leq V_{IN} \leq V_{CC}$
ALE						
VAREF VAGND					active supply pins	$V_{AGND} \leq V_{IN} \leq V_{CC}$
OWE					active input, must be high pull-up disabl.	$V_{IN} = V_{CC}$
$\overline{\text{RESET}}$					active input must be high	$V_{IN} = V_{CC}$
$\overline{\text{RO}}$					floating output	$V_{SS} \leq V_{IN} \leq V_{CC}$

Serial Interfaces

The SAB 80C517A has two serial interfaces. Both interfaces are full duplex and receive buffered. They are functionally identical with the serial interface of the SAB 8051 when working as asynchronous channels. Serial interface 0 additionally has a synchronous mode. Table 9 shows possible configurations and the according baud rates.

Table 9
Baud Rate Generation

	Mode		**Mode 0**			–
8-Bit syn-chron-ous channel	Baud-rate	f_{OSC} =12 MHz	1MHz			–
		f_{OSC} = 16 MHz	1.33 MHz			–
		f_{OSC} = 18 MHz	1.5 MHz			–
	derived from		f_{OSC}			–
	Mode		**Mode 1**			**Mode B**
8-Bit UART	Baud-rate	f_{OSC} = 12 MHz	1 Baud – 62.5 kBaud		183 Baud – 375 kBaud	366 Baud – 375 kBaud
		f_{OSC} = 16 MHz	1 Baud – 83 kBaud		244 Baud – 500 kBaud	244 Baud – 500 kBaud
		f_{OSC} = 18 MHz	1 Baud – 93.7 kBaud		2375 Baud – 562.5 kBaud	549 Baud – 562.5 kBaud
	derived from		Timer 1		10-Bit Baudrate Generator	10-Bit Baudrate Generator
	Mode		**Mode 2**	**Mode 3**		**Mode A**
9-Bit UART	Baud-rate	f_{OSC} = 12 MHz	187.5 kBaud/ 375 kBaud	1 Baud – 62.5 kBaud	183 Baud – 75 kBaud	183 Baud – 75 kBaud
		f_{OSC}= 16 MHz	250 Baud/ 500 kBaud	1 Baud – 83.3 kBaud	244 Baud – 500 kBaud	244 Baud – 500 kBaud
		f_{OSC} = 18 MHz	281.2 kBaud/ 562.5 kBaud	1 Baud – 93.7 kBaud	275 Baud 562.5 kBaud	549 Baud – 562.5 kBaud
	derived from	$f_{OSC}/2$	Timer 1	10-Bit Baudrate Generator		10-Bit Baudrate Generator

Serial Interface 0

Serial Interface 0 can operate in 4 modes:

Mode 0: Shift register mode:
Serial data enters and exits through R × D0. T × D0 outputs the shift clock 8 data bits are transmitted/received (LSB first). The baud rate is fixed at 1/12 of the oscillator frequency.

Mode 1: 8-bit UART, variable baud rate:
10-bit are transmitted (through T × D0) or received (through R × D0): a start bit (0), 8 data bits (LSB first), and a stop bit (1). On reception, the stop bit goes into RB80 in special function register S0CON. The baud rate is variable.

Mode 2: 9-bit UART, fixed baud rate:
11-bit are transmitted (through T × D0) or received (through R × D0): a start bit (0), 8 data bits (LSB first), a programmable 9th, and a stop bit (1). On transmission, the 9th data bit (TB80 in S0CON) can be assigned to the value of 0 or 1. For example, the parity bit (P in the PSW) could be moved into TB80 or a second stop bit by setting TB80 to 1. On reception the 9th data bit goes into RB80 in special function register S0CON, while the stop bit is ignored. The baud rate is programmable to either 1/32 or 1/64 of the oscillator frequency.

Mode 3: 9-bit UART, variable baud rate:
11-bit are transmitted (through T × D0) or received (through R × D0): a start bit (0), 8 data bits (LSB first), a programmable 9th, and a stop bit (1). In fact, mode 3 is the same as mode 2 in all respects except the baud rate. The baud rate in mode 3 is variable.

Variable Baud Rates for Serial Interface 0

Variable baud rates for modes 1 and 3 of serial interface 0 can be derived from either timer 1 or a dedicated Baudrate Generator.

The baud rate is generated by a free running 10-bit timer with programmable reload register.

$$\text{Mode 1.3 baud rate} = \frac{2^{SMOD} * f_{OSC}}{64*(2^{10}\text{-S0REL})}$$

The default value after reset in the reload registers S0RELL and S0RELH provide a baud rate of 4.8 kBaud (SMOD = 0) or 9.6 kBaud (SMOD = 1) at 12 MHz oscillator frequency. This guarantees full compatibility to the SAB 80C517.

Serial Interface 1

Serial interface 1 can operate in two asynchronous modes:

Mode A: 9-bit UART, variable baud rate.
11 bits are transmitted (through T × D1) or received (through R × D1): a start bit (0), 8 data bits (LSB first), a programmable 9th, and a stop bit (1). On transmission, the 9th data bit (TB81 in S1CON) can be assigned to the value of 0 or 1. For example, the parity bit (P in the PSW) could be moved into TB81 or a second stop bit by setting TB81 to 1. On reception the 9th data bit goes into RB81 in special function register S1CON, while the stop bit is ignored.

Mode B: 8-bit UART, variable baud rate.
10 bits are transmitted (through T × D1) or received (through R × D1): a start bit (0), 8 data bits (LSB first), and a stop bit (1). On reception, the stop bit goes into RB81 in special function register S1CON.

Variable Baud Rates for Serial Interface 1.

Variable baud rates for modes A and B of serial interface 1 are derived from a dedicated baud rate generator.

The baud rate clock (baud rate = $\frac{\text{baud rate clock}}{16}$) is generated by an 10-bit free running timer with programmable reload register.

Mode A, B baudrate = $\frac{f_{OSC}}{32 * (2^{10} - \text{SREL})}$

Watchdog Units

The SAB 80C517A offers two enhanced fail safe mechanisms, which allow an automatic recovery from hardware failure or software upset:

– programmable watchdog timer (WDT), variable from 512 µs up to appr. 1.1 s time-out period @12 MHz. Upward compatible to SAB 80515 watchdog.

– oscillator watchdog (OWD), monitors the on-chip oscillator and forces the micro-controller into reset state, in case the on-chip oscillator fails, controls the restart from the Hardware Power Down Mode and provides clock for a fast internal reset after power-on.

Programmable Watchdog Timer

The WDT can be activated by hardware or software.

Hardware initialization is done when pin $\overline{PE}$/SWD (Pin 4) is held high during RESET. The SAB 80C517A then starts program execution with the WDT running. Since Pin $\overline{PE}$/SWD is only sampled during Reset (and hardware power down at parts with stepping code AD and later) dynamical switching of the WDT is not possible.

Software initialization is done by setting bit SWDT.

A refresh of the watchdog timer is done by setting bits WDT and SWDT consecutively.

A block diagram of the watchdog timer is shown in figure 11.

When a watchdog timer resest occurs, the watchdog timer keeps on running, but a status flag WDTS is set. This flag can also be cleared by software.

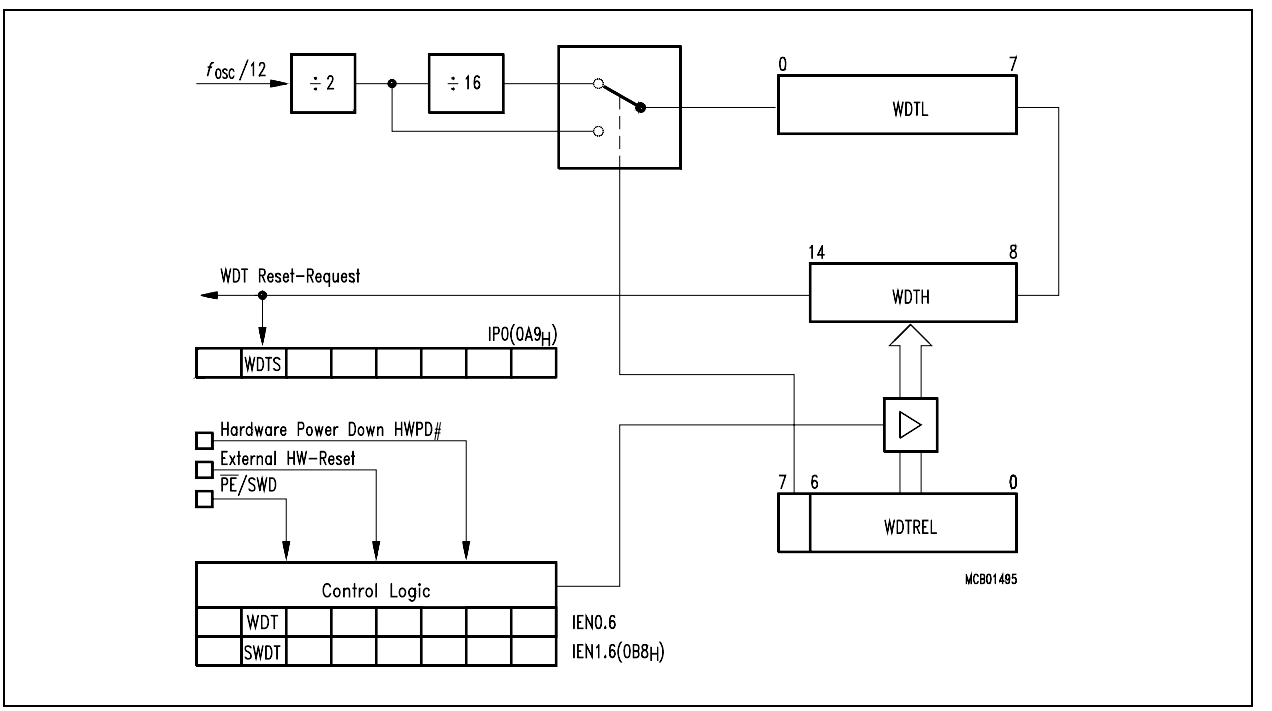


Figure 11
Block Diagram of the Programmable Watchdog Timer

Oscillator Watchdog

The unit serves three functions:

– Monitoring of the on-chip oscillator's function.
  The watchdog supervises the on-chip oscillator's frequency; if it is lower than the frequency of the auxiliary RC oscillator in the watchdog unit, the internal clock is supplied by the RC oscillator and the device is forced into reset; if the failure condition disappears (i.e. the on-chip oscillator has again a higher frequency than the RC oscillator), the part executes a final reset phase of appr. 0.25 ms in order to allow the oscillator to stabilize; then the oscillator watchdog reset is released and the part starts program execution again.

– Restart from the Hardware Power Down Mode.
  If the Hardware Power Down Mode is terminated the oscillator watchdog has to control the correct start-up of the on-chip oscillator and to restart the program. The oscillator watchdog function is only part of the complete Hardware Power Down sequence; however, the watchdog works identically to the monitoring function.

– Fast internal reset after power-on.
  In this function the oscillator watchdog unit provides a clock supply for the reset before the on-chip oscillator has started. In this case the oscillator watchdog unit also works identically to the monitoring function.

If the oscillator watchdog unit is to be used it must be enabled (this is done by applying high level to the control pin OWE).

Figure 12 shows the block diagram of the oscillator watchdog unit. It consists of an internal RC oscillator which provides the reference frequency of the on-chip oscillator. The RC oscillator can be enabled/disabled by the control pin OWE. If it is disabled the complete unit has no function.

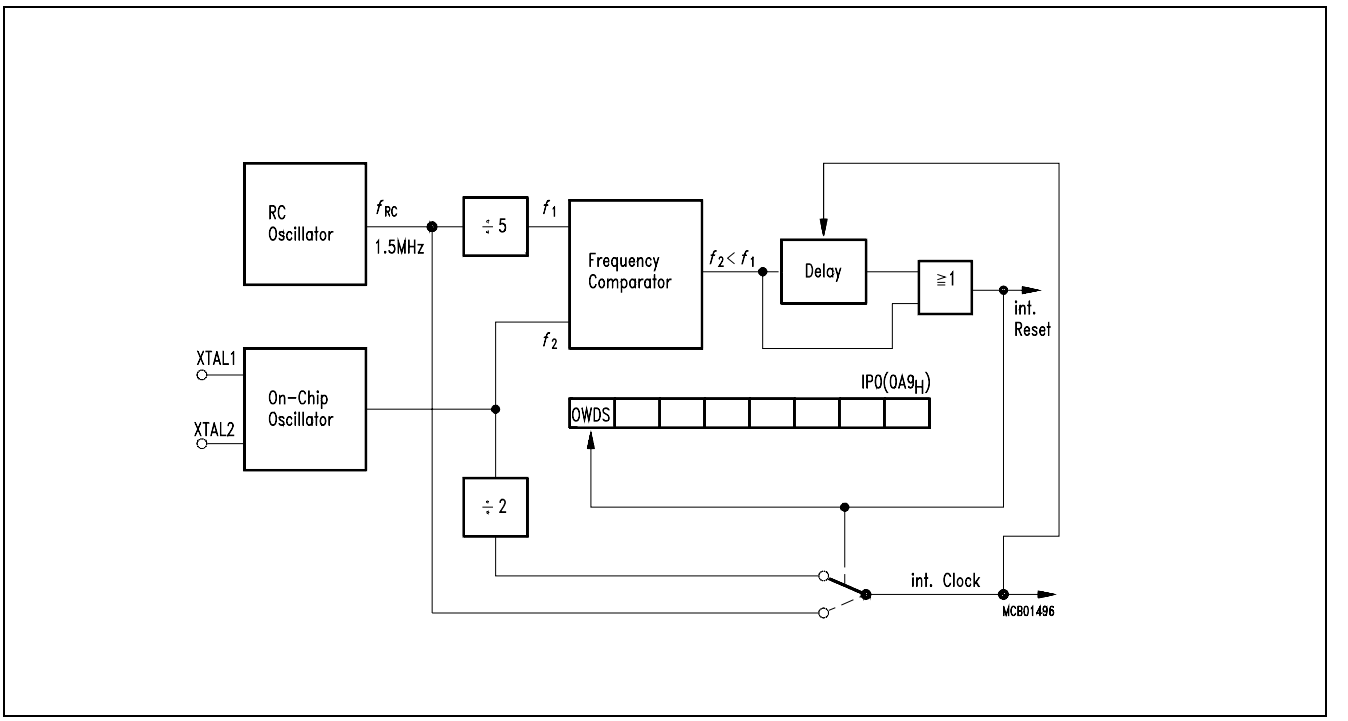


Figure 12
Functional Block Diagram of the Oscillator Watchdog

Fast internal reset after power-on

The SAB 80C517A can use the oscillator watchdog unit for a fast internal reset procedure after power-on.

Normally members of the 8051 family (like the SAB 80C517) enter their default reset state not before the on-chip oscillator starts. The reason is that the external reset signal must be internally synchronized and processed in order to bring the device into the correct reset state. Especially if a crystal is used the start up time of the oscillator is relatively long (typ. 1 ms). During this time period the pins have an undefined state which could have severe effects e.g. to actuators connected to port pins.

In the SAB 80C517A the oscillator watchdog unit avoids this situation. However, the oscillator watchdog must be enabled. In this case, after power-on the oscillator watch-dog's RC oscillator starts working within a very short start-up time (typ. less than 2 micro-seconds). In the following the watchdog circuitry detects a failure condition for the on-chip oscillator because this has not yet started (a failure is always recognized if the watchdog's RC oscillator runs faster than the on-chip oscillator). As long as this condition is valid the watchdog uses the RC oscillator output as clock source for the chip rather than the on-chip oscillator's output.This allows correct resetting of the part and brings also all ports to the defined state.

Delay time between power-on and correct reset state:

Typ.: 18 µs
Max.: 34 µs

Instruction Set

The SAB 80C517A / 83C517A-5 has the same instruction set as the industry standard 8051 microcontroller.

A pocket guide is available which contains the complete instruction set in functional and hexadecimal order. Furtheron it provides helpful information about Special Function Registers, Interrupt Vectors and Assembler Directives.

Literature Information

Title	Ordering No.
Microcontroller Family SAB 8051 Pocket Guide	B158-H6497-X-X-7600

Absolute Maximum Ratings

Ambient temperature under bias ..... – 40 to 110° C
Storage temperature ..... – 65 to 150 °C
Voltage on V_{CC} pins with respect to ground (V_{SS}) ..... – 0.5 V to 6.5 V
Voltage on any pin with respect to ground (V_{SS}) ..... – 0.5 to V_{CC} +0.5 V
Input current on any pin during overload condition ..... – 10mA to +10mA
Absolute sum of all input currents during overload condition ..... |100mA|
Power dissipation ..... 1 W

Note *Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage of the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for longer periods may affect device reliability. During overload conditions (V_{IN} > V_{CC} or V_{IN} < V_{SS}) theVoltage on V_{CC} pins with respect to ground (V_{SS}) must not exeed the values definded by the absolute maximum ratings.*

DC Characteristics

V_{CC} = 5 V + 10 %, – 15 %; V_{SS} = 0 V
T_A = 0 to 70 °C for the SAB 80C517A/83C517A-5
T_A = – 40 to 85 °C for the SAB 80C517A-T3/83C517A-5-T3
T_A = – 40 to 110 °C for the SAB 80C517A-T4/83C517A-5-T4

Parameter	Symbol	Limit Values		Unit	Test condition
		min.	max.		
Input low voltage (except $\overline{EA}$, $\overline{RESET}$, $\overline{HWPD}$)	V_{IL}	– 0.5	0.2 V_{CC} – 0.1	V	–
Input low voltage ($\overline{EA}$)	V_{IL1}	– 0.5	0.2 V_{CC} – 0.3	V	–
Input low voltage ($\overline{HWPD}$, $\overline{RESET}$)	V_{IL2}	– 0.5	0.2 V_{CC} + 0.1	V	–
Input high voltage (except $\overline{RESET}$, XTAL2 and $\overline{HWPD}$	V_{IH}	0.2 V_{CC} + 0.9	V_{CC} + 0.5	V	–
Input high voltage to XTAL2	V_{IH1}	0.7 V_{CC}	V_{CC} + 0.5	V	–
Input high voltage to $\overline{RESET}$ and $\overline{HWPD}$	V_{IH2}	0.6 V_{CC}	V_{CC} + 0.5	V	–

DC Characteristics (cont'd)

Parameter	Symbol	Limit Values		Unit	Test condition
		min.	max.		
Output low voltage (ports 1, 2, 3, 4, 5, 6)	V_{OL}	–	0.45	V	I_{OL}=1.6 mA[1)]
Output low voltage (ports ALE, $\overline{PSEN}$, $\overline{RO}$)	V_{OL1}	–	0.45	V	I_{OL}=3.2 mA [1)]
Output high voltage (ports 1, 2, 3, 4, 5, 6)	V_{OH}	2.4 0.9 V_{CC}	– –	V V	I_{OH} =–80 µA I_{OH} =–10 µA
Output high voltage (port 0 in external bus mode, ALE, $\overline{PSEN}$, $\overline{RO}$)	V_{OH1}	2.4 0.9 V_{CC}	– –	V V	I_{OH} =–800 µA[2)] I_{OH} =–80 µA[2)]
Logic input low current (ports 1, 2, 3, 4, 5, 6)	I_{IL}	– 10	– 70	µA	V_{IN} = 0.45 V
Logical 1-to-0 transition current (ports 1, 2, 3, 4, 5, 6)	I_{TL}	– 65	– 650	µA	V_{IN} = 2 V
Input leakage current (port 0, $\overline{EA}$, ports 7, 8, $\overline{HWPD}$)	I_{LI}	–	± 100	nA	0.45 < V_{IN} < V_{CC}
			± 150	nA	0.45 < V_{IN} < V_{CC} T_A > 100 °C
Input low current to $\overline{RESET}$ for reset	I_{IL2}	– 10	–100	µA	V_{IN} = 0.45 V
Input low current (XTAL2)	I_{IL3}	–	– 15	µA	V_{IN} = 0.45 V
Input low current ($\overline{PE}$/SWD, OWE)	I_{IL4}	–	– 20	µA	V_{IN} = 0.45 V
Pin capacitance	C_{IO}	–	10	pF	f_C= 1 MHz T_A= 25 °C
Power supply current: Active mode, 12 MHz[7)] Active mode, 18 MHz[7)] Idle mode, 12 MHz[7)] Idle mode, 18 MHz[7)] Slow down mode, 12 MHz Slow down mode, 18 MHz Power Down Mode	 I_{CC} I_{CC} I_{CC} I_{CC} I_{CC} I_{CC} I_{PD}	 – – – – – – –	 28 37 24 31 12 16 50	 mA mA mA mA mA mA µA	 V_{CC} = 5 V,[4)] V_{CC} = 5 V,[4)] V_{CC} = 5 V,[5)] V_{CC} = 5 V,[5)] V_{CC} = 5 V,[6)] V_{CC} = 5 V,[6)] V_{CC} = 2...5.5 V, [3)]

Notes see page 63.

Notes for page 62:

1) Capacitive loading on ports 0 and 2 may cause spurious noise pulses to be superimposed on the V_{OL} of ALE and ports 1, 3, 4, 5 and 6. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins make 1-to-0 transitions during bus operation. In the worst case (capacitive loading > 100 pF), the noise pulse on ALE line may exceed 0.8 V. In such cases it may be desirable to qualify ALE with a schmitt-trigger, or use an address latch with a schmitt-trigger strobe input.

2) Capacitive loading on ports 0 and 2 may cause the V_{OH} on ALE and $\overline{PSEN}$ to momentarily fall below the 0.9 V_{CC} specification when the address lines are stabilizing.

3) I_{PD} (Power down mode) is measured with:
$\overline{EA}$ = $\overline{RESET}$ = $V_{CC;}$ Port0 = Port7 = Port8 = V_{CC}; XTAL1 = N.C.; XTAL2 = V_{SS};
$\overline{PE}$/SWD = OWE = V_{SS};$\overline{HWDP}$ = V_{CC} (Software Power Down mode); V_{AREF} = V_{CC};
V_{AGND} = V_{SS}; all other pins are disconnected. Hardware Powerdown I_{PD} : OWE =V_{CC} or V_{SS}. No certain pin connection for the other pins.

4) I_{CC} (active mode) is measured with:
XTAL2 driven with t_{CLCH}, t_{CHCL} = 5 ns, V_{IL} = V_{SS} + 0.5 V, V_{IH} = V_{CC} – 0.5 V; XTAL1 = N.C.;
$\overline{EA}$ = $\overline{PE}$/SWD = V_{CC}; Port0 = Port7 = Port8 = V_{CC}; $\overline{HWPD}$ = V_{CC}; $\overline{RESET}$ = V_{SS}
all other pins are disconnected. I_{CC} would be slightly higher if a crystal oscillator is used (appr. 1 mA).

5) I_{CC} (Idle mode) is measured with all output pins disconnected and with all peripherals disabled; XTAL2 driven with t_{CLCH}, t_{CHCL} = 5 ns, V_{IL} = V_{SS} + 0.5 V, V_{IH} = V_{CC} – 0.5 V;
XTAL1 = N.C.; $\overline{RESET}$ = V_{CC}; $\overline{HWPD}$ = V_{CC}; Port0 = Port7 = Port8 =V_{CC} ;
$\overline{EA}$ = $\overline{PE}$/SWD = V_{SS}; all other pins are disconnected;

6) I_{CC} (slow down mode) is measured with all output pins disconnected and with all peripherals disabled; XTAL2 driven with t_{CLCH}, t_{CHCL} = 5 ns, V_{IL} = V_{SS} + 0.5 V, V_{IH} =V_{CC} – 0.5 V;
XTAL1 = N.C.;$\overline{RESET}$= V_{CC}; $\overline{HWPD}$ = V_{CC}; Port7 = Port8 = V_{CC}; $\overline{EA}$ = $\overline{PE}$/SWD = V_{SS} ;
all other pins are disconnected;

7) $I_{CC\,Max}$ at other frequencies is given by:
active mode: I_{CC} (max) = 1.50* f_{OSC} + 10
idle mode: I_{CC} (max) = 1.17* f_{OSC} + 10
where f_{OSC} is the oscillator frequency in MHz. I_{CC} values are given in mA and measured at V_{CC} = 5 V.

A/D Converter Characteristics

V_{CC} = 5 V + 10 %, – 15 %; V_{SS} = 0 V
V_{AREF} = V_{CC} ± 5%; V_{AGND} = V_{SS} ± 0.2 V;
T_A = 0 to 70 °C for the SAB 80C517A/83C517A-5
T_A = – 40 to 85 ° C for the SAB 80C517A-T3/83C517A-5-T3
T_A = – 40 to 110 °C for the SAB 80C517A-T4/83C517A-5-T4

Parameter	Symbol	Limit values			Unit	Test condition
		min.	typ.	max.		
Analog input capacitance	C_I		25	70	pF	
Sample time (inc. load time)	T_S			4 t_{CY} [1]	µs	[2]
Conversion time (inc. sample time)	T_C			14 t_{CY} [1]	µs	[3]
Total unadjusted error	TUE			± 2	LSB	V_{AREF} = V_{CC} V_{AGND} = V_{SS}
V_{AREF} supply current	I_{REF}		± 20		µA	[4]

1) $t_{CY} = (8*2^{ADCL}) / f_{OSC}$; ($t_{CY} = 1/f_{ADC}$; $f_{ADC} = f_{OSC}/(8*2^{ADCL})$)
2) This parameter specifies the time during the input capacitance C_I, can be charged/discharged by the external source. It must be guaranteed, that the input capacitance C_I, is fully loaded within this time. 4TCY is 2 µs at the f_{OSC}= 16 MHz. After the end of the sample time T_S, changes of the analog input voltage have no effect on the conversion result.
3) This parameter includes the sample time T_S. 14TCY is 7 µs at f_{OSC} = 16 MHz.
4) The differencial impedance r_D of the analog reference source must be less than 1 KΩ at reference supply voltage.

AC Characteristics

V_{CC} = 5 V + 10 %, – 15 %; V_{SS} = 0 V

T_A = 0 to 70 °C for the SAB 80C517A/83C517A-5
T_A = – 40 to 85 °C for the SAB 80C517A-T3/83C517A-5-T3
T_A = – 40 to110 ° C for the SAB 80C517A-T4/83C517A-5-T4

(C_L for port 0, ALE and $\overline{PSEN}$ outputs = 100 pF; C_L for all other outputs = 80 pF)

Parameter	Symbol	Limit values				Unit
		18 MHz clock		Variable clock $1/t_{CLCL}$ = 3.5 MHz to 18 MHz		
		min.	max.	min.	max.	

Program Memory Characteristics

ALE pulse width	t_{LHLL}	71	–	$2\,t_{CLCL} - 40$	–	ns
Address setup to ALE	t_{AVLL}	26	–	$t_{CLCL} - 30$	–	ns
Address hold after ALE	t_{LLAX}	26	–	$t_{CLCL} - 30$	–	ns
ALE to valid instruction	t_{LLIV}	–	122	–	$4t_{CLCL} - 100$	ns
ALE to $\overline{PSEN}$	t_{LLPL}	31	–	$t_{CLCL} - 25$	–	ns
$\overline{PSEN}$ pulse width	t_{PLPH}	132	–	$3\,t_{CLCL} - 35$	–	ns
$\overline{PSEN}$ to valid instruction	t_{PLIV}	–	92	–	$3t_{CLCL} - 75$	ns
Input instruction hold after $\overline{PSEN}$	t_{PXIX}	0	–	0		ns
Input instruction float after $\overline{PSEN}$	t_{PXIZ}	–	46	–	$t_{CLCL} - 10$	ns
Address valid after $\overline{PSEN}$	t_{PXAV}*)	48	–	$t_{CLCL} - 8$	–	ns
Address to valid instr in	t_{AVIV}	–	218	–	$5t_{CLCL} - 60$	ns
Address float to $\overline{PSEN}$	t_{AZPL}	0	–	0	–	ns

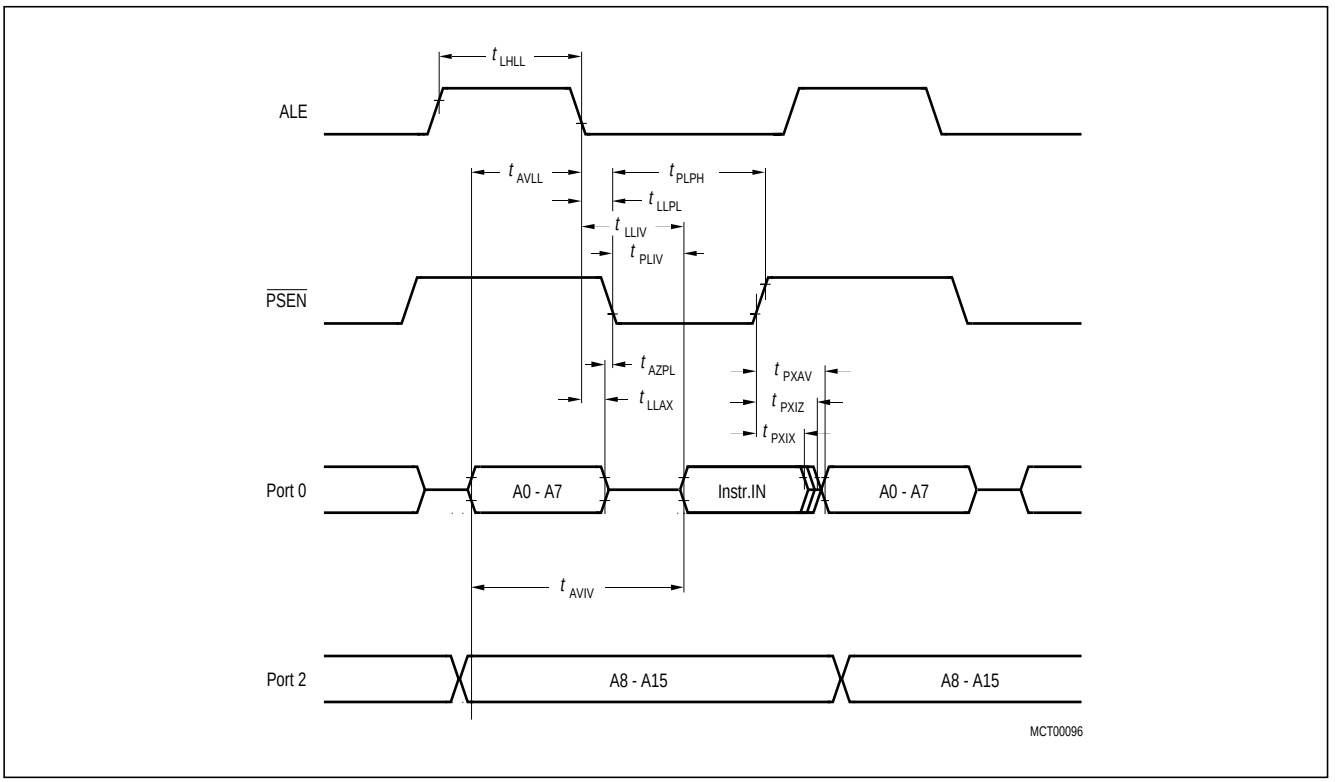
*) Interfacing the SAB 80C51 7A to devices with float times up to 45 ns is permissible. This limited bus contention will not cause any damage to port 0 drivers.

AC Characteristics (cont'd)

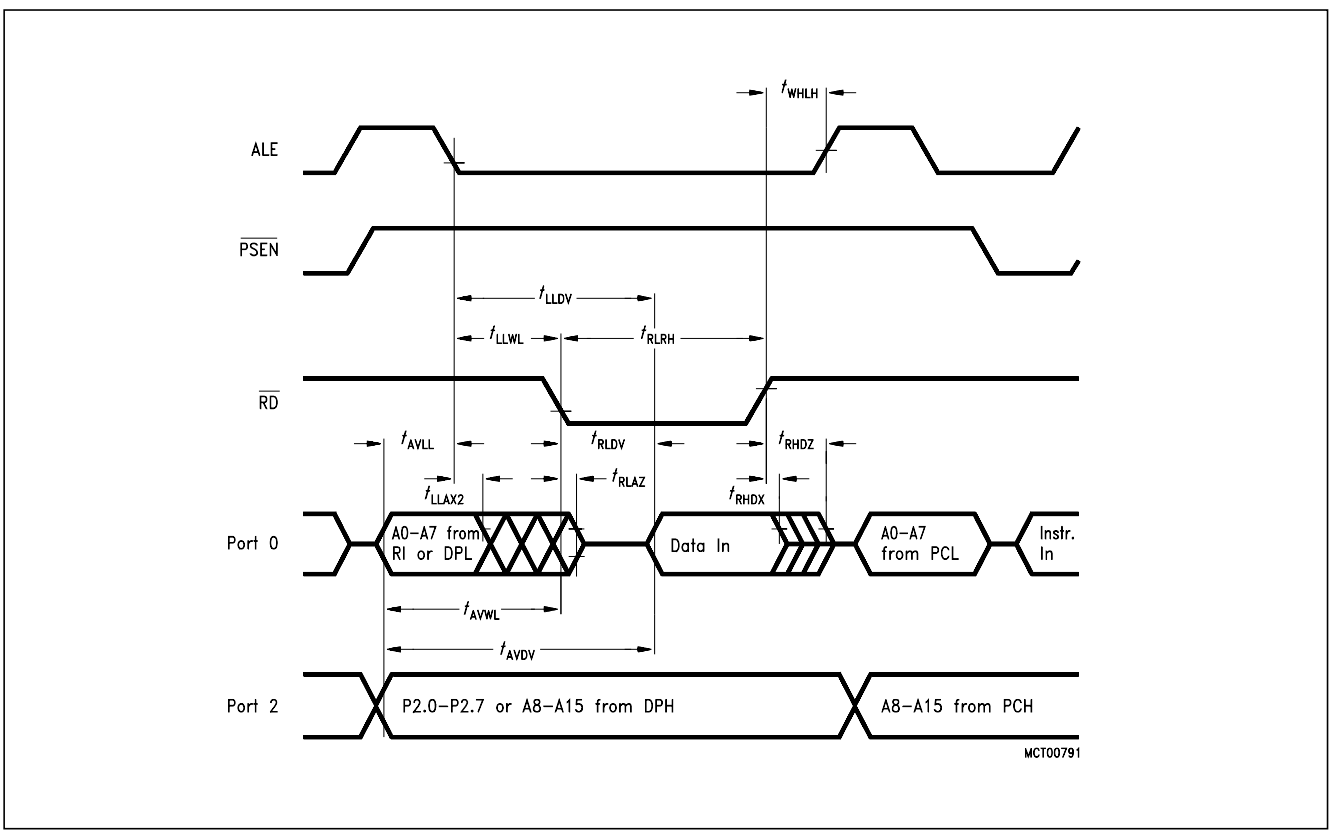
Parameter	Symbol	Limit values				Unit
		18 MHz clock		Variable clock $1/t_{CLCL}$ = 3.5 MHz to 18 MHz		
		min.	max.	min.	max.	

External Data Memory Characteristics

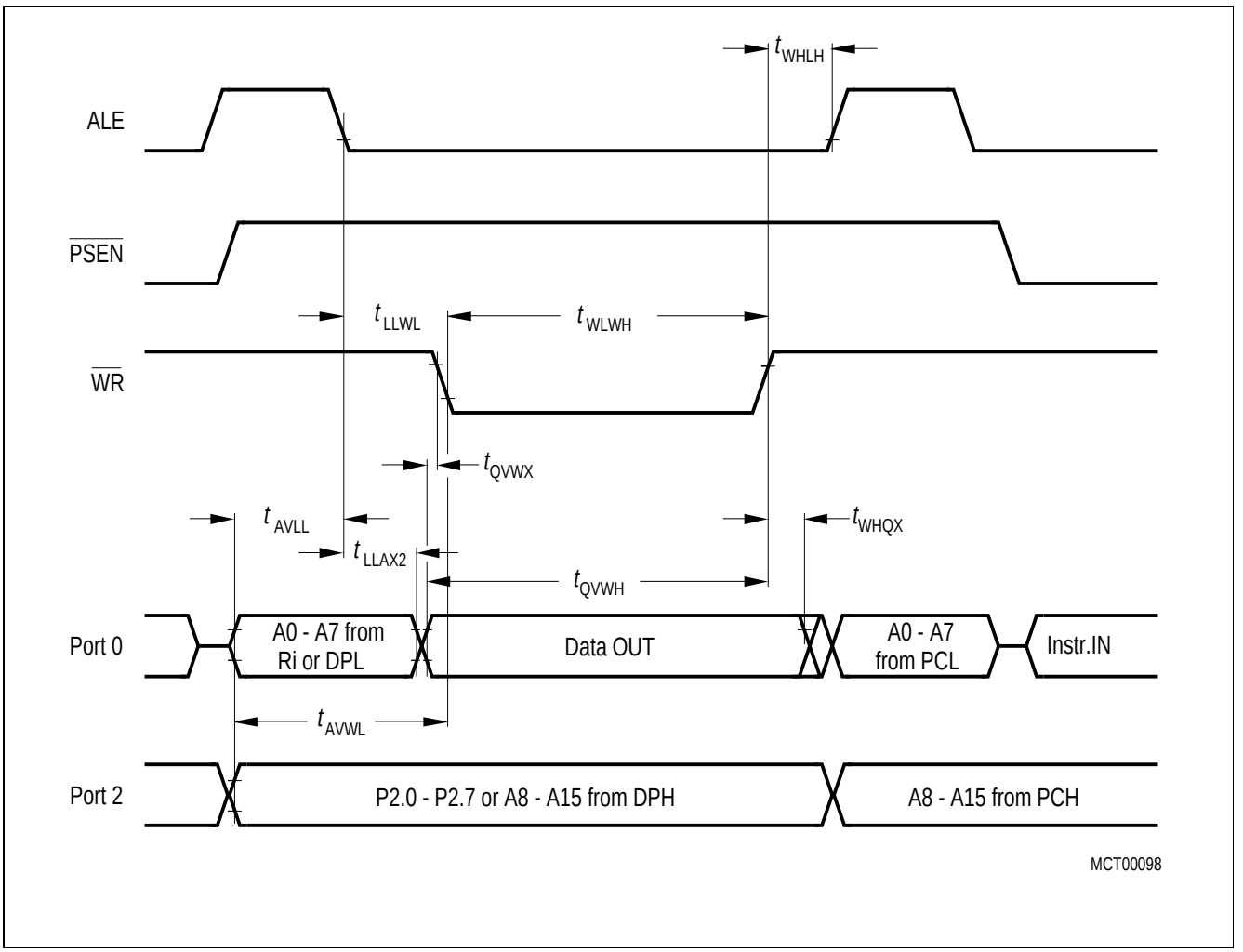
$\overline{RD}$ pulse width	t_{RLRH}	233	–	6 t_{CLCL} – 100	–	ns
$\overline{WR}$ pulse width	t_{WLWH}	233	–	6 t_{CLCL} – 100	–	ns
Address hold after ALE	t_{LLAX2}	81	–	2 t_{CLCL} – 30	–	ns
$\overline{RD}$ to valid data in	t_{RLDV}	–	128	–	5 t_{CLCL} – 150	ns
Data hold after $\overline{RD}$	t_{RHDX}	0	–	0	–	ns
Data float after $\overline{RD}$	t_{RHDZ}	–	51	–	2 t_{CLCL} – 60	ns
ALE to valid data in	t_{LLDV}	–	294	–	8 t_{CLCL} – 150	ns
Address to valid data in	t_{AVDV}	–	335	–	9 t_{CLCL} – 165	ns
ALE to $\overline{WR}$ or $\overline{RD}$	t_{LLWL}	117	217	3 t_{CLCL} – 50	3 t_{CLCL} +50	ns
$\overline{WR}$ or $\overline{RD}$ high to ALE high	t_{WHLH}	16	96	t_{CLCL} – 40	t_{CLCL} +40	ns
Address valid to $\overline{WR}$	t_{AVWL}	92	–	4 t_{CLCL} – 130	–	ns
Data valid to $\overline{WR}$ transition	t_{QVWX}	11	–	t_{CLCL} – 45	–	ns
Data setup before $\overline{WR}$	t_{QVWH}	239	–	7 t_{CLCL} – 150	–	ns
Data hold after $\overline{WR}$	t_{WHQX}	16	–	t_{CLCL} – 40	–	ns
Address float after $\overline{RD}$	t_{RLAZ}	–	0	–	0	ns



Program Memory Read Cycle



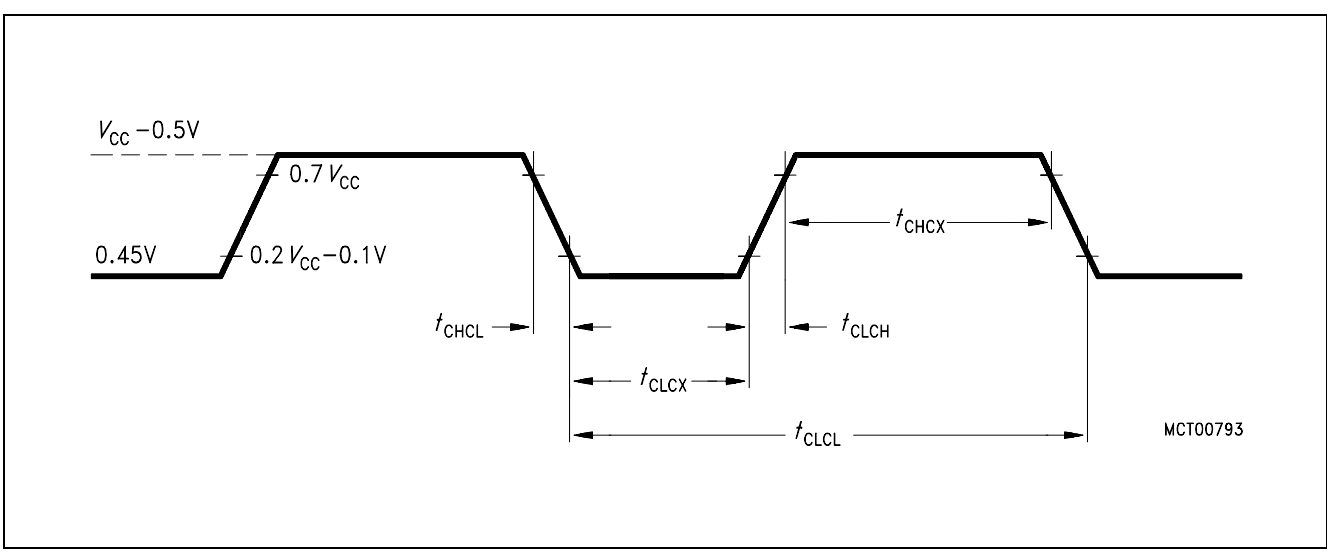
Data Memory Read Cycle



Data Memory Write Cycle

AC Characteristics (cont'd)

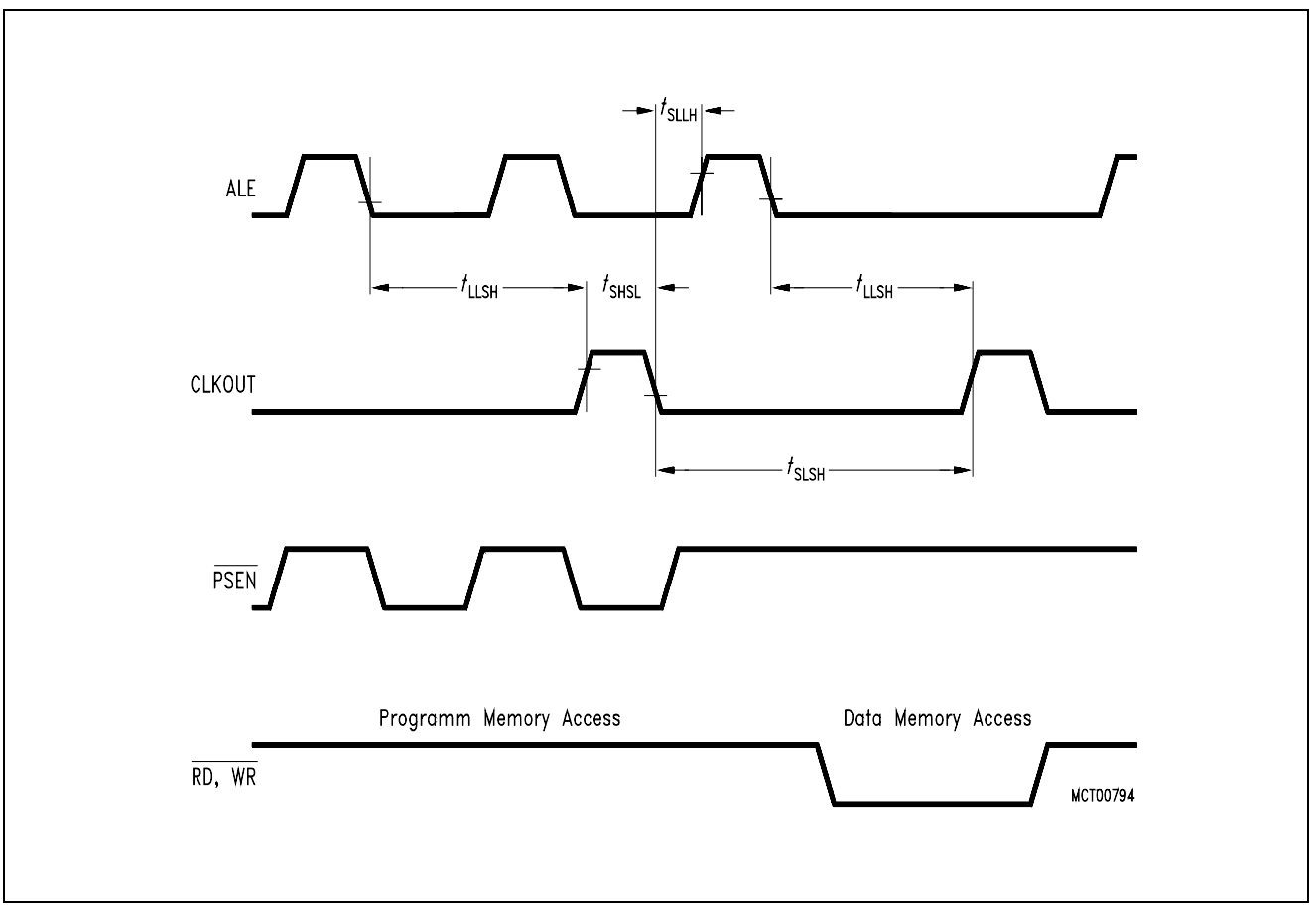
Parameter	Symbol	Limit values		Unit
		Variable clock Frequ. = 3.5 MHz to 18 MHz		
		min.	max.	
External Clock Drive				
Oscillator period	t_{CLCL}	55.6	285	ns
High time	t_{CHCX}	20	t_{CLCL}-t_{CHCX}	ns
Low time	t_{CLCX}	20	t_{CLCL}-t_{CHCX}	ns
Rise time	t_{CLCH}	–	20	ns
Fall time	t_{CHCL}	–	20	ns
Oscillator frequency	1/t_{CLC}	3.5	18	MHz



External Clock Cycle

AC Characteristics (cont'd)

Parameter	Symbol	Limit values				Unit
		18 MHz clock		Variable clock $1/t_{CLCL}$ = 3.5 MHz to 18 MHz		
		min.	max.	min.	max.	
System Clock Timing						
ALE to CLKOUT	t_{LLSH}	349	–	7 t_{CLCL} – 40	–	ns
CLKOUT high time	t_{SHSL}	71	–	2 t_{CLCL} – 40	–	ns
CLKOUT low time	t_{SLSH}	516	–	10 t_{CLCL} – 40	–	ns
CLKOUT low to ALE high	t_{SLLH}	16	96	t_{CLCL} – 40	t_{CLCL} +40	ns



System Clock Timing

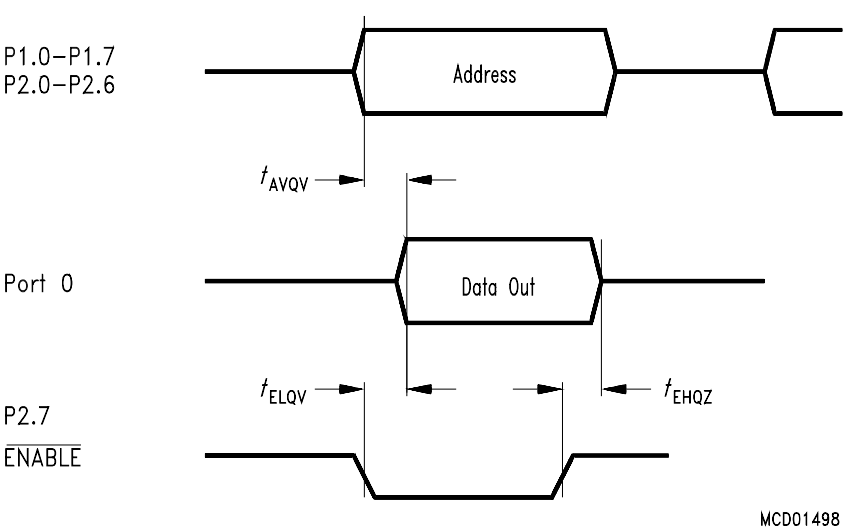
ROM Verification Characteristics

T_A = 25°C ± 5°C; V_{CC} = 5 V ± 10%; V_{SS} = 0 V

Parameter	Symbol	Limit values		Unit
		min.	max.	

ROM Verification Mode 1 (Standard Verify Mode for not Read Protected ROM)

Address to valid data	t_{AVQV}	–	48 t_{CLCL}	ns
ENABLE to valid data	t_{ELQV}	–	48 t_{CLCL}	ns
Data float after ENABLE	t_{EHOZ}	0	48 t_{CLCL}	ns
Oscillator frequency	1/t_{CLCL}	4	6	MHz

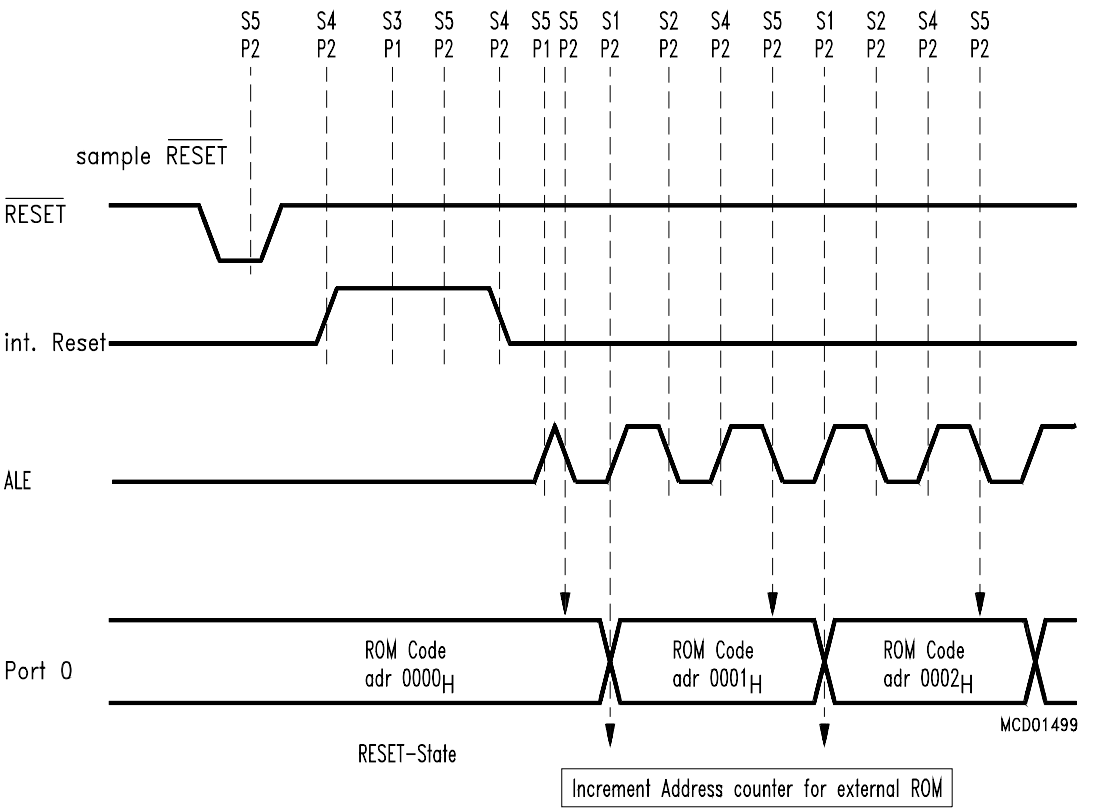


Address: P1.0–P1.7=A0–A7
P2.0–P2.6=A8–A14
Data: P0.0–0.7=D0–D7

Inputs $\overline{PSEN}$ = V_{SS}
ALE,$\overline{EA}$ = V_{IH}
$\overline{RESET}$ = V_{IL}

ROM Verification Mode 1

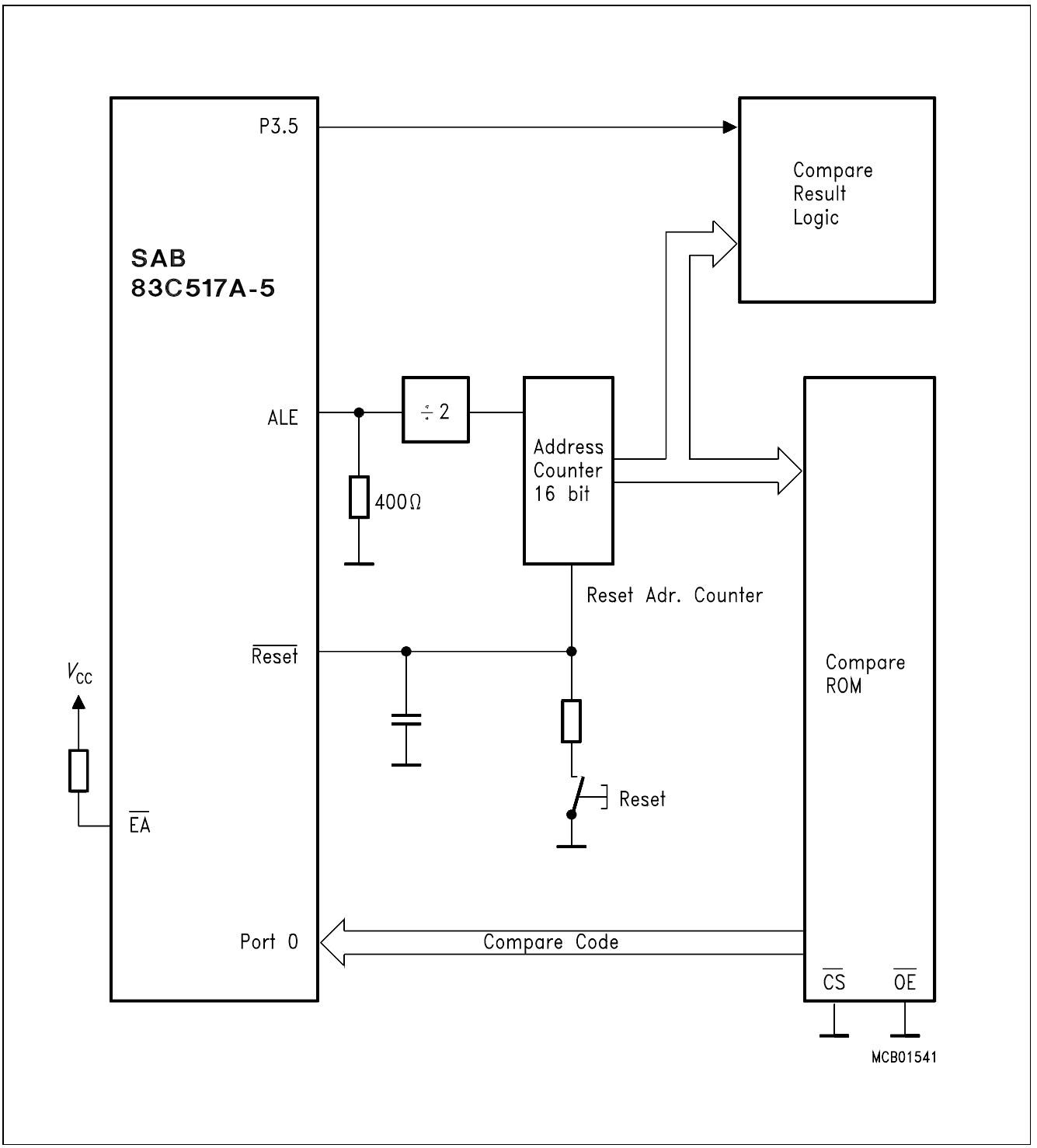
ROM Verification Mode 2 (New Verify Mode for Protected and not Protected ROM)



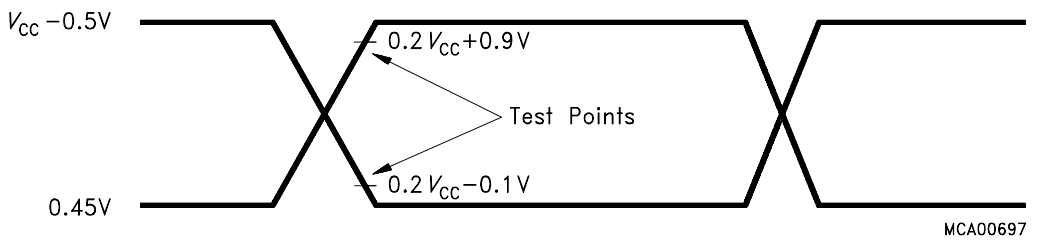
Inputs $\overline{EA}= V_{IH}$
ALE forced to low level by a weak pull down resistor (approx.400Ω),
during $\overline{RESET}$ activ ROM-Code: Port 0=D0-D7

Outputs Port 3.5 shows all 1024 cycles low level for one cycle
when compared ROM-Code was not alright

ROM Verification Mode 2

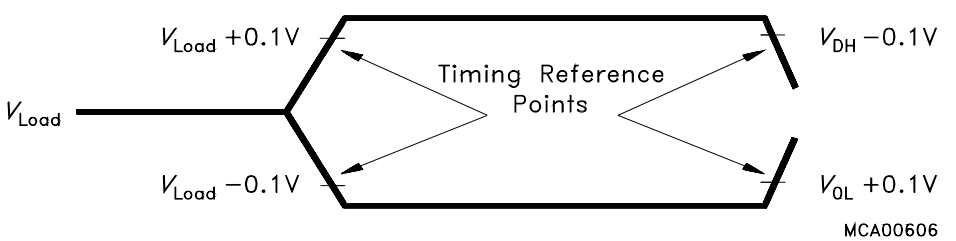


Application Circuitry for Verifying the Internal ROM



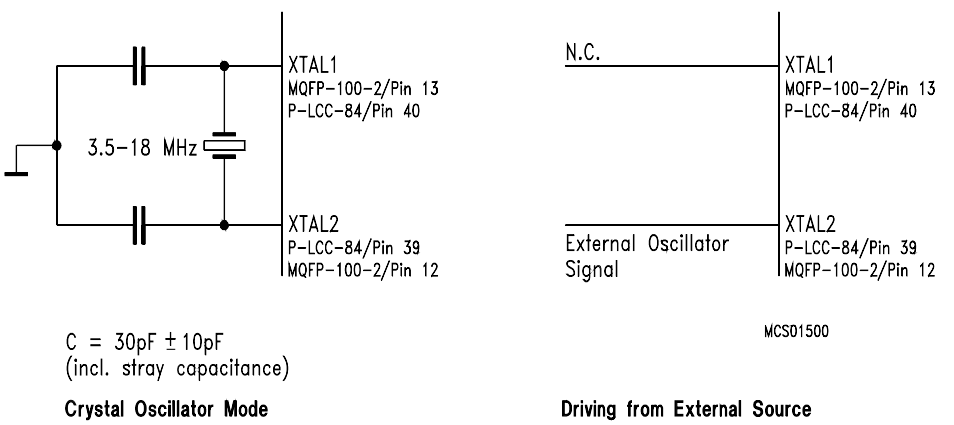
AC Inputs during testing are driven at V_{CC} - 0.5 V for a logic '1' and 0.45 V for a logic '0'. Timing measurements are made at V_{IHmin} for a logic '1' and V_{ILmax} for a logic '0'.

AC Testing: Input, Output Waveforms



For timing purposes a port pin is no longer floating when a 100 mV change from load voltage occurs and begins to float when a 100 mV change from the loaded V_{OH}/V_{OL} level occurs. $I_{OL}/I_{OH} \geq \pm 20$ mA.

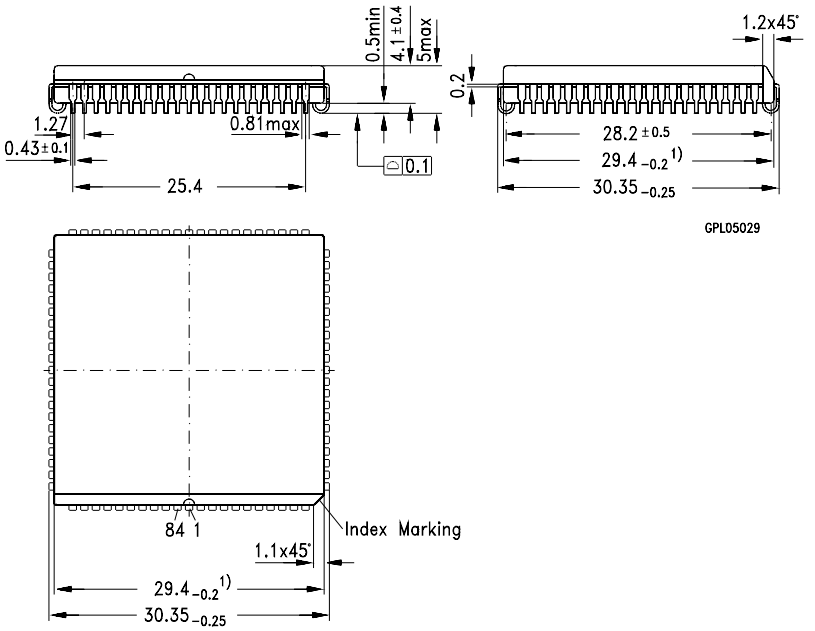
AC Testing: Float Waveforms



Recommended Oscillator Circuits

Package Outlines

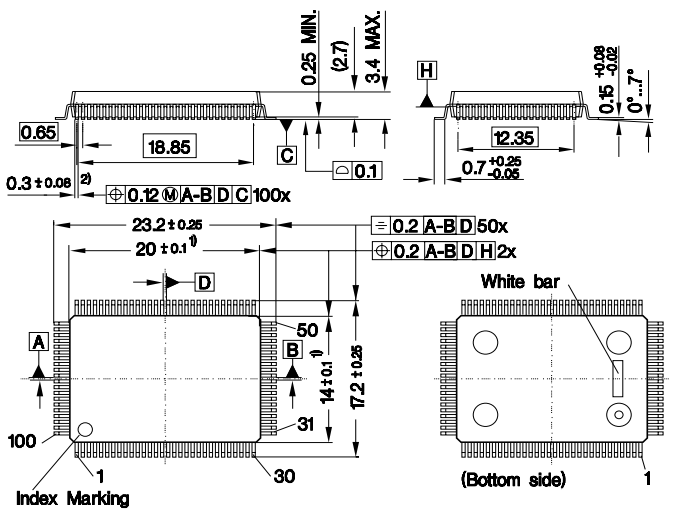
Plastic Package, P-LCC-84 – SMD
(Plastic Leaded Chip-Carrier)



1) Does not include plastic or metal protrusions of 0.15max per side

Dimensions in mm

Plastic Package, P-MQFP-100-2 – SMD
(Plastic Metric Rectangular Flat Package)



2) Does not include dambar protrusion of 0.08 max. per side
1) Does not include plastic or metal protrusion of 0.25 max. per side

Dimensions in mm

SMD = Surface Mounted Device